# ARM926EJ-S Development Chip Reference Manual



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# ARM926EJ-S Development Chip Reference Manual

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#### **Release Information**

Change history

Description	Issue	Change
April 2004	А	New document
August 2006	В	Second release, updated to fix defects on AHB monitor and AHB bus graphics.

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#### CE Declaration of Conformity

# CE

A system using this development chip should be powered down when not in use.

The ARM926PXP development chip generates, uses, and can radiate radio frequency energy and may cause harmful interference to radio communications. However, there is no guarantee that interference will not occur in a particular installation. If equipment using the ARM926PXP development chip causes harmful interference to radio or television reception, which can be determined by turning the equipment off or on, you are encouraged to try to correct the interference by one or more of the following measures:

- ensure attached cables do not lie across the card
- reorient the receiving antenna
- increase the distance between the equipment and the receiver
- connect the equipment into an outlet on a circuit different from that to which the receiver is connected
- consult the dealer or an experienced radio/TV technician for help

# – Note –––––

It is recommended that wherever possible shielded interface cables be used.

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# Preface

This preface introduces the *ARM926EJ-S Development Chip Reference Manual*. It contains the following sections:

- About this document on page xviii
- *Feedback* on page xxiii.

# About this document

This document provides an overview of the ARM926EJ-S Development Chip and a description of the modules in it. For details on the registers and programmer's interface, see the *Technical Reference Manual* for the individual controller.

# Intended audience

This document has been written for experienced hardware and software developers using the ARM926EJ-S Development Chip as part of an existing development system.

# Organization

This document is organized into the following chapters:

## **Chapter 1** Introduction

Read this chapter for an introduction to the ARM926EJ-S Development Chip.

## Chapter 2 System Controller and Configuration Logic

Read this chapter for a description of the clock and configuration logic that is associated with the system controller.

# Chapter 3 Memory Map and Memory Configuration

Read this chapter for a description of the AHB buses and the memory map for the ARM926EJ-S Development Chip.

# Chapter 4 AHB Monitor

Read this chapter for a description of the bus monitor.

# Chapter 5 Color LCD Controller (CLCDC)

Read this chapter for a description of the display controller.

### Chapter 6 MOVE Coprocessor

Read this chapter for a description of the MOVE graphic coprocessor.

# Chapter 7 MBX HR-S Graphics Accelerator

Read this chapter for a description of the MBX graphic coprocessor.

### Chapter 8 Direct Memory Access Controller (DMAC)

Read this chapter for a description of the DMA controller.

# Chapter 9 General Purpose Input Output (GPIO)

Read this chapter for a description of the GPIO.

# Chapter 10 Multi-Port Memory Controller (MPMC)

Read this chapter for a description of the MPMC.

#### Chapter 11 Real-Time Clock (RTC)

Read this chapter for a description of the RTC controller.

# Chapter 12 Smart Card Interface (SCI)

Read this chapter for a description of the SCI.

Chapter 13 Synchronous Static Memory Controller (SSMC) Read this chapter for a description of the SSMC.

#### Chapter 14 Synchronous Serial Port (SSP)

Read this chapter for a description of the SSP.

# Chapter 15 Dual Timer/Counters

Read this chapter for a description of the dual timer/counter.

#### Chapter 17 Vectored Interrupt Controller (VIC)

Read this chapter for a description of the VIC controller.

#### Chapter 18 ARM Vector Floating Point Coprocessor (VFP9)

Read this chapter for a description of the VFP9.

## Chapter 19 Watchdog Timer

Read this chapter for a description of the watchdog controller.

#### Appendix A Signals on Pads

Refer to this appendix for a list of signals on the input/output pads of the ARM926EJ-S Development Chip.

### Appendix B Mechanical and Electrical Specifications

Read this appendix for details on the ARM926EJ-S Development Chip mechanical packaging and the electrical specifications.

### Appendix C Timing Specification

Refer to this appendix for timing specifications.

# Typographical conventions

The following typographical conventions are used in this document:

bold	Highlights ARM signal names within text, and interface elements such as menu names. This style is also used for emphasis in descriptive lists where appropriate.
italic	Highlights special terminology, cross-references and citations.
monospace	Denotes text that can be entered at the keyboard, such as commands, file names and program names, and source code.
<u>mono</u> space	Denotes a permitted abbreviation for a command or option. The underlined text can be entered instead of the full command or option name.
monospace italic	
	Denotes arguments to commands or functions where the argument is to be replaced by a specific value.
monospace bold	
	Denotes language keywords when used outside example code.

# **Further reading**

This section lists related publications by ARM Limited and other companies that might provide additional information.

# **ARM** publications

The following publication provides information about the registers and interfaces on the ARM926EJ-S Development Chip:

- ARM926EJ-S Technical Reference Manual (ARM DDI 0198)
- ARM926EJ-S<sup>™</sup> PrimeXsys Wireless Platform Virtual Component Technical Reference Manual (ARM DDI 0232)
- *ARM926EJ-S<sup>™</sup> PrimeXsys Platform Virtual Component User Guide* (ARM DUI 0213)
- ARM MOVE Coprocessor Technical Reference Manual (ARM DDI 0251)
- ARM VFP9-S Coprocessor Technical Reference Manual (ARM DDI 0238)
- ARM MBX HR-S Graphics Core Technical Reference Manual (ARM DDI 0241).

The following publications provide reference information about the ARM architecture:

- *AMBA<sup>™</sup> Specification* (ARM IHI 0011)
- ARM Architecture Reference Manual (ARM DDI 0100).

The following publications provides information about related ARM products and toolkits:

- $Multi-ICE^{TM}$  User Guide (ARM DUI 0048)
- *RealView<sup>™</sup> ICE User Guide* (ARM DUI 0155)
- Trace Debug Tools User Guide (ARM DUI 0118)
- ARM MultiTrace<sup>®</sup> User Guide (ARM DUI 0150)
- ARM LT-XC2V4000+ Versatile Logic Tile User Guide (ARM DUI 0186)
- *RealView<sup>™</sup> Debugger User Guide* (ARM DUI 0153)
- RealView Compilation Tools Compilers and Libraries Guide (ARM DUI 0205)
- *RealView Compilation Tools Developer Guide* (ARM DUI 0203)
- RealView Compilation Tools Linker and Utilities Guide (ARM DUI 0206).

The following publications provide information about ARM PrimeCell<sup>®</sup> and other processor devices:

- ARM PrimeCell Color LCD Controller (PL110) Technical Reference Manual (ARM DDI 0161)
- ARM PrimeCell DMA (PL080) Technical Reference Manual (ARM DDI 0196)
- ARM Dual-Timer Module (SP804) Technical Reference Manual (ARM DDI 0271)
- ARM PrimeCell GPIO (PL061) Technical Reference Manual (ARM DDI 0190)
- ARM Multiport Memory Controller (GX175) Technical Reference Manual (ARM DDI 0277)
- ARM PrimeCell Real Time Clock Controller (PL031) Technical Reference Manual (ARM DDI 0224)
- ARM PrimeCell Smart Card Interface (PL131) Technical Reference Manual (ARM DDI 0228)
- ARM PrimeCell Synchronous Serial Port Controller (PL022) Technical Reference Manual (ARM DDI 0194)
- ARM PrimeCell Static Memory Controller (PL093) Technical Reference Manual (ARM DDI 236)
- ARM PrimeCell System Controller (SP810) Technical Reference Manual (ARM DDI 0254)
- ARM PrimeCell UART (PL011) Technical Reference Manual (ARM DDI 0183)
- ARM PrimeCell Vector Interrupt Controller (PL190) Technical Reference Manual (ARM DDI 0181)

- ARM PrimeCell Watchdog Controller (SP805) Technical Reference Manual (ARM DDI 0270)
- ETM9 Technical Reference Manual (ARM DDI 0157)

# Other publications

The following publication describes the JTAG ports with which Multi-ICE communicates:

• *IEEE Standard Test Access Port and Boundary Scan Architecture* (IEEE Std. 1149.1).

# Feedback

ARM Limited welcomes feedback both on the ARM926EJ-S Development Chip and on the documentation.

# Feedback on this document

If you have any comments about this document, send email to errata@arm.com giving:

- the document title
- the document number
- the page number(s) to which your comments refer
- an explanation of your comments.

General suggestions for additions and improvements are also welcome.

# Feedback on the ARM926EJ-S Development Chip

If you have any comments or suggestions about these products, contact your supplier giving:

- the product name
- an explanation of your comments.

Preface

# Part A Introduction and Configuration

# Chapter 1 Introduction

This chapter introduces the ARM926EJ-S Development Chip. It contains the following sections:

- About the ARM926EJ-S Development Chip on page 1-2
- *Functional description* on page 1-4
- *External interfaces* on page 1-9.

# 1.1 About the ARM926EJ-S Development Chip

The ARM926EJ-S Development Chip is used in ARM development boards and enables you to develop software for products based on the ARM926EJ-S PrimeXSys Wireless Platform.

A typical application of the ARM926EJ-S Development Chip is shown in Figure 1-1.



Figure 1-1 Typical application



The block diagram in Figure 1-2 shows the internal buses and the master and slave bus interfaces.

Figure 1-2 ARM926EJ-S Development Chip block diagram

# 1.2 Functional description

The ARM926EJ-S Development Chip comprises the following functional blocks:

# ARM926EJ-S

This is a cached ARM CPU including Instruction and Data caches, *Memory Management Unit* (MMU), and *Tightly Coupled Memory* (TCM). It supports the Jazelle<sup>TM</sup> extensions for Java acceleration.

The ARM926EJ-S processor used with the ARM926EJ-S Development Chip is configured with 32KB instruction and data caches and 32KB TCMs.

The release version used is ARM926EJ-S r0p3-00rel0. The PrimeXsys Wireless Platform version is r2p0.

For more information on the ARM926EJ-S, see the *ARM926EJ-S Technical Reference Manual*.

# **MOVE coprocessor**

The MOVE coprocessor is a video encoding acceleration coprocessor designed to accelerate *Motion Estimation* (ME) algorithms within block-based video encoding schemes such as MPEG4 and H.263. This is done by providing support for the execution of *Sum of Absolute Differences* (SAD) calculations, which account for most of the processing activity within an ME algorithm. These algorithms require many comparisons between 8x8 pixel blocks to made between a current frame and a reference frame.

The release version used is MOVE r3p0-00bet0.

For more information on the MOVE coprocessor, see the *ARM MOVE Coprocessor Technical Reference Manual* and Chapter 6 *MOVE Coprocessor*.

# VFP9 coprocessor

The VFP9-S coprocessor is an implementation of the *Vector Floating-Point* architecture version 2 (VFPv2) and provides floating-point computation that is fully compliant with the *ANSI/IEEE Std* 754-1985, *IEEE Standard for Binary Floating-Point Arithmetic*. The VFP9-S coprocessor supports all addressing modes described in section C5 of the ARM Architecture Reference Manual.

The release version used is VFP9-S r1p1.

For more information on the VFP9 coprocessor, see the ARM VFP9-S Coprocessor Technical Reference Manual and Chapter 18 ARM Vector Floating Point Coprocessor (VFP9).

# AHB Monitor

The AHB Monitor block outputs transaction information for the buses in the ARM926EJ-S Development Chip and is used to evaluate performance and bandwidth utilization analysis.

For more information on the AHB monitor, see Chapter 4 AHB Monitor.

# **MBX** Graphics Accelerator

The ARM MBX HR-S is a graphics accelerator that operates on 3D scene data. Triangles are written directly to the Tile Accelerator on a *First In First Out* (FIFO) basis so that the CPU is not stalled.

The release version used is MBX HR-S r1p2.

For more information on the MBX accelerator, see the ARM MBX HR-S Graphics Core Technical Reference Manual and Chapter 7 MBX HR-S Graphics Accelerator.

# System Controller

This provides a control interface for clock generation components external to the chip. It also controls system-wide and peripherals-specific energy management features.

The release version used is SP810 SYSCTRL r0p0-00ltd0.

For more information on the system controller, see the *ARM PrimeCell* System Controller (SP810) Technical Reference Manual and Chapter 2 System Controller and Configuration Logic.

# Multi-Port Memory Controller (MPMC)

The MPMC can be used to interface with *Synchronous Dynamic Random Access Memory* (SDRAM) and static memory devices.

The release version used is GX175 MPMC r0p0-00alp2.

For more information on the MPMC, see the ARM Multiport Memory Controller (GX175) Technical Reference Manual and Chapter 10 Multi-Port Memory Controller (MPMC).

# Synchronous Static Memory Controller (SSMC)

The SSMC interfaces to off-chip static memory devices such as *Read Only Memory* (ROM), *Static Random Access Memory* (SRAM), or static flash memory.

The release version used is PL093 SSMC r0p0-00ltd0.

For more information on the SSMC, see the ARM PrimeCell Static Memory Controller (PL093) Technical Reference Manual and Chapter 13 Synchronous Static Memory Controller (SSMC).

## Direct Memory Access Controller (DMAC)

Direct memory access can be used with DMA peripherals. FIFO fill and empty requests from these peripherals can be serviced immediately by the DMAC without CPU interaction. Memory-to-memory DMA is also supported.

The release version used is PL080 DMAC REL1v1.

For more information on DMA, see the *ARM PrimeCell DMA (PL080) Technical Reference Manual* and Chapter 8 *Direct Memory Access Controller (DMAC)*.

## Vectored Interrupt Controller (VIC)

The VIC enables the interrupt handler software to quickly dispatch interrupt service routines in response to peripheral interrupts.

The release version used is PL190 VIC 1v1.

For more information on the VIC, see the ARM PrimeCell Vector Interrupt Controller (PL190) Technical Reference Manual and Chapter 17 Vectored Interrupt Controller (VIC).

# Embedded Trace Macrocell (ETM9)

The ETM9 provides a trace port for real-time debug.

The release version used is ETM9 Rev2a. The ETM configuration for the ARM926EJ-S Development Chip is Medium-Plus.

For more information on the ETM9, see the *ETM9 Technical Reference Manual*.

# Real Time Clock (RTC)

The RTC provides a one-second resolution clock. This keeps time when the ARM926EJ-S Development Chip is inactive and can be used to wake the chip up when a programmed alarm time is reached.

The release version used is PL031 RTC 1v0.

For more information on the RTC, see the *ARM PrimeCell Real Time Clock Controller (PL031) Technical Reference Manual* and Chapter 11 *Real-Time Clock (RTC).* 

# **Timer modules**

The ARM926EJ-S Development Chip provides two Timer modules. They can be used to, for example, generate periodic and timed interrupts required by operating system services.

The release version used is SP804 TIMER r1p0-02ltd0.

For more information on the timers, see the *ARM Dual-Timer Module* (SP804) Technical Reference Manual and Chapter 15 Dual Timer/Counters.

# Watchdog module

This is used to trigger a system reset in the event of software failure.

The release version used is SP805 WDOG r1p0-02ltd0.

For more information on the Watchdog monitor, see the *ARM PrimeCell Watchdog Controller (SP805) Technical Reference Manual* and Chapter 19 *Watchdog Timer*.

# Universal Asynchronous Receiver-Transmitter (UART)

There are three UARTs in the ARM926EJ-S Development Chip. The UARTs perform serial-to-parallel conversion on data received from a peripheral device

The release version used is PL011 UART 1v3.

For more information on the UARTs, see the ARM PrimeCell UART (PL011) Technical Reference Manual and Chapter 16 UART Controller.

# Synchronous Serial Port (SSP)

The PrimeCell SSP is a master or slave interface that enables synchronous serial communication with slave or master peripherals having one of the following:

- a Motorola SPI-compatible interface
- a Texas Instruments synchronous serial interface
- a National Semiconductor Microwire interface.

The release version used is PL022 SSP REL1v2.

For more information on the SSP, see the ARM PrimeCell Synchronous Serial Port Controller (PL022) Technical Reference Manual and Chapter 14 Synchronous Serial Port (SSP).

# Color Liquid Crystal Display Controller (CLCDC)

The CLCDC performs translation of pixel-coded data into the required formats and timings to drive a variety of single/dual mono and color LCDs. Support is provided for passive *Super Twisted Nematic* (STN) and active *Thin Film Transistor* (TFT) LCD display types.

The release version used is a modified PL110 CLCDC r0p0-00alp0 with the hardware cursor from the PL111.

For more information on the CLCDC, see the *ARM PrimeCell Color LCD Controller (PL110) Technical Reference Manual* and Chapter 5 *Color LCD Controller (CLCDC)*.

# General Purpose Input/Output (GPIO) interface

There are four GPIO interfaces in the ARM926EJ-S Development Chip. Each GPIO interface provides eight programmable inputs or outputs.

The release version used is PL061 GPIO 1v0.

For more information on the GPIOs, see the *ARM PrimeCell GPIO* (*PL061*) *Technical Reference Manual* and Chapter 9 *General Purpose Input Output* (*GPIO*).

# Smart Card Interface (SCI)

This connects to smart card, *Security Identity Module* (SIM) card, and other modules.

The release version used is PL131 SCI 1v0.

For more information on the SCI, see the *ARM PrimeCell Smart Card Interface (PL131) Technical Reference Manual* and Chapter 12 *Smart Card Interface (SCI).* 

# 1.3 External interfaces

The ARM926EJ-S Development Chip supports the following external interfaces:

- three AHB expansion ports:
  - two master ports
  - one slave port.
- 11 external interrupt sources
- a dedicated power-fail interrupt source
- six external peripheral Direct Memory Access (DMA) interfaces
- interface to static memory devices
- interface to Synchronous SDRAM devices
- CLCDC supporting *SuperTwist Nematic* (STN) and *Thin Film Transistor* (TFT) displays
- three UARTs with support for slow Infra-red Data Association (IrDA)
- Synchronous Serial Port (SSP) supporting master and slave operation
- 32 General Purpose Input Output (GPIO) lines
- Smart Card Interface (SCI) consistent with the UICC Terminal Interface Specification.

# 1.3.1 External memory support

Two memory interfaces are provided to support external static memory and external SDRAM. When modeling high-performance systems, both memory interfaces can be used in parallel. In this configuration, the Synchronous Static Memory Controller PrimeCell PL093 drives the static memory interface and the Multiport Memory Controller PrimeCell GX175 drives the SDRAM memory interface.

When modeling a relatively low-performance system, one memory interface can be used. In this configuration, the Multiport Memory Controller PrimeCell GX175 drives both the static memory and the SDRAM memory interfaces.

The MPMC supports seven ports:

- six 32-bit ports (one port is dedicated to the MBX accelerator)
- a single 32-bit AHB configuration port.

The mapping between the ARM926EJ-S Development Chip AHB buses and the MPMC ports is listed in Table 1-1.

ARM926EJ-S Development Chip AHB	MPMC port
CLCDC AHB (highest priority)	Port 0
EXPM AHB	Port 1
DMA1 AHB	Port 2
ARM Data AHB	Port 3
ARM Instruction AHB	Port 4
MBX	Port 5

### Table 1-1 MPMC port allocation

The SSMC is not a multiport device. However, the AHB bus switch selects one of the following buses for the SSMC:

- ARM Data AHB
- ARM Instruction AHB
- DMA1 AHB
- EXPM AHB expansion bus

The MPMC and SSMC have additional AHB control ports that are used to access the configuration registers. These ports are only accessible using the ARM Data AHB bus.
#### Default memory map

The default memory map is divided into the regions shown in Figure 1-3 on page 1-12. They are configured as follows:

- SDRAM for CS0 and 1 are mapped into a 256Mb region starting at 0x00000000
- SDRAM for CS2 and 3 are mapped into a 256Mb region starting at 0x70000000
- the first set of four SSMC banks for CS4, CS5, CS6, and CS7 are mapped into a 256Mb region starting at 0x2000000
- the second set of four SSMC banks for CS0, CS1, CS2, and CS3 are mapped into a 256Mb region starting at 0x30000000.

The remaining peripheral interfaces are contained in a single 1Mb region, with the AHB peripherals at the bottom of the region and the APB peripherals at the top. This enables either type of peripheral to be added to the region.

#### —— Note ———

The remainder of the address map is decoded by an off-chip AHB bridge and is provided for peripherals external to the ARM926EJ-S Development Chip. Because these address regions are not decoded in the ARM926EJ-S Development Chip, valid AHB responses must be generated through the external AHB interfaces to any access to an undefined address region.

See Chapter 3 *Memory Map and Memory Configuration* for more information on the AHB buses and the memory map.

AHB Bridge to Off-chip Peripherals		0xffffffff
And bridge to on-only r enp	All blidge to on empirementa	
MPMC SDBAM	MPMCDYCS3	0x7FFFFFFF
	MPMCDYCS2	0x7000000
AHB Bridge to Off-chip Perin	horals	0x6FFFFFFF
	lioidio	0x41000000
MBX		0x40FFFFFF
WEX		0x4000000
SSMC static memory	nSTATICCS3 nSTATICCS2	0x3FFFFFFF
Some state memory	nSTATICCS0	0x3000000
SSMC static memory	nSTATICCS7 nSTATICCS6	0x2FFFFFFF
Some state memory	nSTATICCS5 nSTATICCS4	0x2000000
AHB Bridge to Off-chip Perin	horale	0x1FFFFFFF
And bridge to On-chip r enp	Tierais	0x10200000
		0x101FFFFF
DIVIA AF B		0x101F0000
Coro APB		0x101EFFFF
COLE AL D		0x101E0000
AHB Monitor	AHB Monitor	
		0x101D0000
AHR Bridge to Off chip Borin	borals	0x101CFFFF
AILE BILGE to OII-CITP FEIP	Tierais	0x10150000
VIC		0x1014FFFF
vie		0x10140000
DMAC		0x1013FFFF
		0x10130000
		0x1012FFFF
CECD		0x10120000
MPMC configuration ragio	tore	0x1011FFFF
MPMC configuration registers		0x10110000
SMC configuration regist	SMC configuration registers	
AUR Bridge to Off ship Devis	borals	0x100FFFFF
And bridge to Oil-chip Perip	nerals	0x10000000
	MPMCDYCS1	0x0FFFFFFF
	MPMCDYCS0	0x00000000

#### ARM D bus

#### Figure 1-3 Default system bus memory map for ARM DATA AHB bus

#### 1.3.2 DMA support

The PrimeCell Dual-Master DMAC is provided to take full advantage of the multilayer AHB architecture. This enables memory-to-memory data transfers to be performed anywhere in the ARM926EJ-S Development Chip address space. Additionally, DMA handshake signals are provided, enabling memory-to-peripheral and peripheral-to-memory transfers to be supported.

Sixteen peripheral DMA request interfaces are provided by the PrimeCell DMAC. Ten of these are used by the ARM926EJ-S Development Chip peripherals:

- three UARTs
- SCI
- SSP.

Six DMAC interfaces are available for off-chip peripherals. See Chapter 8 *Direct Memory Access Controller (DMAC)* for more detail on the DMA controller.

Introduction

# Chapter 2 System Controller and Configuration Logic

This chapter describes the system controller and configuration logic in the ARM926EJ-S Development Chip. It contains the following sections:

- About the System Controller on page 2-2
- Clock control on page 2-13
- External configuration signals on page 2-19
- JTAG logic on page 2-25
- Implementation details for the ARM926EJ-S and system controller on page 2-28
- *Control, configuration, and test signals on pads* on page 2-30.

# 2.1 About the System Controller

The System Controller in the ARM926EJ-S Development Chip is used to provide an interface to control the operation of the chip.

The PrimeXsys System Controller supports the following functionality:

- a system mode control state machine
- crystal and PLL control
- definition of system response to interrupts
- reset status capture and soft reset generation
- Watchdog and Timer module clock enable generation
- remap control
- general-purpose peripheral control registers
- system/peripheral clock control and status.

The PrimeCell version used is SP810 SYSCTRL r0p0-00ltd0. The base address for the System Controller registers is 0x101E0000. For more details on the controller, see the *ARM PrimeCell System Controller (SP810) Technical Reference Manual*.

## 2.1.1 Reset control

Reset control is used to:

- monitor the **ResetStatus** input signals and make them accessible to software through the reset status register
- request a soft reset to be generated by asserting the **SOFTRESREQ** output for a single **SCLK** cycle when any value is written to the reset status register.

\_\_\_\_\_ Note \_\_\_\_\_

SCLK has the same frequency as HCLK.

**SCLK**, however, is present even in SLEEP mode when other clocks have been turned off.

#### 2.1.2 Interrupt response mode

To enable the best possible response to interrupts, you can override the present mode bits in the System Control register after an interrupt has been generated. This enables, for example, the state machine to move from the DOZE mode to NORMAL mode after an interrupt.

The interrupt response functionality is controlled by the interrupt mode control register, which defines:

- if the functionality has been enabled
- the mode of operation that is required following an interrupt
- what type of interrupt is permitted to enable the interrupt response mode
- an interrupt mode status bit and clear mechanism.

\_\_\_\_ Note \_\_\_\_\_

It is not possible for the interrupt response mode to slow the system operating speed, for example, change mode from NORMAL to SLOW.

The interrupt response mode is cleared by writing logic 0 to the interrupt mode control register.

Following a power-on reset, the interrupt response mode is disabled.

# 2.1.3 Wait for interrupt control

To enter SLEEP mode the CPU must enter the Wait-for-interrupt state using register 7 in CP15 of the CPU system control coprocessor. This ensures that the CPU is in a low-power state. You must also use Wait-for-interrupt whenever short pauses occur in processing requirements (the system mode control state machine can remain in the same state).

## 2.1.4 Low battery handling

Two inputs are provided to the ARM926EJ-S Development Chip to facilitate software implementation of low battery and emergency power failure situations. These are:

**BATOK** This input is an alternate function of **GPIO3**[7] and tells the software that there is sufficient charge in the battery for normal operation. When this input is inactive the system must not move into an operating mode that requires higher power consumption.

See the *ARM PrimeCell GPIO (PL061) Technical Reference Manual* for details on enabling alternate functions.

- **PWRFAIL** This primary input to the interrupt controller signals an emergency power failure. Software must respond immediately by:
  - switching off any high power consumption peripherals, such as LCD back lights and displays
  - moving the system from NORMAL to SLOW mode
  - storing important application state
  - placing the system into SLEEP mode.

The ARM926EJ-S Development Chip does not implement hardware to facilitate the above functions. It is the responsibility of software to check the **BATOK** input before raising the systems power consumption.

Software must also handle the **PWRFAIL** interrupt correctly.

#### 2.1.5 System controller registers

The system controller registers start at memory location 0x101E0000.

For detailed information on the System Controller registers, see the *ARM PrimeCell System Controller (SP810) Technical Reference Manual.* 

#### 2.1.6 Watchdog and Timer module clock enable generation

Enable signals are generated to enable the Timer and Watchdog modules to be clocked at a rate that is independent of the system clock. The enable signals are generated by sampling a free-running, constant frequency clock from the **TIMCLKEXT** input and generating an active HIGH pulse for a single **SCLK** clock cycle on each rising edge of the input clock. This is shown in Figure 2-1 on page 2-5.



#### Figure 2-1 Enable signal generation for the Timer and Watchdog modules

The module enable signals are:

- WDOGCLKEN for the Watchdog module
- **TIMERCLKEN0** for timer clock enable 0
- **TIMERCLKEN1** for timer clock enable 1
- **TIMERCLKEN2** for timer clock enable 2
- **TIMERCLKEN3** for timer clock enable 3.

The enable signal for the Watchdog module is generated from the REFCLK input.

The Timer module enable signals are selectively generated as defined in the System Control Register from either:

- REFCLK
- TIMCLK.

Additionally, to enable the Watchdog and Timer modules to be clocked directly at the system clock rate, it is also possible to selectively force the enable outputs HIGH.

The watchdog clock enable output can be forced inactive by deasserting the **WDEN** input. For example, the **WDEN** input can be used to disable the watchdog timer when the processor core is in a debug state.

#### Watchdog and Timer modules clock enable generation

The Watchdog and Timer modules have clock enable terms generated synchronously to **CLK** by the System Controller:

- WDOGCLKEN
- TIMER1CLKEN
- TIMER2CLKEN
- TIMER3CLKEN
- TIMER4CLKEN.

To enable the Timer and Watchdog module enable signals to be generated at a constant rate independently of the system clock, the signals are derived from asynchronous, fixed-rate clock inputs.

The Watchdog module enable is generated from the **REFCLK** input and a single **WDOGCLKEN** pulse is generated on every rising edge of **REFCLK**.

The Timer module enable can be selectively generated from either the **REFCLK** or **TIMCLK** inputs. This is shown for **WDOGCLKEN** and **TIMER1CLKEN** in Figure 2-2.





To support debugging the system software, both Timer and Watchdog modules stall when the ARM processor is in Debug mode.

# 2.1.7 PLL frequency control

The PLL frequency control register is provided (SCPLLFCTRL). is not used in the ARM926EJ-S Development Chip.

#### 2.1.8 System mode control

A system mode control state machine is provided to define the source of the system clock and System Controller clock inputs.

—— Note ———

Most applications only use NORMAL mode. The other modes are used for special power down conditions.

The state machine is controlled using three mode control bits in the system control register, which define the required system operating mode. The modes are controlled by the mode control bits:

1xx	If the <i>Most Significant Bit</i> (MSB) is set then the system moves into NORMAL mode.
01x	If the MSB is not set and the next MSB is set then the system moves into SLOW mode. This is described in <i>SLOW mode</i> on page 2-10.
001	If only the <i>Least Significant Bit</i> (LSB) is set then the system moves into DOZE mode. This is described in <i>DOZE mode</i> on page 2-10.
000	If none of the mode control bits are set the system moves into SLEEP mode. This is described in <i>SLEEP mode</i> on page 2-9.

— Note —

x denotes that the bit can be set to 0 or 1.

When the required operating mode has been defined in the system mode control register the system mode control state machine moves to the required operating mode without further software interaction.

The current system mode is output on the **SYSMODE[3:0]** bus and can also be read back by the processor using the ModeStatus bit in the SCCTRL Register.

Following a power-on reset the system mode control state machine enters DOZE mode.

— Note —

It is the responsibility of the system integrator to ensure that all the required clock sources are active and stable before the power-on reset is released and system operation begins.

If the **nPOR** input is activated, the state machine and the required operating mode in the system control register are set to DOZE. If the **PRESETn** input is activated, the system mode control state machine does not change mode but the required operating mode is set to DOZE in the system control register.



Figure 2-3 System mode control state machine

It is possible to override the mode control bits (in the system control register) when an interrupt is generated by the VIC, see *Interrupt response mode* on page 2-3. The state transitions are shown in Figure 2-3 on page 2-8.

The signal states that are required to achieve the modes and transitions shown in Figure 2-3 on page 2-8 are listed in Table 2-1.

Transition/mode	Signal				
Transition/mode	XTALEN	XTALRQSW	PLLEN	PLLRQSW	SLEEPMODE
NORMAL	1	1	1	1	0
SW from PLL	1	1	1	0	0
SW to PLL	1	1	1	1	0
PLL CTL	1	1	1	0	0
SLOW	1	1	0	0	0
SW from XTAL	1	0	0	0	0
SW to XTAL	1	1	0	0	0
XTAL CTL	1	0	0	0	0
DOZE	0	0	0	0	0
SLEEP	0	0	0	0	1

Table 2-1 System mode control signal states

#### SLEEP mode

In SLEEP mode, the system clocks, **HCLK** and **CLK**, are disabled and the System Controller clock, **SCLK**, is driven from a slow speed oscillator (nominally 32768Hz).

When either a FIQ or an IRQ interrupt is activated (through the VIC) the system moves into the DOZE mode. Additionally, the required operating mode in the system control register automatically changes from SLEEP to DOZE.

—— Note ———

Before entering SLEEP mode you must ensure that the processor is in the Wait-for-interrupt state. Processor status is determined by the **STANDBYWFI** output from the processor.

## DOZE mode

In DOZE mode, the system clocks and the System Controller clock are driven from a low frequency oscillator.

From DOZE mode it is possible to move into SLEEP mode when none of the mode control bits are set and the processor is in Wait-for-interrupt state.

If SLOW mode or NORMAL mode is required the system moves into the XTAL control transition state to initialize the crystal oscillator.

# XTAL control transition state, XTAL CTL

XTAL control transition state is used to initialize the crystal oscillator. While in this state, both the system clocks and the System Controller clock are driven from a low-frequency oscillator.

The system moves into the Switch to XTAL transition state when the crystal oscillator output is stable. This is indicated when either the Xtal timeout defined in the Xtal Control Register expires (when the **XTALTIMEEN** input is valid) or by the **XTALON** input being set to logic 1.

## Switch to XTAL transition state, SW TO XTAL

Switch to XTAL transition state is used to initiate the switching of the system clock source from the slow speed oscillator to the crystal oscillator.

The system moves into the SLOW mode when the **XTALSW** input is set to a logic 1, to indicate that the clock switching is complete.

## Switch from XTAL transition state, SW FROM XTAL

Switch from XTAL transition state is entered when moving from the SLOW mode to DOZE mode. It initiates the switching of the system clock source from the crystal oscillator to the slow speed oscillator.

The system moves into the DOZE mode when the **XTALSW** input is reset to a logic 0, to indicate that the clock switching is complete.

## SLOW mode

In SLOW mode, both the system clocks and the System Controller clock are driven from the output of the crystal oscillator. If NORMAL mode is required the system moves into the PLL control transition state. If neither the SLOW or the NORMAL mode control bits are set the system moves into the Switch from XTAL transition state.

# PLL control transition state, PLL CTL

PLL control transition state is used to initialize the PLL. In this mode both the systems clock and the System Controller clock are driven from the output of the crystal oscillator.

The system moves into the Switch to PLL transition state when either:

- the PLL timeout define in the PLL control register expires (when the **PLLTIMEEN** input is valid)
- the **PLLON** input is set to logic 1.

# Switch to PLL transition state, SW TO PLL

Switch to PLL transition state is used to initiate the switching of the system clock source from the crystal oscillator to the PLL output.

The system moves into the NORMAL mode when the **PLLSW** input is set to a logic 1, to indicate that clock switching is complete.

## Switch from PLL transition state, SW FROM PLL

Switch from PLL transition state is entered when moving from the NORMAL mode to SLOW mode. It initiates the switching of the clock sources from the PLL to the crystal oscillator output.

The system moves into the SLOW mode when the **PLLSW** input is reset to a logic 0, to indicate that clock switching is complete.

# NORMAL mode

In NORMAL mode both of the system clocks and the System Controller clock are driven from the output of the PLL.

If the NORMAL mode control bit is not set the system moves into the Switch from PLL transition state.

# **Core clock control**

To enable the software to control the relative frequency of the core clock, **CLK**, and the bus clock, **HCLK**, the System Controller provides access to the **HCLKDIVSEL[2:0]** output through the system control register. These output signals are intended for use by the clock generation logic to control the generation of the **CLK/HCLK** clock source and the **HCLKEN** input.

To prevent spurious changes of the **CLK/HCLK** clock ratio, the **HCLKDIVSEL** output can only change when the system mode control state machine is in a stable state. That is, the actual system mode matches the required system mode.

# **HCLK to CLK relationship**

HCLK and CLK are synchronous. In a very simple clock generation case, HCLK and CLK can be tied together and then HCLKEN is tied HIGH. This means that there is a 1:1 relationship between the CPU core clock and the bus clock HCLK.

Using this configuration limits the frequency that the core can run at to the maximum frequency supported by **HCLK**. To use the higher operating frequency capability of the core, **CLK** must operate at a multiple of the **HCLK** frequency. Configuration of this is supported by the system control register. **HCLK** can be set as equal to, divided by two, divided by three, or divided by four of **CLK**. This configuration is independent of operating mode. However, modes other than NORMAL only ever have to use 1:1.

# 2.2 Clock control

The operation of the clock and reset controller is described in the following sections:

- Overview
- SDRAM interaction with frequency and power modes on page 2-17
- *Peripheral clock selection* on page 2-18
- Watchdog and Timer module clock enable generation on page 2-4
- *PLL frequency control* on page 2-6
- System mode control on page 2-7
- System controller registers on page 2-4.

#### 2.2.1 Overview

The block diagram for the clock and reset circuit is shown in Figure 2-4.



#### Figure 2-4 Clock and reset block diagram



An example of external clock sources for the CPU, memory, and bus clocks is shown in Figure 2-5.

Figure 2-5 External clock signals and clock selection

The clock and reset controller has two modes of operation for driving the processor clocks:

- Use the on-chip PLL to de-skew on-chip clocks with respect to the off-chip reference clock **XTALCLKEXT**.
- Drive the on-chip **CPUCLK** master clock from one of three asynchronous off-chip clocks: **REFCLK32K**, **PLLCLKEXT**, or **XTALCLKEXT**.

The clock and reset controller generates two clocks for the AHB bridges:

• The internal **HCLK** is always used to control the internal side of the AHB bridges.

**HCLK** is also used to clock the external part of the bridges for synchronous 1:1 operating mode.

• The external part of the three AHB bridges can be driven by **HCLKEXT** in synchronous mode if the clock ratio is not 1:1.

The external part of the three AHB bridges can also be driven by an external clock (**HCLKM1** for master 1, **HCLKM2** for master 2, or **HCLKS** for the slave bus) for asynchronous operating mode.

All ARM926EJ-S Development Chip clocks, except for the System Controller clock itself (SCLK), are turned off in SLEEP mode.

Using the PLL to de-skew the on-chip clocks with respect to **XTALCLKEXT** allows synchronous AHB bridges to be used for low latency data transfer across the chip boundary. The **XTALCLKEXT** frequency must meet the minimum PLL input frequency requirement. The PLL also multiplies **XTALCLKEXT** to allow the processor clock and AMBA subsystem clocks to be at higher frequencies. As the PLL is the only source of clocks for the processor and AMBA subsystem the frequency cannot be changed during normal operation. The clock ratio between the processor, AMBA subsystem and **XTALCLKEXT** is fixed after reset. Changes in the System Controller state machine have no affect on the clocks though it can still move through the power management states and application software will be unaffected.

Driving the on-chip clocks from one of three asynchronous off-chip clocks (**REFCLK32K**, **PLLCLKEXT**, or **XTALCLKEXT**) allows the System Controller state machine to select the clock source. The System Controller can switch between clocks running at different speeds as part of a power management strategy. It can also change the processor to AMBA subsystem clock ratio. The on-chip PLL cannot be used to de-skew clocks as the input frequencies may be outside of the PLL specification. The skew between on-chip and off-chip clocks requires asynchronous AHB bridges to be used. The data transfer latency of asynchronous bridges is much higher than that of the synchronous bridges.

In the example shown in Figure 2-5 on page 2-14 and with the default clock and configuration values:

- The 24MHz oscillator provides the **XTALCLKEXT** input clock for the PLL in the ARM926EJ-S Development Chip.
- The PLL output **CPUCLK** is used as the CPU core clock and as the input to the **HCLK** divider.
- HCLK is CPUCLK divided by 1, 2, 3, or 4 depending on the value of CFGHCLKDIVSEL[1:0]. HCLK is used as the SDRAM clock MPMCCLK, and as the inputs to the MBX and SMC clock dividers.
- HCLKEXT is HCLK divided by 1 to 8 depending on the value of CFGHCLKEXTDIVSEL[2:0]. HCLKEXT is the reference clock for the external part of the AMBA bridges M1, M2, and S. This clock is the feedback clock for the PLL, therefore the frequency of HCLKEXT is the same as that of XTALCLKEXT.

The system controller in the ARM926EJ-S Development Chip can switch the system into power-saving modes (slow, doze, and sleep).

In the power-saving modes, the external low-frequency clocks are used as **CPUCLK**. Because of the low-speed external clock, the AHB bridges typically operate in the lower performance asynchronous mode and are controlled by external clocks **HCLKM1**, **HCLKM2**, and **HCLKS**.

The following signals control the internal multiplexors in the ARM926EJ-S Development Chip:

- **CFGPLLBYPASS** Bypasses the PLL and uses **XTALCLKEXT** as the input to the **CPUCLK** multiplexor. The default is LOW, the PLL output is used.
- CFGUSEPLL Selects an external clock (REFCLK32K, PLLCLKEXT, or XTALCLKEXT) instead of the PLL output as CPUCLK. The default is HIGH, the output from the PLL multiplexor is used and the power-saving modes are disabled.

#### 2.2.2 SDRAM interaction with frequency and power modes

The SDRAM refresh period is programmed into the MPMC in **HCLK** tick units. This setting must be reprogrammed when the operating frequency of the ARM926EJ-S Development Chip changes (when the PLL frequency control is altered or if the system switched operating mode between NORMAL or SLOW). When moving to:

- a higher HCLK frequency the refresh period must be updated after the transition
- a lower **HCLK** frequency the refresh period must be updated before the transition to a setting suitable for the target operating frequency.

Before entering operating modes where the **HCLK** frequency is very low or stalled (DOZE and SLEEP modes) the SDRAM must be put into self-refresh mode. In this mode the SDRAM is not accessible.

—— Note ———

Other peripherals, such as the SCI, must have the correct shutdown sequence applied before the system can be put into the DOZE or SLEEP mode.

— Note — \_\_\_\_

The feedback clock to the MPMC and SSMC are input to the clock selection and gating block shown in Figure 2-4 on page 2-13. **MPMCFBCLK[3:0]** and **SMFBCLK[3:0]** are only buffered in this block.

## 2.2.3 Peripheral clock selection

The external clock signals are user-defined off-chip clocks. They are gated by the System Controller outputs **PERIPHCLKENx**. Alternatively, the peripheral clocks may be derived from **HCLK**.

In normal operation the System Controller output **PERIPHCTRL0x** selects the clock source. To ensure correct operation of the peripheral **PERIPHCTRL0x** should not change state while the gate is enabled. At reset the **PERIPHCTRL0x** outputs are set low by the system controller, therefore selecting the External Clocks.

External Clock	Peripheral Clock	PERIPHCLKENx and PERIPHCLKSTATx	PERIPHCTRL0x
CLCDCLKEXTIN	CLCDCLK	3	3
SSPCLKEXTIN	SSPCLK	4	4
SCIREFCLKEXTIN	SCIREFCLK	5	5
UARTCLKEXTIN	UARTCLK0	6	6
UARTCLKEXTIN	UARTCLK1	7	7
UARTCLKEXTIN	UARTCLK2	8	8

Table 2-1 External peripheral clocks and clock control sig	gnals
--	-------

# 2.3 External configuration signals

The configuration block is used to define the operating mode of the chip. It samples the state of **HDATAM2[28:0]** pads while the rest of the chip is held in reset. The state of these pads can then be held to drive configuration signals within the chip. The operating mode of the chip is then defined when reset is released.

—— Note ———

In a typical device, the configuration signals would be tied HIGH or LOW. The configuration signals are brought out of the chip to allow different system settings to be tested with the ARM926EJ-S Development Chip.

The configuration block reset **nCONFIGRST** and clock **CONFIGINIT** are independent of the rest of the chip. While the chip is held in reset the configuration block can be reset and sample the input data **CONFIGDATA[28:0]** to set the mode of the chip. The chip can then be released from reset and operate in the defined mode. The reset state of the configuration signals defines a default mode that can be used instead of sampling pads on reset.

See Table 2-2 for the source of the configuration signals and Table 2-3 on page 2-20 for the destination of the configuration signals.

Signal name	Source	Description
CONFIGDATA[28:0]	HDATAM2[28:0]	Configuration signals from data bus pads.
nCONFIGCLR	Clock and reset controller	Force all configuration signals to reset state (active LOW).
CONFIGINIT	Clock and reset controller	Sample status of pads on rising edge.

#### Table 2-2 Configuration signal sources

Signal name	Destination	Description
CFGCPUVINITHI	ARM926EJ-S processor VINITHI	Determines the reset location of the exception vectors for the ARM926EJ-S processor.When LOW, the vectors are located at 0x0000000. When HIGH, the vectors are located at 0xFFFF0000.
		<b>HDATAM2[0]</b> during reconfiguration.
CFGCPUBIGENDIN	ARM926EJ-S processor BIGENDINIT	Defines the byte endian mode at reset. When LOW, little endianness is used. When HIGH, big endianness is used.
		The reset value is 0. The value is loaded from <b>HDATAM2[1]</b> during reconfiguration.
CFGVFPENABLE	Clock and reset controller and coprocessor multiplexor.	VFP9-S coprocessor enable (active HIGH). The reset value is 1. The value is loaded from <b>HDATAM2[2]</b> during reconfiguration.
CFGMPMCnSMC	ARM926EJ-S Development Chip AMBA infrastructure MPMCnSMC	Defines which static memory controller is used. When LOW, the SMC is used. When HIGH, the MPMC is used.
		The reset value is 0. The value is loaded from <b>HDATAM2[3]</b> during reconfiguration.
CFGREMAPSTEXEN	ARM926EJ-S Development Chip AMBA infrastructure.	Static memory and expansion memory alias enable. When HIGH and <b>CFGREMAPDYEXEN</b> is LOW, then static memory is aliased to 0x00000000. When HIGH and <b>CFGREMAPDYEXEN</b> is HIGH, then expansion memory is aliased to 0x00000000. The reset value is 1. The value is loaded from <b>HDATAM2[4]</b> during reconfiguration.

## Table 2-3 Configuration signal destinations

Signal name	Destination	Description
CFGREMAPDYEXEN	ARM926EJ-S Development Chip AMBA infrastructure	Dynamic memory and expansion memory alias enable. When HIGH and <b>CFGREMAPSTEXEN</b> is HIGH, then expansion memory is aliased to 0x00000000.
		Note
		The combination of CFGREMAPDYEXEN HIGH and CFGREMAPSTEXEN LOW is reserved and must not be used.
		The reset value is 0. A new value is loaded from <b>HDATAM2[5]</b> during reconfiguration.
CFGBRIDGEMEMMAP	ARM926EJ-S Development Chip AMBA infrastructure	Select memory map for the off-chip bridges. The reset value is 1. A new value is loaded from <b>HDATAM2[6]</b> during reconfiguration.
CFGUSEPLL	Clock and reset controller	Uses the on-chip PLL to drive the processor and AMBA subsystem (active HIGH). The reset value is 1. A new value is loaded from HDATAM2[10] during reconfiguration.
CFGPLLBYPASS	Clock and reset controller	Forces the PLL output to be bypassed (active HIGH). The reset value is 0. A new value is loaded from
		HDAIAM2[11] during reconfiguration.
CFGPLLSHORTFB	Clock and reset controller	Removes the clock tree delay from the PLL feedback (active HIGH).
		The reset value is 0. A new value is loaded from <b>HDATAM2[12]</b> during reconfiguration.
CFGHCLKDIVSEL[1:0]	Clock and reset controller	Sets the <b>CLK</b> to <b>HCLK</b> divide ratio. The divide value is set as follows: b00 = 1 b01 = 2 b10 = 3 b11 = 4. The reset value is b01. A new value is loaded from <b>HDATAM2[14:13]</b> during reconfiguration.

## Table 2-3 Configuration signal destinations (continued)

Signal name	Destination	Description
CFGHCLKEXTDIVSEL[2:0]	Clock and reset controller	Sets the <b>HCLK</b> to <b>HCLKEXT</b> divide ratio. The divide value is set as follows: b000 = 1 b001 = 2 b010 = 3 b011 = 4 b100 = 5 b101 = 6 b110 = 7 b111 = 8. The reset value is b001. A new value is loaded from <b>HDATAM2[17:15]</b> during reconfiguration.
CFGMBXCLKDIVSEL[1:0]	MBX Graphics Accelerator, CLKRATIO[1:0]	Sets the <b>HCLK</b> to <b>MBXCLK</b> divide ratio. The divide value is set as follows: b00 = 1 b01 = 2 b10 = 3 b11 = 4. The reset value is b01. A new value is loaded from <b>HDATAM2[19:18]</b> during reconfiguration.
CFGSMCCLKDIVSEL[1:0]	SSMC, SMMEMCLKRATIO[1:0]	Sets the <b>HCLK</b> to <b>SMCLK</b> divide ratio for SSMC. The divide value is set as follows: b00 = 1 b01 = 2 b10 = 3 b11 = 4. The reset value is b01. A new value is loaded from <b>HDATAM2[21:20]</b> during reconfiguration.
CFGAHBM1ASYNC	Off-chip AHB bridge 1 and clock and reset controller	Force off-chip bridge 1 to asynchronous mode (active HIGH). The reset value is 0. A new value is loaded from <b>HDATAM2[22]</b> during reconfiguration.
CFGAHBM2ASYNC	Off-chip AHB bridge 2 and clock and reset controller	Force off-chip bridge 2 to asynchronous mode (active HIGH). The reset value is 0. A new value is loaded from <b>HDATAM2[23]</b> during reconfiguration.

# Table 2-3 Configuration signal destinations (continued)

Signal name	Destination	Description
CFGAHBSASYNC	On-chip AHB bridge and clock and reset controller	Force the on-chip bridge to asynchronous mode (active HIGH).
		The reset value is 0. A new value is loaded from <b>HDATAM2[24]</b> during reconfiguration.
CFGAHBPASST	All AHB bridges	Switch the off-chip and on-chip bridges to pass-through mode (active HIGH).
		The reset value is 0. A new value is loaded from <b>HDATAM2[25]</b> during reconfiguration.
CFGINCROVERRIDEM1	Off-chip AHB bridge 1	Override burst transfer with INCR mode (active HIGH).
		The reset value is 0. A new value is loaded from <b>HDATAM2[26]</b> during reconfiguration.
CFGINCROVERRIDEM2	Off-chip AHB bridge 2	Override burst transfer with INCR mode (active HIGH).
		The reset value is 0. A new value is loaded from <b>HDATAM2[27]</b> during reconfiguration.
CFGINCROVERRIDES	On-chip AHB bridge	Override burst transfer with INCR mode (active HIGH).
		The reset value is 0. A new value is loaded from <b>HDATAM2[28]</b> during reconfiguration.

## Table 2-3 Configuration signal destinations (continued)



Figure 2-6 Power-on configuration block diagram

# 2.4 JTAG logic

The JTAG interface can control one of two TAP controllers. When **nBSTAPEN** is LOW the boundary scan TAP controller is selected. The boundary scan TAP controller is a Synopsys DesignWare component. When **nBSTAPEN** is HIGH the ARM926EJ-S processor TAP controller is selected. This is part of the ARM926EJ-S processor debug features.

The ARM926EJ-S processor TAP controller runs at core clock frequency and so some signals must pass through a Multi-ICE Synchronization block. A return clock RTCK is provided to indicate when TDO is valid.

Figure 2-7 on page 2-26 shows how the JTAG interface is connected to the boundary scan TAP controller and ARM926EJ-S processor.

\_\_\_\_\_ Note \_\_\_\_\_

There are Pull-ups on input pins nTRST, TDI and TMS.

Figure 2-8 on page 2-27 shows how the Multi-ICE synchronization registers are inserted between the JTAG test access port and the ARM926EJ-S processor.



Figure 2-7 JTAG Test Access Port



Figure 2-8 Multi-ICE synchronization

# 2.5 Implementation details for the ARM926EJ-S and system controller

The following ARM926EJ-S inputs are tied off:

- **DBGEN** is tied HIGH
- **DBGDEWPT** is tied LOW
- **DBGEXT[1:0]** are tied LOW
- **DBGIEBRKPT** is tied LOW.

The following ARM926EJ-S outputs are unconnected:

- DBGINSTREXEC
- DBGIR[3:0]
- DBGRNG[1:0]
- DBGRQI
- DBGSCREG[4:0]
- DBGSDIN
- DBGTAPSM[3:0]
- STANDBYWFI.

The following ETM inputs are tied off:

- **EXTIN**[3:1] are tied LOW
- MMDIN[15:0] are tied LOW
- **SYSOPT[8:0]** are tied off to b010111010.

The following ETM outputs are unconnected:

- MMDCTRL[7:0]
- MMDDA[31:0]
- MMDDnRW
- MMDDnMREQ
- MMDIA[31:1]
- MMDInMREQ
- MMDITBIT.

The following system controller inputs are tied off:

- **PERIPHCLKSTAT[2:0]** are tied LOW.
- **PERIPHCLKSTAT**[15:9] are tied LOW.
- **PERIPHCLKSTAT[31:19]** are tied LOW.

The following system controller outputs are unconnected:

- PERIPHCLKENx[2:0]
- PERIPHCLKENx[15:9]
- PERIPHCLKENx[31:19]
- PERIPHCTRLx[2:0]
- PERIPHCTRLx[15:9]
- PERIPHCTRLx[31:19]
- PLLFREQCTRL[31:9].

The following memory map controls inputs are tied off:

- **MOVESTATIC** is tied LOW
- **MOVESDRAM** is tied HIGH.

# 2.6 Control, configuration, and test signals on pads

This section lists control, configuration, and test signals on the input/output pads.

\_\_\_\_\_ Note \_\_\_\_\_

For details on AHB signals, see Chapter 3 *Memory Map and Memory Configuration* and Chapter 4 *AHB Monitor*.

For details on other peripherals and controllers, see the chapter describing the component.

In order to simplify finding signal information, some signals appear in more than one table. For example TCK is in both Table 2-7 on page 2-32 and Table 2-8 on page 2-33.

Table 2-4 lists the debug signals for the ARM926EJ-S.

Signal Name	Туре	Description
DBGACK	Output	Debug acknowledge indicates when the ARM CPU is in debug state (active HIGH).
EDBGRQ	Input	External request for ARM to enter debug state (active HIGH).

Table 2-4 ARM926EJ-S signals

Table 2-5 lists the ETM signals.

#### Table 2-5 ETM signals

Signal Name	Туре	Description
ETMEXTIN	Input	Debug cross trigger support.
ETMEXTOUT[3:0]	Output	Debug cross trigger support.
PIPESTAT[2:0]	Output	Pipeline status
TRACECLK	Output	Trace clock
TRACEPKT[15:0]	Output	Trace packet port
TRACESYNC	Output	Trace synchronization

Table 2-6 lists the reset and configuration signals.

# Table 2-6 Reset and configuration signals

Signal Name	Туре	Description
nPORESET	Input	This is an active-LOW power-on reset input used to reset the MPMC refresh timer, System Controller, and the Clock and Reset Controller.
CONFIGDATA[28:0]	Inputs	Configuration inputs on <b>HDATAM2[28:0]</b> sampled at reconfiguration. (See <i>External configuration signals</i> on page 2-19 for details.)
nCONFIGCLR	Input	This resets all of the configuration bits before <b>nPORESET</b> and <b>nRESET</b> are released.
CONFIGINIT	Input	Samples the status of pads to define the configuration signals (rising edge).
nRESET	Input	System reset (active LOW).
TESTSELECT	Input	Manufacturing test mode select. This signal is asynchronous and should be static after reset. Signals form the Configuration block and the Clock and Reset Controller are forced to a known state.
		Note
		This signal is used for manufacturing test only and must always be held LOW.
SCANENABLE	Input	Manufacturing test mode scan enable.
		Note
		This signal is used for manufacturing test only.
BIGENDOUT	Output	Byte endian mode.

# Table 2-7 lists the clock signals.

#### Table 2-7 Clock signals

Clock	Direction	Description
XTALCLKEXT	Input	If the on-chip PLL is used, this input is the reference clock for the PLL. If the on-chip PLL is not used, this input can drive the processor and AMBA subsystem clocks. This clock can be selected from the System Controller.
PLLCLKEXT	Input	If the on-chip PLL is not used, this input can drive the processor and AMBA subsystem clocks. This clock can be selected from the System Controller
HCLKM1	Input	This input provides an alternative clock source that can be used to time the external part of the M1 bus.
HCLKM2	Input	This input provides an alternative clock source that can be used to time the external part of the M2 bus.
HCLKS	Input	This input provides an alternative clock source that can be used to time the external part of the S bus.
CLCDCLKEXT	Input	This input is used to drive the external interface of the CLCDC.
REFCLK32K	Input	This input provides a constantly running slow frequency used to provide a timing reference for the Timer and Watchdog modules at a nominal rate of 32kHz (32768Hz).
RTC1HZCLK	Input	This input is used to clock the RTC timer at a nominal rate of 1Hz.
SCIREFCLKEXT	Input	This input is used to drive the external interface of the SCI.
SSPCLKEXT	Input	This input is the clock for the SSP external interface.
TIMCLKEXT	Input	This input provides an alternative clock source that can be used by the ARM926EJ-S Development Chip Timer modules. It must remain constant when the PLL frequency is varied. It is required to provide the Timer modules with at least 10µs resolution and must therefore be at least 100KHz although much higher frequencies can also be used.
UARTCLKEXT	Input	This input provides an alternative clock source that can be used to derive the UART baud frequencies.
nPLLRESET	Input	On-chip PLL reset (active LOW).
PLLPWRDN	Input	On-chip PLL power down (active HIGH).
ТСК	Input	This input is the JTAG clock
RTCK	Output	This output is the returned JTAG clock
#### Table 2-7 Clock signals (continued)

Clock	Direction	Description
MPMCCLK[4:0]	Output	These are the output clocks from the MPMC.
SMCLK[2:0] Output		These are the output clocks from the SSMC.
SMFBCLK	Input	This input is the feedback clock for the SSMC.

Table 2-8 lists the JTAG signals.

#### Table 2-8 JTAG TAP signals

Signal Name	Туре	Description
ТСК	Input	Test clock.
TMS	Input	Test mode select.
nTRST	Input	Test reset (active LOW).
TDI	Input	Boundary scan input.
nBSTAPEN	Input	When LOW the boundary scan TAP controller is selected. When HIGH the Multi-ICE processor debug interface is selected.
TDO	Tristate output	Boundary scan output.
RTCK	Output	Mullet-ICE TCK synchronization.

System Controller and Configuration Logic

# Chapter 3 Memory Map and Memory Configuration

This chapter describes the AMBA buses and the memory configuration options. It contains the following sections:

- Overview of the AMBA buses in the ARM926EJ-S Development Chip on page 3-2
- *Memory map options* on page 3-15
- *AHB signals to pads* on page 3-32.

# 3.1 Overview of the AMBA buses in the ARM926EJ-S Development Chip

The ARM926EJ-S Development Chip bus architecture is described in the following sections:

- About the bus architecture
- Bus matrix on page 3-3
- *AHB restrictions* on page 3-6.

#### \_\_\_\_\_Note \_\_\_\_\_

The bus system for the ARM926EJ-S Development Chip is highly configurable. This enables the chip to emulate many different system designs, but it also complicates configuration and use. The main areas of bus use that require attention are:

- selecting the physical memory that is accessed at 0x0 after a reset
- handling accesses to undefined areas that are remapped to external buses
- enabling the static controller for static memory
- recognizing that some buses cannot access devices located on a different bus
- identifying bus masters that can access different memory regions in parallel.

For a production device based on the ARM926EJ-S, most of these issues would be resolved before the device was designed. However, many of these design choices must be handled by program design or configuration settings in ARM926EJ-S Development Chip the because it was produced for use in a development environment.

For more details on signals related to bus access, see the following manuals:

- ARM926EJ-S PrimeXSys Virtual Component Technical Reference Manual
- ARM926EJ-S Integration Guide
- AMBA Specification
- AMBA Design Kit Technical Reference Manual
- AHB EASY Technical Reference Manual

#### 3.1.1 About the bus architecture

The ARM926EJ-S Development Chip peripherals are interconnected to enable maximum flexibility in the final SoC performance by extensive use of multilayer *Advanced High-performance Bus* (AHB). The multilayer AHB architecture provides a performance advantage by enabling multiple bus masters to be active in parallel. For example, the DMAC can transfer data to the UART, while the CLCDC fetches data from the MPMC and the ARM processor accesses the Timer modules.

Six AHB buses are provided:

ARM I AHB	This bus is used by the instruction fetch port of the ARM926EJ-S processor and has access to the memory interfaces. This AHB supports external bus slaves.					
ARM D AHB	This bus is used by the data bus port of the ARM926EJ-S processor and has access to all of the ARM926EJ-S Development Chip peripherals. This AHB supports external bus slaves.					
CLCDC AHB	This bus is used by the ARM926EJ-S Development Chip CLCDC to fetch display data from either of the memory interfaces. The AHB supports external bus slaves.					
DMA0 AHB	This bus is used for DMA peripheral accesses and is connected to the DMA APB bridge. External bus slaves are supported.					
DMA1 AHB	This bus is used for DMA memory accesses and is connected to the memory interfaces. External bus slaves are supported.					
Expansion AHB	An expansion AHB bus supports the external M1 and M2 master buses and the S slave bus.					
Two Advanced Peripheral Buses (APBs) are provided. They are:						
<b>DMA APB</b> This bus is used to access the APB peripherals that are required to support						

- DMA APB This bus is used to access the APB peripherals that are required to support DMA transfers. This APB supports external APB expansion with 11 external APB select lines provided.
- **Core APB** This bus is used to access the APB peripherals that are required by the ARM926EJ-S processor.

#### 3.1.2 Bus matrix

TheARM926EJ-S Development Chip bus matrix is implemented in a single module. It is constructed using two basic components:

Input stageThis is used to request access to the required slave port and to<br/>buffer the AHB address phase signals (for example, HADDR and<br/>HTRANS) when access to the slave port is not granted.Output stageThis is used to arbitrate between the input stages that are<br/>requesting access to the slave port.

The interconnect between the various input and output stages define the structure of the bus matrix. For example, Figure 3-1 on page 3-4 shows the implementation of the ARM926EJ-S Development Chip bus matrix.



Figure 3-1 Bus matrix configuration

The ARM926EJ-S PXP Slave Expansion AHB interfaces that are used have only one peripheral connected to them and the ARM926EJ-S PXP Master Expansion AHB interface has only one master connected to it. Consequently no additional AMBA infrastructure components are required.

The ARM Instruction, DMAC 1, DMAC 2 and LCD AHB interfaces from the PXP subsystem are unused. The ARM926EJ-S PXP memory map is modified in this implementation so that no additional peripherals can be accessed via these interfaces.

The multi-layer interconnections are optimized to remove any redundant connections. For instance, the CLCDC master is intended to fetch significant quantities of data from memory devices. The CLCDC cannot usefully fetch data from communications peripherals on the DMA APB bus. Therefore the DMA APB bridge is not connected as a slave on the CLCDC AHB.

Arbitration between the buses only occurs when two or more masters try to gain access to the same slave. The arbitration priority is fixed as:

- 1. CLCDC AHB (highest priority).
- 2. DMA0 AHB.
- 3. Expansion Master AHB
- 4. DMA1 AHB.
- 5. ARM Data AHB.
- 6. ARM Instruction AHB (lowest priority).

The slave arbitration is performed at the start of every transfer and on the quadword boundary of any incrementing burst.

The ARM926EJ-S Development Chip adds four AHB peripherals into the ARM926EJ-S PXP memory map:

- MBX Graphics Accelerator is mapped into a 16MB region at 0x40000000
- The AHB Monitor block is mapped into a 64KB region at 0x101D0000
- Off-chip AHB bridge 1 is mapped into a region defined by **CFGBRIDGEMEMMAP**
- Off-chip AHB bridge 2 is mapped into a region defined by **CFGBRIDGEMEMMAP**.

#### 3.1.3 AHB restrictions

Using a multilayer AHB system requires that certain restrictions are placed on the use of locked transfers to prevent a deadlock situation. A sequence of locked transfers must all be performed to the same slave in the system. A bus master can ensure this restriction is met by ensuring that a locked sequence of transfers remains inside a 1KB address region.

Specifically, if a bus master is to perform two locked transfer sequences to different address regions, the bus master must not start the second locked transfer sequence until the final data phase of the first locked transfer sequence has completed.

#### 3.1.4 AHB bus interfaces

This section describes the AHB bridges that forms part of the ARM926EJS PrimeXsys Platform Development Chip multi-layer AHB system.

#### Off-chip (master) bridges

The off-chip AHB bridges are AMBA compliant bridges that allows AHB masters in the ARM926EJ-S PXP subsystem to access off-chip AHB slave peripherals. The off-chip AHB bridge has the following features:

- AMBA compliant AHB slave and master interfaces.
- Synchronous and asynchronous operation.
- Pass-through mode for cycle accurate modeling.
- Tristate pin control for multi-master AHB systems off-chip.

The block diagrams for the off-chip bus interfaces (M1 and M2) are shown in Figure 3-2 on page 3-7 and Figure 3-3 on page 3-8.



Figure 3-2 AHB M1 interface



Figure 3-3 AHB M2 interface

The bridge AHB master output signals drive the pads of the chip through tristate buffers. As the AHB read and write data buses are never active at the same time, the two are combined onto one set of pads. Tristate buffers allow the write data bus to drive the external AHB data bus. The action of the tristate buffers allows multiple AHB masters to drive the off-chip AHB bus under the control of an external arbiter. The AHB arbiter output signals do not use tristate buffers.

The bridge slave interface is part of the memory map and it will respond to transactions in the appropriate address range. The address input of the slave interface is a full 32-bit address, even though it responds to a decoded address range as it is passed through the bridge unchanged. No address translation is performed. This links the on-chip and off-chip AHB busses and preserves the on-chip address map.

Transactions initiated by the on-chip AHB masters are passed from the slave interface to the master interface of the bridge. The response of off-chip peripherals is then passed back through the bridge. The response of the bridge is dependent on the clock arrangement between the two AHB busses and response of the off-chip peripheral. The bridge will always ensure that AMBA AHB protocols are observed on both AHB busses. To ensure this the slave interface can generate wait states and the master interface can insert BUSY cycles.

A system design outside of the ARM926EJ-S Development Chip might break the AHB protocol. If fixed length bursts are broken by an arbiter on the transfer source side of the bridge, an incomplete burst appears on the destination side of the bridge. To avoid breaking the AHB protocol, set the configuration signals **CFGINCOVERRIDEM1** and **CFGINCOVERRIDEM1** HIGH. All burst information will be converted to INCR. If this situation cannot be encountered due to the system design, fixed length bursts can be passed across the bridges (set **CFGINCOVERRIDEM1** and **CFGINCOVERRIDEM1** LOW).

The bridge can operate in four modes that define the relationship between the on-chip and off-chip AHB bus clocks and the response of the bridge to AHB transfers. These modes are:

- Synchronous 1:1 bridge
- Synchronous N:1 bridge
- Asynchronous bridge
- Pass-through bridge.

The multiplexor control determines which of the bridge clocking modes is to be used as shown in Table 3-1.

CFGAHBASYNC	CFGHCLKEXTDIVSEL[2:0]	CFGAHBPASST	BRIDGESEL[1:0]	Bridge selected
1	xxx	x	00	Asynchronous
0	001-111	x	01	Synchronous N:1
0	000	0	10	Synchronous 1:1
0	000	1	11	Pass-through

#### Table 3-1 On-chip bridge selection

The synchronous 1:1 bridge mode requires that the on-chip and off-chip AHB bus clocks run at the same frequency. The bridge is only provided with the on-chip bus clock. The maximum frequency of the on chip bus clock is restricted by the off-chip bus timing. The paths between the slave and master interfaces of the bridge are registered to provide timing isolation. Registering the AHB signals means that accesses through the bridge incur delays.

The synchronous N:1 bridge mode requires that the on-chip bus clock to runs at an integer multiple of the off-chip AHB bus clock. The bridge is provided with the on-chip bus clock and a clock enable signal. The clock enable indicates which clock edges are valid for the off-chip bus. The maximum frequency of each bus clock is restricted by the timing for that bus and the requirement that the on-chip bus clock must run at an integer multiple of the off-chip bus clock. The paths between the slave and master interfaces of the bridge are registered to provide timing isolation. Registering the AHB signals means that accesses through the bridge incur delays.

The asynchronous bridge mode allows the on-chip and off-chip AHB bus clocks to run at completely independent frequencies. The bridge is provided with two clocks. The maximum frequency of each bus clock is only restricted by the timing for that bus. The paths between the slave and master interfaces of the bridge are registered in both clock domains to provide timing isolation. The registering of the AHB signal paths in both clock domains mean that the bridge will add several clock cycles delay to transactions.

The pass-through bridge mode requires that the on-chip and off-chip AHB bus clocks to run at the same frequency. The bridge is only provided with the on-chip bus clock. The maximum frequency of the on-chip AHB bus clock is limited by the timing of signal paths off and on the chip. The paths between the slave and master interfaces of

the bridge are combinatorial. As there are no registers in the AHB signal paths, the bridge will not add any delay to a transaction. This mode is designed for cycle accurate modeling of on-chip masters accessing off-chip slaves.

#### On-chip (slave) bridge

This section describes the AHB bridge to on-chip peripherals that forms part of the ARM926EJS PrimeXsys Platform Development Chip multi-layer AHB system. The on-chip AHB bridge is an AMBA compliant bridge that allows off-chip AHB masters to access AHB slave peripherals in the ARM926EJ-S PXP subsystem. The on-chip AHB bridge has the following features:

- AMBA compliant AHB slave and master interfaces
- Synchronous and asynchronous operation
- Pass-through mode for cycle accurate modeling
- Tristate pin control for multi-slave AHB systems off-chip.

The bridge slave interface is part of the off-chip AHB memory map and it will respond to transactions in the appropriate address range. The address input of the slave interface is a full 32-bit address, even though it responds to a decoded address range as it is passed through the bridge unchanged. No address translation is performed. This links the on-chip and off-chip AHB busses and preserves the on-chip address map.

Transactions initiated by the off-chip AHB masters are passed from the slave interface to the master interface of the bridge. The response of on-chip peripherals is then passed back through the bridge. The response of the bridge is dependent on the clock arrangement between the two AHB busses and response of the on-chip peripheral. The bridge will always ensure that AMBA AHB protocols are observed on both AHB busses. To ensure this the slave interface can generate wait states and the master interface can insert BUSY cycles.

A system design outside of the ARM926EJ-S Development Chip might break the AHB protocol. If fixed length bursts are broken by an arbiter on the transfer source side of the bridge, an incomplete burst appears on the destination side of the bridge. To avoid breaking the AHB protocol, set the configuration signals **CFGINCOVERRIDES** and **CFGINCOVERRIDES** HIGH. All burst information will be converted to INCR. If this situation cannot be encountered due to the system design, fixed length bursts can be passed across the bridges (set **CFGINCOVERRIDES** and **CFGINCOVERRIDES** LOW).

The bridge can operate in four modes that define the relationship between the on-chip and off-chip AHB bus clocks and the response of the bridge to AHB transfers. These modes are:

- Synchronous 1:1 bridge
- Synchronous N:1 bridge
- Asynchronous bridge
- Pass-through bridge.

The synchronous 1:1 bridge mode requires that the on-chip and off-chip AHB bus clocks to run at the same frequency. The bridge is only provided with the on-chip bus clock. The maximum frequency of the on chip bus clock is restricted by the off-chip bus timing. The paths between the slave and master interfaces of the bridge are registered to provide timing isolation. Registering the AHB signals means that accesses through the bridge incur delays.

The multiplexor control determines which of the bridge clocking modes is to be used as shown in Table 3-1 on page 3-10.

The synchronous 1:N bridge mode requires that the on-chip bus clock runs at an integer multiple of the off-chip AHB bus clock. The bridge is provided with the on-chip bus clock and a clock enable signal. The clock enable indicates which clock edges are valid for the off-chip bus. The maximum frequency of each bus clock is restricted by the timing for that bus and the requirement that the on-chip bus clock must run at an integer multiple of the off-chip bus clock. The paths between the slave and master interfaces of the bridge are registered to provide timing isolation. Registering the AHB signals means that accesses through the bridge incur delays.

The asynchronous bridge mode allows the on-chip and off-chip AHB bus clocks to run at completely independent frequencies. The bridge is provided with two clocks. The maximum frequency of each bus clock is only restricted by the timing for that bus. The paths between the slave and master interfaces of the bridge are registered in both clock domains to provide timing isolation. The registering of the AHB signal paths in both clock domains mean that the bridge will add several clock cycles delay to transactions.

The pass-through bridge mode requires that the on-chip and off-chip AHB bus clocks to run at the same frequency. The bridge is only provided with the on-chip bus clock. The maximum frequency of the on-chip AHB bus clock is limited by the timing of signal paths off and on the chip. The paths between the slave and master interfaces of the bridge are combinatorial. As there are no registers in the AHB signal paths, the bridge will not add any delay to a transaction. This mode is designed for cycle accurate modeling of off-chip masters accessing on-chip slaves.

The block diagrams for the on-chip bus interface is shown in Figure 3-4 on page 3-13.



Figure 3-4 AHB S interface

#### 3.1.5 Endianness

The ARM926EJ-S Development Chip supports both little-endian and big-endian operation. The endianness required is configured using bit 7 of Register 1 of CP15 in the ARM926EJ-S system control coprocessor. The ARM926EJ-S Development Chip provides the **BIGENDOUT** output signal so that components outside the ARM926EJ-S Development Chip can also be configured for endianness using this control.

Following a reset, the ARM926EJ-S Development Chip defaults to the endianness defined by the **CFGCPUBIGENDIN** input signal (this signal connects to the internal **BIGENDINIT** signal). The B-bit in the ARM926EJ-S CP15 r1 Register is set to the same state as **BIGENDINIT** at the time of reset. When **BIGENDINIT**=0 then little-endian mode is selected.

## 3.2 Memory map options

Supporting several memory configurations and operating systems requires some configurability of the memory map.

#### CFGBRIDGEMEMMAP

This signal defines the memory regions occupied by AHB bridge1 and AHB bridge 2. Accesses to memory regions that are not decoded on-chip are presented to one of the off-chip bridges. If an external device does not acknowledge the request, a bus fault is generated.

#### MPMCnSMC

This signal defines the controller that is used to access static memory. If HIGH, the MPMC controls static memory. If LOW, the SMC controls static memory.

#### REMAPSTATIC

When HIGH the region at 0x0000000 is mapped to SSMC chip select 7 if **MPMCnSMC** is LOW or MPMC chip select 1 if **MPMCnSMC** is HIGH.

#### REMAPEXTERNAL

When HIGH and **REMAPSTATIC** is LOW and **REMAPMPMCCS5** is LOW, then the region at 0x00000000 is mapped externally to the ARM926EJ-S Development Chip.

#### **REMAPMPMCCS5**

When HIGH and **REMAPSTATIC** is LOW, then the region at 0x00000000 is mapped to the MPMC dynamic memory chip select 1 (**nMPMCDYCS1**).

The control logic is shown in Figure 3-5 on page 3-16.



Figure 3-5 Memory control signals

#### 3.2.1 TCM

The ARM926EJ-S Development Chip contains 32KB of data Tightly Coupled Memory (TCM) and 32KB of instruction TCM.

\_\_\_\_\_ Note \_\_\_\_\_

Both TCMs operate with one wait state. The TCMs do not support DMA.

The caches, TCMs, *Memory Management Unit* (MMU), and most other system options are controlled using CP15 registers. You can only access CP15 registers with MRC and MCR instructions in a privileged mode. CDP, LDC, STC, MCRR, and MRRC instructions, and unprivileged MRC or MCR instructions to CP15 cause the UNDEFINED instruction exception to be taken.

#### 3.2.2 Memory map for internal buses

This section shows the memory map for each of the buses in the bus matrix and for different bus mapping configurations.

#### 3.2.3 Selection between MPMC and SSMC as static memory controller

The chip selects for static memory are determined by the state of the **MPMCnSMC** signal:

- If HIGH, the MPMC controls the static memory buses.
- If LOW, the SSMC controls static memory.

—— Note ———

Dynamic memory is always controlled by the MPMC and the **MPMCnSMC** signal has no effect on the MPMC SDRAM bank select signals.

The multiplexing of the chip select signals from the MPMC and SSMC is done inside the ARM926EJ-S Development Chip before the memory remapping circuitry modifies the chip select lines.

This section describes the memory map after booting has completed and memory is mapped to its normal location. For details on aliasing of memory to the boot memory range at 0x0000000–0x03FFFFF, see *AHB memory alias for low memory* on page 3-25.

The memory map for control signals **CFGBRIDGEMEMMAP** HIGH and **MPMCnSMC** LOW is shown in Figure 3-6 on page 3-18.

Expansion AHB S		DMA0		ARM I, LCD & DMA1	ARM D	
AHB Bridge 1 to Off-		AHB Bridge 1 to Off-		AHB Bridge 1 to Off-	AHB Bridge 1 to Off-	0xffffffff
chip Peripherals		chip Peripherals		chip Peripherals	chip Peripherals	0x80000000
MPMC MPMCDYCS3				MPMC MPMCDYCS3	MPMC MPMCDYCS3	0x7FFFFFFF
SDRAM MPMCDYCS2				SDRAM MPMCDYCS2	SDRAM MPMCDYCS2	0x7000000
					AHB Bridge 2 to Off-	0x6FFFFFFF
AHB Bridge 2 to Off-				AHB Bridge 2 to Off-	chip Peripherals	0x41000000
chip Peripherals				chip Peripherals	MBX	0x40FFFFFF
		AHB Bridge 2 to Off-			MBX	0x4000000
SSMC nSTATICCS3		chip Peripherals		nSTATICCS3	nSTATICCS3 SSMC nSTATICCS2	0x3FFFFFFF
nSTATICCS1 nSTATICCS0				nSTATICCS1 nSTATICCS0	nSTATICCS1 nSTATICCS0	0x3000000
nSTATICCS7 nSTATICCS6				nSTATICCS7 nSTATICCS6	nSTATICCS7 SSMC nSTATICCS6	0x2FFFFFFF
nSTATICCS5 nSTATICCS4		_		nSTATICCS5 nSTATICCS4	nSTATICCS5 nSTATICCS4	0x2000000
AHB Bridge 2 to Off-					AHB Bridge 2 to Off-	0x1FFFFFFF
chip Peripherals					chip Peripherals	0x10200000
					DMA APB	0x101FFFFF
						0x101F0000
Core APB					Core APB	0x101EFFFF
			$\vdash$		001071112	0x101E0000
AHB Monitor					AHB Monitor	0x101DFFFF
		-				0x101D0000
					AHB Bridge 2 to Off-	0x101CFFFF
		-		AHB Bridge 2 to Off-	chip Peripherals	0x10150000
		AHB Bridge 2 to Off-			VIC	0x1014FFFF
						0x10140000
AHB Bridge 2 to Off-		chip Peripherals			DMAC	0x1013FFFF
chip Peripherals					211110	0x10130000
					CLCD	0x1012FFFF
					0200	0x10120000
					MPMC configuration	0x1011FFFF
_					registers	0x10110000
					SMC configuration	0x1010FFFF
					registers	0x10100000
					AHB Bridge 2 to Off-	0x100FFFFF
					chip Peripherals	0x1000000
MPMC MPMCDYCS1				MPMC MPMCDYCS1	MPMC MPMCDYCS1	0x0FFFFFFF
SDRAM MPMCDYCS0				SDRAM MPMCDYCS0	SDRAM MPMCDYCS0	0x00000000

#### Figure 3-6 Default AHB memory map with SMC

The memory map for control signals **CFGBRIDGEMEMMAP** HIGH and **MPMCnSMC** HIGH is shown in Figure 3-7. Part of the static memory range has been remapped to a bridge to off-chip peripherals.

Expansion AHB S		DMA0		ARM I, CLCD & DMA1		ARM D	
AHB Bridge 1 to Off-		AHB Bridge 1 to Off-		AHB Bridge 1 to Off-		AHB Bridge 1 to Off-	0xffffffff
chip Peripherals		chip Peripherals		chip Peripherals		chip Peripherals	0x80000000
MPMC MPMCDYCS3				MPMC MPMCDYCS3		MPMC MPMCDYCS3	0x7FFFFFFF
SDRAM MPMCDYCS2				SDRAM MPMCDYCS2		SDRAM MPMCDYCS2	0x7000000
				AHB Bridge 2 to Off-		AHB Bridge 2 to Off-	0x6FFFFFFF
AHB Bridge 2 to Off-				chip Peripherals		chip Peripherals	0x41000000
chip Peripherals		AHB Bridge 2 to Off-				MBX	0x40FFFFFF
		chip Peripherals					0x4000000
MPMC nSTATICCS3 nSTATICCS2				MPMC nSTATICCS3 nSTATICCS2		MPMC nSTATICCS3 nSTATICCS2	0x3FFFFFFF
static nSTATICCS1		-		static nSTATICCS1		static nSTATICCS1	0x3000000
							0x2FFFFFFF
AHB Bridge 2 to Off-		-				AHB Bridge 2 to Off-	0x2000000
chip Peripherals						chip Peripherals	0x1FFFFFFF
							0x10200000
DMA APB		DMA APB				DMA APB	0x101FFFFF
							0x101F0000
Core APB						Core APB	0x101EFFFF
			<u> </u>				0x101E0000
AHB Monitor			╞	AHB Bridge 2 to Off- chip Peripherals		AHB Monitor	0x101DFFFF
							0x101D0000
						chip Peripherals	0x101CFFFF
	-						0~101/FFFF
						VIC	0x1014FFFF
	-		-	-			0x1013FFFF
						DMAC	0x10130000
AHB Bridge 2 to Off-		AHB Bridge 2 to Off-			-		0x1012FFFF
chip Peripherais		chip Peripherals				CLCD	0x10120000
		-				MPMC configuration	0x1011FFFF
						registers	0x10110000
							0x1010FFFF
						AHB Bridge 2 to Off-	0x10100000
						chip Peripherals	0x100FFFFF
							0x1000000
MPMC MPMCDYCS1				MPMC MPMCDYCS1		MPMC MPMCDYCS1	0x0FFFFFFF
SDRAM MPMCDYCS0				SDRAM MPMCDYCS0		SDRAM MPMCDYCS0	0x00000000

#### Figure 3-7 AHB memory map without SMC

## 3.2.4 Bridge remapping

The default decoding is to have the AHB M1 selected for accesses between 0x8000000–0xFFFFFFF and AHB M2 selected for accesses below 0x8000000 that are not decoded by a peripheral in the ARM926EJ-S Development Chip. See Figure 3-8.



Figure 3-8 AHB M1 access determined by address range

If **CFGBRIDGEMEMMAP** is LOW, however, the address decoding for the AHB M1 and AHB M2 buses changes as shown in Figure 3-9. The ARM D master always accesses the AHB M1 bus for regions not decoded by a peripheral in the ARM926EJ-S Development Chip and all other buses access ARM M2 for regions not decoded by a peripheral in the ARM926EJ-S Development Chip.



Figure 3-9 AHB M1 access determined by ARM D

If **CFGBRIDGEMEMMAP** is LOW, the ARM D and ARM I buses access different bridges for memory accesses below 0x80000000. This affects boot memory aliasing (see *AHB memory alias for low memory* on page 3-25). You must modify applications to reflect the different memory decoding.

Caution -

#### Figure 3-10 shows the normal decoding.

Expansion AHB S		DMA0		ARM I, LCD & DMA1		ARM D	
AHB Bridge 1 to Off-		AHB Bridge 1 to Off-		AHB Bridge 1 to Off-		AHB Bridge 1 to Off-	0xffffffff
chip Peripherals		chip Peripherals		chip Peripherals		chip Peripherals	0x80000000
MPMC MPMCDYCS3				MPMC MPMCDYCS3		MPMC MPMCDYCS3	0x7FFFFFFF
SDRAM MPMCDYCS2				SDRAM MPMCDYCS2		SDRAM MPMCDYCS2	0x7000000
						AHB Bridge 2 to Off-	0x6FFFFFFF
AHB Bridge 2 to Off-				AHB Bridge 2 to Off-		chip Peripherals	0x41000000
chip Peripherals				chip Peripherals		MBX	0x40FFFFFF
		AHB Bridge 2 to Off-				MDX	0x4000000
nSTATICCS3		chip Peripherals		nSTATICCS3		nSTATICCS3	0x3FFFFFFF
nSTATICCS1 nSTATICCS0				nSTATICCS1 nSTATICCS0		nSTATICCS1 nSTATICCS0	0x3000000
nSTATICCS7 nSTATICCS6				nSTATICCS7 nSTATICCS6		nSTATICCS7 nSTATICCS6	0x2FFFFFFF
nSTATICCS5 nSTATICCS4				nSTATICCS5 nSTATICCS4		nSTATICCS5 nSTATICCS4	0x2000000
AHB Bridge 2 to Off-						AHB Bridge 2 to Off-	0x1FFFFFFF
chip Peripherals						chip Peripherals	0x10200000
							0x101FFFFF
						BWITTE	0x101F0000
Core APB						Core APB	0x101EFFFF
							0x101E0000
AHB Monitor						AHB Monitor	0x101DFFFF
							0x101D0000
						AHB Bridge 2 to Off-	0x101CFFFF
				ALIP Bridge 2 to Off		chip Peripherals	0x10150000
				chip Peripherals		VIC	0x1014FFFF
		AHB Bridge 2 to Off-				10	0x10140000
AHB Bridge 2 to Off-		chip Peripherals				DMAC	0x1013FFFF
chip Peripherals						2111/10	0x10130000
						CLCD	0x1012FFFF
						0200	0x10120000
-						MPMC configuration	0x1011FFFF
						registers	0x10110000
						SMC configuration	0x1010FFFF
						registers	0x10100000
						AHB Bridge 2 to Off-	0x100FFFFF
						chip Peripherals	0x10000000
MPMC MPMCDYCS1				MPMC MPMCDYCS1		MPMC MPMCDYCS1	0x0FFFFFFF
SDRAM MPMCDYCS0				SDRAM MPMCDYCS0		SDRAM MPMCDYCS0	0x00000000

#### Figure 3-10 Default AHB memory map with no bridge remap and SMC

Expansion AHB S		DMA0		ARM I, CLCD & DMA1		ARM D	
AHB Bridge 2 to Off-				AHB Bridge 2 to Off-		AHB Bridge 1 to Off-	0xffffffff
chip Peripherals				chip Peripherals		chip Peripherals	0x80000000
MPMC MPMCDYCS3				MPMC MPMCDYCS3		MPMC MPMCDYCS3	0x7FFFFFFF
SDRAM MPMCDYCS2				SDRAM MPMCDYCS2		SDRAM MPMCDYCS2	0x7000000
				AHB Bridge 2 to Off-		AHB Bridge 1 to Off-	0x6FFFFFFF
AHB Bridge 2 to Off-				chip Peripherals		chip Peripherals	0x41000000
chip Peripherals		AHB Bridge 2 to Off-				MBX	0x40FFFFFF
		chip Peripherals				MDX	0x4000000
nSTATICCS3 nSTATICCS2				nSTATICCS3 nSTATICCS2		nSTATICCS3	0x3FFFFFFF
nSTATICCS1 nSTATICCS0				nSTATICCS1 nSTATICCS0		nSTATICCS1 nSTATICCS0	0x3000000
nSTATICCS7				nSTATICCS7		nSTATICCS7	0x2FFFFFFF
nSTATICCS5 nSTATICCS4				nSTATICCS5 nSTATICCS4		nSTATICCS5 nSTATICCS4	0x2000000
AHB Bridge 2 to Off-						AHB Bridge 1 to Off-	0x1FFFFFFF
chip Peripherals						chip Peripherals	0x10200000
		DMA APB				DMA APB	0x101FFFFF
							0x101F0000
Core APB						Core APB	0x101EFFFF
		AHB Bridge 2 to Off-		AHB Bridge 2 to Off- chip Peripherals			0x101E0000
AHB Monitor						AHB Monitor	0x101DFFFF
							0x101D0000
						AHB Bridge 1 to Off-	0x101CFFFF
						chip Peripherals	0x10150000
						VIC	0x1014FFFF
							0x10140000
						DMAC	0x1013FFFF
		chip Peripherals					0x10130000
AHB Bridge 2 to Off-						CLCD	0x1012FFFF
chip Peripherals		-					0x10120000
						MPMC configuration	0x1011FFFF
		-				registers	0x10110000
						SMC configuration	0x1010FFFF
		-				registers	0x10100000
						AHB Bridge 1 to Off-	0x100FFFFF
		-				chip Peripherals	0x1000000
MPMC MPMCDYCS1				MPMC MPMCDYCS1		MPMC MPMCDYCS1	0x0FFFFFFF
SDRAM MPMCDYCS0				SDRAM MPMCDYCS0		SDRAM MPMCDYCS0	0x00000000

The memory map for bridge remapping is shown in Figure 3-11.

#### Figure 3-11 AHB memory map with bridge remap and SMC

If the SSMC is not used, part of the static memory range is mapped to an external bridge. The memory map for control signals **CFGBRIDGEMEMMAP** LOW and **MPMCnSMC** HIGH is shown in Figure 3-12.

Expansion AHB S		DMA0		ARM I, CLCD & DMA1		ARM D	
AHB Bridge 2 to Off-				AHB Bridge 2 to Off-		AHB Bridge 1 to Off-	0xFFFFFFFF
chip Peripherals				chip Peripherals		chip Peripherals	0x80000000
MPMC MPMCDYCS3				MPMC MPMCDYCS3	1	MPMC MPMCDYCS3	0x7FFFFFFF
SDRAM MPMCDYCS2				SDRAM MPMCDYCS2		SDRAM MPMCDYCS2	0x7000000
						AHB Bridge 1 to Off-	0x6FFFFFFF
AHB Bridge 2 to Off-				AHB Bridge 2 to Off-		chip Peripherals	0x41000000
chip Peripherals		AHB Bridge 2 to Off-		chip Peripherals		MBX	0x40FFFFFF
		chip Peripherals					0x4000000
MPMC nSTATICCS3 nSTATICCS2				MPMC nSTATICCS3 nSTATICCS2		MPMC nSTATICCS3 nSTATICCS2	0x3FFFFFFF
static nSTATICCS1				static nSTATICCS1		static nSTATICCS1	0x3000000
AHB Bridge 2 to Off-						AHB Bridge 1 to Off-	0x2FFFFFFF
chip Peripherals						chip Peripherals	0x2000000
						AHB Bridge 1 to Off-	0x1FFFFFFFF
						chip Peripherals	0x10200000
DMA APB		DMA APB				DMA APB	0x101FFFFF
				-			0x101F0000
Core APB						Core APB	0x101EFFFF
							0x101E0000
AHB Monitor				-		AHB Monitor	0x101DFFFF
							0x101D0000
				AHB Bridge 2 to Off-		AHB Bridge 1 to Off-	0x101CFFFF
		-		chip Peripherals		chip Peripherals	0x10150000
						VIC	0x1014FFFF
AHB Bridge 2 to Off-	- AHB Bridge 2 to O						0x10140000
chip Peripherals		chip Peripherals				DMAC	0x1013FFFF
						Billing	0x10130000
						CLCD	0x1012FFFF
							0x10120000
						MPMC configuration	0x1011FFFF
						registers	0x10110000
							0x1010FFFF
						AHB Bridge 1 to Off- chip Peripherals	0x10100000
							0x100FFFFF
							0x10000000
MPMC MPMCDYCS1				MPMC MPMCDYCS1		MPMC MPMCDYCS1	0x0FFFFFFF
SDRAM MPMCDYCS0				SDRAM MPMCDYCS0		SDRAM MPMCDYCS0	0x00000000

#### Figure 3-12 AHB memory map with bridge remap and no SMC

#### 3.2.5 AHB memory alias for low memory

Normally, fast dynamic memory resides at location 0x00000000. This area is used to store exception vector tables. Address remap functionality is provided to temporarily map an alias of another memory region to 0x0000000–0x03FFFFFF after a power-on reset.

The memory map outside the 0x0000000 to 0x03FFFFFF address range is only controlled by **MPMCnSMC** and **CFGBRIDGEMEMMAP**. Except for Figure 3-13 and Figure 3-16 on page 3-27, all figures show the memory map for **MPMCnSMC** LOW and **CFGBRIDGEMEMMAP** LOW.

Figure 3-13 summarizes the effects of the remap signals on the AHB data and instruction buses.

— Note ———

Only the combination of **REMAPEXTERNAL** HIGH and **CFGBRIDGEMEMMAP** LOW result in different mappings for the ARM I AHB master and the ARM D AHB master.



Figure 3-13 Supported address remap functionality for ARM D AHB

Figure 3-14 shows the internal bus map for:

- **REMAPSTATIC** LOW (only dynamic memory in boot area)
- MPMCnSMC X
- **CFGBRIDGEMEMMAP** HIGH (AHB M1 determined by address range)
- **REMAPEXTERNAL** LOW (boot memory is controlled by MPMC).



#### Figure 3-14 Alias for REMAPSTATIC LOW

Figure 3-15 on page 3-27 shows the internal bus map for:

- **REMAPSTATIC** HIGH
- MPMCnSMC LOW (the SSMC controls static memory)
- **CFGBRIDGEMEMMAP** HIGH (AHB M1 determined by address range)
- **REMAPEXTERNAL** LOW (boot memory is controlled by MPMC and SSMC).



#### Figure 3-15 Alias for REMAPSTATIC HIGH and MPMCnSMC LOW

Figure 3-16 shows the internal bus map for:

- **REMAPSTATIC** HIGH
- MPMCnSMC HIGH (the MPMC controls static memory)
- **CFGBRIDGEMEMMAP** HIGH (AHB M1 determined by address range)
- **REMAPEXTERNAL** LOW (boot memory is controlled by MPMC).



#### Figure 3-16 Alias for REMAPSTATIC HIGH and MPMCnSMC HIGH

Figure 3-17 shows the internal bus map for:

- **REMAPSTATIC** HIGH
- MPMCnSMC HIGH (the MPMC controls static memory)
- **CFGBRIDGEMEMMAP** HIGH (AHB M1 access selected by address range)
- **REMAPEXTERNAL** HIGH (boot memory is controlled off-chip).



#### Figure 3-17 Alias for REMAPEXTERNAL HIGH and CFGBRIDGEMEMMAP HIGH

Figure 3-18 shows the internal bus map for:

- **REMAPSTATIC** HIGH
- MPMCnSMC HIGH (the MPMC controls static memory)
- **CFGBRIDGEMEMMAP** LOW (AHB M1 access selected by master used)
- **REMAPEXTERNAL** HIGH (boot memory is controlled off-chip).



Figure 3-18 Alias for REMAPEXTERNAL HIGH and CFGBRIDGEMEMMAP LOW

## 3.2.6 APB address maps

Expansion AHB S		DMA0		ARM I, CLCD & DMA1		ARM D	
AHB Bridge 2 to Off- chip Peripherals		AHB Bridge 2 to Off- chip Peripherals				AHB Bridge to Off- chip Peripherals	0x101FFFFF 0x101F500
SSP		SSP				SSP	0x101F400
UART 2		UART 2				UART 2	0x101F3000
UART 1		UART 1				UART 1	0x101F2000
UART 0		UART 0				UART 0	0x101F1000
SCI		SCI				SCI	0x101F0000
AHB Bridge 2 to Off- chip Peripherals				AHB Bridge 2 to Off- chip Peripherals		AHB Bridge to Off- chip Peripherals	0x101EFFFF
RTC		AHB Bridge 2 to Off-				RTC	0x101E8000
GPIO 3		chip Peripherals				GPIO 3	0x101E7000
GPIO 2						GPIO 2	0x101E6000
GPIO 1						GPIO 1	0x101E5000
GPIO 0						GPIO 0	0x101E4000
Timer 2&3						Timer 2&3	0x101E3000
Timer 0&1						Timer 0&1	0x101E2000
Watchdog						Watchdog	0x101E1000
Sys. Controller						Sys. Controller	0x101E0000
r	-	•	-	-	-	÷	•

Figure 3-19 shows the Core APB and DMA APB memory organization.

#### Figure 3-19 APB map

The DMA APB address map is listed in Table 3-1. The DMA APB is not accessible by the ARM I, CLCD, or DMA1 masters. Accesses from these masters are routed to an off-chip bridge.

Base address	Base name	Peripheral
0x101F4000	SSP	Synchronous Serial Port
0x101F3000	UART2	UART two
0x101F2000	UART1	UART one
0x101F1000	UART0	UART zero
0x101F0000	SCI	Smart Card Interface

The Core APB address map is listed in Table 3-2. The Core APB is not accessible by the ARM I, CLCD, DMA0, or DMA1 masters. Accesses from these masters are routed to an off-chip bridge.

Base address	Base name	Peripheral
0x101E8000	RTC	RTC
0x101E7000	GPIO3	GPIO port three
0x101E6000	GPIO2	GPIO port two
0x101E5000	GPIO1	GPIO port one
0x101E4000	GPIO0	GPIO port zero
0x101E3000	Timer2_3	Timer modules 2 and 3
0x101E2000	Timer0_1	Timer modules 0 and 1
0x101E1000	Watchdog	Watchdog module
0x101E0000	SCTL	System Controller

#### Table 3-2 Core APB peripheral base addresses

## 3.2.7 MBX memory map

The mapping of the internal MBX AHB bus to dynamic memory is shown in Figure 3-20.

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		bank 4	0x00000000

#### MBX Memory Interface

#### Figure 3-20 MBX map

# 3.3 AHB signals to pads

This section describes the AHB signals on the input/output pads.

\_\_\_\_\_ Note \_\_\_\_\_

The **HDATAM2[28:0]** signals on the AHB M2 bus are also used for the configuration signals **CFGDATA[28:0]**, see *External configuration signals* on page 2-19.

## Table 3-1 AHB M1 signals

Signal Name	Туре	Description
HBUSREQM1	Output	Bus request. A signal from the master to the arbiter, which indicates that the master interface requires the bus.
HLOCKM1	Output	When HIGH this signal indicates that the master requires locked access to the bus and no other master should be granted the bus until this signal is LOW.
HGRANTM1	Input	Bus grant. This signal indicates that the master interface is currently the highest priority master. Ownership of the address / control signals changes at the end of a transfer when HREADYM is HIGH, so the master gets access to the bus when both HREADYM and HGRANTM are HIGH.
HADDRM1[31:0]	Tristate output	System address bus, least significant 20 bits, driven by the active bus master.
HWRITEM1	Tristate output	Transfer direction signal. When HIGH, this signal indicates a write to a slave and when LOW a read from a slave.
HTRANSM1[1:0]	Tristate output	Indicates the type of the current transfer, which can be NONSEQUENTIAL, SEQUENTIAL, IDLE or BUSY.
HSIZEM1[1:0]	Tristate output	Transfer size signal. This signal indicates the size of the current transfer, which can be byte (8-bit), halfword (16-bit), or word (32-bit).
HBURSTM1[2:0]	Tristate output	Indicates if the transfer forms part of a burst. Four, eight and 16 beat bursts are supported and the burst can be either incrementing or wrapping.
HPROTM1[3:0]	Tristate output	The protection control signals provide additional information about a bus access. They are primarily intended for use by any module that wished to implement some level of protection.
HREADYM1	Input	Transfer completed input. When HIGH the signal indicates that a transfer has finished on the bus. This signal can be driven LOW to extend a transfer.

#### Table 3-1 AHB M1 signals (continued)

Signal Name	Туре	Description
HRESPM1[1:0]	Input	The transfer response provides additional information on the status of a transfer. Two different responses are provided, OKAY and ERROR.
HDATAM1[31:0]	Bidirectional	Read/write data bus.
HCLKM1	Input	Asynchronous AHB bus clock from an external source.

### Table 3-2 AHB M2 signals

Signal Name	Туре	Description
HBUSREQM2	Output	Bus request. A signal from the master to the arbiter, which indicates that the master interface requires the bus.
HLOCKM2	Output	When HIGH this signal indicates that the master requires locked access to the bus and no other master should be granted the bus until this signal is LOW.
HGRANTM2	Input	Bus grant. This signal indicates that the master interface is currently the highest priority master. Ownership of the address / control signals changes at the end of a transfer when HREADYM is HIGH, so the master gets access to the bus when both HREADYM and HGRANTM are HIGH.
HADDRM2[31:0]	Tristate output	System address bus, least significant 20 bits, driven by the active bus master.
HWRITEM2	Tristate output	Transfer direction signal. When HIGH, this signal indicates a write to a slave and when LOW a read from a slave.
HTRANSM2[1:0]	Tristate output	Indicates the type of the current transfer, which can be NONSEQUENTIAL, SEQUENTIAL, IDLE or BUSY.
HSIZEM2[1:0]	Tristate output	Transfer size signal. This signal indicates the size of the current transfer, which can be byte (8-bit), halfword (16-bit), or word (32-bit).
HBURSTM2[2:0]	Tristate output	Indicates if the transfer forms part of a burst. Four, eight and 16 beat bursts are supported and the burst can be either incrementing or wrapping.
HPROTM2[3:0]	Tristate output	The protection control signals provide additional information about a bus access. They are primarily intended for use by any module that wished to implement some level of protection.
HREADYM2	Input	Transfer completed input. When HIGH the signal indicates that a transfer has finished on the bus. This signal can be driven LOW to extend a transfer.

#### Table 3-2 AHB M2 signals (continued)

Signal Name	Туре	Description
HRESPM2[1:0]	Input	The transfer response provides additional information on the status of a transfer. Two different responses are provided, OKAY and ERROR.
HDATAM2[31:0]	Bidirectional	Read/write data bus.
HCLKM2	Input	Asynchronous AHB bus clock from an external source.

#### Table 3-3 AHB S signals

Signal Name	Туре	Description
HMASTLOCKS	Input	Master lock signal. When HIGH, this signal indicates that the master on the bus requires locked access and no other master should be granted the bus until this signal is LOW.
HSELS	Input	Slave select.
HADDRS[31:0]	Input	System address bus, least significant 20 bits, driven by the active bus master.
HWRITES	Input	Transfer direction signal. When HIGH, this signal indicates a write to a slave and when LOW a read from a slave.
HTRANSS[1:0]	Input	Indicates the type of the current transfer, which can be NONSEQUENTIAL, SEQUENTIAL, IDLE or BUSY.
HSIZES[1:0]	Input	Transfer size signal. This signal indicates the size of the current transfer, which can be byte (8-bit), halfword (16-bit), or word (32-bit).
HBURSTS[2:0]	Input	Indicates if the transfer forms part of a burst. Four, eight and 16 beat bursts are supported and the burst can be either incrementing or wrapping.
HPROTS[3:0]	Input	The protection control signals provide additional information about a bus access. They are primarily intended for use by any module that wished to implement some level of protection.
HREADYS	Bidirectional	Transfer done. When HIGH indicates that a transfer has finished on the bus. This signal can be driven LOW to extend a transfer.
HRESPS[1:0]	Tristate output	The transfer response provides additional information on the status of a transfer. Two different responses are provided, OKAY and ERROR.
HDATAS[31:0]	Bidirectional	Read/write data bus.
HCLKS	Input	Asynchronous AHB bus clock from an external source.
# Part B Controllers and Peripherals

# Chapter 4 AHB Monitor

This chapter describes the AHB Monitor in the ARM926EJ-S Development Chip. It contains the following section:

- *About the AHB monitor* on page 4-2
- Functional description on page 4-3
- *AHB Monitor signals on pads* on page 4-42.

# 4.1 About the AHB monitor

The ARM926EJ-S Development Chip contains a multi-layer AHB system to provide high bandwidth connectivity between the various bus masters and slaves both within and outside the ARM926EJ-S Development Chip. The AHB Monitor connects to the AHB matrix. A slave bus is available for reading bus activity counters.

The release version for the AHB Monitor is SP816. The base address for the AHB registers is 0x101D000.

For further information on AMBA refer to the AMBA Specification.

The AHB Monitor block provides two functions:

- suppling an off-chip, real-time monitor on the state of the six AHB buses and MBX graphics expansion interface within the ARM926EJ-S Development Chip
- recording operational data to enable a profiling analysis of the interconnect system.

The AHB Monitor contains an AHB slave interface to enable the control and retrieval of the monitor data located between 0x101D0000 and 0x101DFFFF on the ARM Data and expansion AHB Layers

The AHB Monitor contains the following blocks that supply the functional elements:

- ARM-D Layer Monitor
- ARM-I Layer Monitor
- CLCDC Layer Monitor
- DMA-0 Layer Monitor
- DMA-1 Layer Monitor
- EXPansion Layer Monitor
- MBX Graphics eXpansion Interface (GXI) Monitor
- AHB Slave Interface.

The AHB layer monitors observe the activity on their respective bus signals to produce real-time information, that is exported off-chip, and record statistical information, that is accessible through the AHB slave interface.

The GXI is a dedicated interconnect between the MBX and MPMC. The MBX GXI monitor observes the activity on this interconnect and records statistical information in a similar manner that of the AHB layer monitors.

# 4.2 Functional description



The AHB monitor interface is shown in Figure 4-1.

# Figure 4-1 AHB monitor block diagram

The base address of the AHB monitor is at 0x101D0000-0x101DFFFF.

#### 4.2.1 Bus Cycle Analyzer

The *Bus Cycle Analyzer* (BCA) provides information about bus activity on a cycle by cycle basis. A packet of information is created on every bus clock. Access to the real-time status of the layers is made available through a set of pins on the chip named **AHBMONITOR**. Use the **AHBMONITOR** connections to monitor the activity of the AHB interconnects through a logic analyzer.

# The AHBMONITOR port

The **AHBMONITOR** port consists of 33 data output pins that export status data packets at the AHB clock rate. A localized clock is exported on **AHBMONITOR**[33].

To produce minimal loading effects on the respective bus layers and to improve setup and hold characteristics, the logic in the BCA includes registers to de-pipeline that part of the information that it captured from the address phase. The registering of these signals causes the status reported at the port to be three **HCLK** cycles behind the actual activity on the interconnect.

#### **AHB Monitor packet format**

There are 33 bits per data packet. To simplify the subsequent analysis of the data, there are completely separate groups of bits associated with each AHB layer and the GXI. The packet can be viewed as seven independent subpackets as shown in Figure 4-2. There are six bits assigned to the ARM-D layer, five to each of the DMA and Expansion layers, and four for the LCD, ARM-I and GXI layers.

32	29	28		23	22	19	18	14	13	9	8		4	3	0
GX	(1		ARM-D		ARN	/I-I	DN	1A-0	DM	A-1		EXP		l	CD

#### Figure 4-2 AHB Monitor packet format

# **AHB Layer Cycle States**

The states that can be reported for an AHB layer are shown in Table 4-1.

#### **Table 4-1 Cycle states**

Symbol	Name	Description
Ι	Idle	The bus master is performing, and hence completing, an IDLE transfer.
В	Busy	The bus master is performing, and hence completing, a BUSY transfer.
EN	Error_Next	The bus master is receiving the first half of an ERROR response.
RN	Retry_Next	The bus master is receiving the first half of a RETRY response.
WS	Wait_Slave	The bus master is incurring a wait state as a result of the slave.
WB	Wait_Bus	The bus master is incurring a wait state as a result of the matrix latency on a new connection.
WA	Wait_Arbiter	The bus master is incurring a wait state as a result of the arbitration latency of competing masters.
Sb	Sequential_Burst_Type_b	The bus master is completing a data transfer sequential to the last one. Set of states representing each possible burst type.
NRs	NewReadSlave_s	The bus master is completing a Nonsequential Read from slave number <s></s>
NWs	NewWriteSlave_s	The bus master is completing a Nonsequential Write to slave number <s></s>

The total number of different NRs and NWs states, that are valid, is dependent upon the layer - some masters only perform reads and most have connections to only a subset of the possible slaves. Similarly the number of valid Sb states is dependent upon the layer because most masters are not capable of producing all possible burst types. For these reasons, the format of the encoded signals has been developed to allow the bit allocation per layer as stated in the previous section.

Assigning different states for Sequential and Nonsequential transfers means that it is possible to reconstruct burst information from the data stream. It is not necessary to identify either the transfer direction or the slave number in a sequential transfer because the bus protocol defines that both of these must remain constant throughout a burst, so is the same as the most recent NRs or NWs state. Similarly, it is not necessary to identify the burst type in a nonsequential transfer because this is indicated in any subsequent sequential transfers.

The Error\_Next and Retry\_Next responses are indicated during the first cycle of the two cycle response sequence, which allows the progress of the burst in second cycle as can occur with an error response.

Table 4-2 shows an example pattern of transfers and the data stream produced.

Pattern on bus	Description
Ι	Idle Transfer
WB	First write transfer to slave 1 incurring one wait state imposed by the bus matrix
NW1	-
S_INCR4	Second write transfer to slave 1 in an incrementing burst of four
S_INCR4	Third write transfer to slave 1 in an incrementing burst of four
S_INCR4	Fourth write transfer to slave 1 in an incrementing burst of four
WB	First read transfer from slave 2, one wait states from the bus connect latency and one from the arbitration latency
WA	-
NR2	-
WS	Second read transfer from slave 2 in a wrapping burst of 4, one wait state inserted by the slave
S_WRAP4	-

#### Table 4-2 Sample output

#### Table 4-2 Sample output (continued)

Pattern on bus	Description
WS	Third read transfer from slave 2 in a wrapping burst of 4, one wait state inserted by the slave
S_WRAP4	-
WS	Fourth read transfer from slave 2 in a wrapping burst of 4, one wait state inserted by the slave
S_WRAP4	-

#### AHB Cycle State encoding

Table 4-3 shows the bit pattern encoding used for each of the possible Bus Cycle States on each layer and shows which of those values can actually be generated by that layer (boxes marked with a Y).

\_\_\_\_\_ Note \_\_\_\_\_

The LCD and ARM-I layers can only generate bit patterns with bits [5] and [4] are held at 0. Similarly, the EXPansion, DMA0, and DMA0 layers can only generate bit patterns with bit [5] of the Code field at 0. There are six bits assigned to the ARM-D layer, five to each of the DMA and Expansion layers, and four for the LCD, ARM-I and GXI layers.

Symbol and bus state	[5] a	[4] b	[3:0]	ARM-D [28:23]	ARM-I [22:19]	DMA-0 [18:14]	DMA-1 [13:9]	EXP [8:4]	LCD [3:0]
I, Idle	0	0	0000	Y	Y	Y	Y	Y	Y
S_INCR, Sequential_INCR	0	0	0001	-	-	Y	Y	Y	Y
B, Busy	0	0	0010	-	-	-	-	Y	Y
S_INCR4, Sequential_INCR4	0	0	0011	Y	Y	Y	Y	Y	Y
S_WRAP8, Sequential_WRAP8	0	0	0100	Y	Y	-	-	Y	-
S_INCR8, Sequential_INCR8	0	0	0101	Y	-	Y	Y	Y	Y
EN, Error Next	0	0	0110	Y	Y	Y	Y	Y	Y

Table 4-3 Bus state bit patterns

Table 4-3 Bus state bit patterns (continued)

Symbol and bus state	[5] a	[4] <sup>b</sup>	[3:0]	ARM-D [28:23]	ARM-I [22:19]	DMA-0 [18:14]	DMA-1 [13:9]	EXP [8:4]	LCD [3:0]
S_INCR16, Sequential_INCR16	0	0	0111	-	-	Y	Y	Y	Y
NR_EXP1, Expansion Bridge 1	0	0	1000	Y	Y	Y	Y	Y	Y
NR_EXP2, Expansion Bridge 2	0	0	1001	Y	Y	Y	Y	Y	Y
NR_MPMC, MPMC	0	0	1010	Y	Y	-	Y	Y	Y
NR_SMC, SMC	0	0	1011	Y	Y	-	Y	Y	Y
WS, Wait_Slave	0	0	1100	Y	Y	Y	Y	Y	Y
WB, Wait_Bus	0	0	1101	Y	Y	Y	Y	Y	Y
WA, Wait_Arbiter	0	0	1110	Y	Y	Y	Y	Y	Y
HRESET	0	0	1111	-	Y	-	-	-	Y
NW_EXP1, Expansion Bridge 1	0	1	0000	Y	-	Y	Y	Y	-
NW_EXP2, Expansion Bridge 2	0	1	0001	Y	-	Y	Y	Y	-
NW_MPMC, MPMC	0	1	0010	Y	-	-	Y	Y	-
NW_SMC, SMC	0	1	0011	Y	-	-	Y	Y	-
NW_APBDMA, APB bridge to DMA peripherals	0	1	0100	Y	-	-	Y	Y	-
NW_APBCore, APB bridge to Core peripherals	0	1	0101	Y	-	Y	-	Y	-
NW_AHBMON, AHB Monitor registers	0	1	0110	Y	-	-	-	Y	-
0x17, Unused	0	1	0111	-	-	-	-	-	-
0x18 - 0x19, Unused	0	1	100x	-	-	-	-	-	-
S_WRAP4, Sequential_WRAP4	0	1	1010	-	-	-	-	Y	-
S_WRAP16, Sequential_WRAP16	0	1	1011	-	-	-	-	Y	-
NR_APBDMA, APB bridge to DMA peripherals	0	1	1100	Y	-	Y	-	Y	-

Table 4-3 Bus state bit patterns (continued)

Symbol and bus state	[5] a	[4] <sup>b</sup>	[3:0]	ARM-D [28:23]	ARM-I [22:19]	DMA-0 [18:14]	DMA-1 [13:9]	EXP [8:4]	LCD [3:0]
NR_APBCore, APB bridge to Core peripherals	0	1	1101	Y	-	-	-	Y	-
NR_AHBMON, AHB Monitor registers	0	1	1110	Y	-	-	-	Y	-
HRESET	0	1	1111	-	-	Y	Y	Y	-
0x20- 0x2F, Unused	1	0	XXXX	-	-	-	-	-	-
NW_SMCCFG, SMC	1	1	0111	Y	-	-	-	-	-
NW_MPMCCFG, MPMC config registers	1	1	0000	Y	-	-	-	-	-
NW_VIC, VIC registers	1	1	0010	Y	-	-	-	-	-
NW_CLCDC, CLCDC registers	1	1	0011	Y	-	-	-	-	-
NW_DMAC, DMAC registers	1	1	0100	Y	-	-	-	-	-
NW_MBX, MBX registers	1	1	0101	Y	-	-	-	-	-
0x36 - 0x37, Unused	1	1	011x	-	-	-	-	-	-
NR_SMCCFG, Read SMC configuration	1	1	1000	Y	-	-	-	-	-
NR_MPMCCFG, Read MPMC configuration	1	1	1001	Y	-	-	-	-	-
NR_VIC, Read from VIC	1	1	1010	Y	-	-	-	-	-
NR_CLCDC, Read from CLCDC	1	1	1011	Y	-	-	-	-	-
NR_DMAC, DMAC registers	1	1	1100	Y	-	-	-	-	-
NR_MBX, MBX registers	1	1	1101	Y	-	-	-	-	-
RN, Retry_Next	1	1	1110	Y	-	-	-	-	-
HRESET, Bus reset	1	1	1111	-	-	-	-	-	-

a. The ARM-D bus state code is 6-bits long.

b. The DMA-0, DMA-1, and EXP bus state codes are 5-bits long.

# **GXI Cycle States and Encoding**

The GXI can perform concurrent read and write activities due to the split transfer architecture it employs. Therefore, the four debug output pins related to the GXI are divided into two, providing separate state information for the read and write channels. The four bits dedicated to the GXI assign the upper two bits to the read channel and the lower bits to the write channel, **AHBMONITOR**[32:29] = {ReadState, WriteState}.

—— Note ———

The GXI debug is a registered output based on the registered forms of the GXI bus similar to the approach taken for the AHB layers, therefore the reported activity is similarly delayed.

The two GXI channels behave differently and have different encoding presented in Table 4-4 and Table 4-5 on page 4-10. Table 4-4 shows the states of the read data channel and Table 4-5 on page 4-10 shows the states of the address channel.

Symbol	Name	Encoding [32:31]	Description
Ι	Idle	00	The GXI read data channel is idle, that is, no transfers are active nor pending
WP	Wait Pending	01	The GXI read data channel has been stalled and has one or more transfers waiting for completion
TnP	Transfer and None Pending	10	The GXI read data channel is taking part in a transfer without any further transfers wait for completion
TP	Transfer and Pending	11	The GXI read data channel is taking part in a transfer with one or more additional transfers waiting for completion

#### Table 4-4 Bit patterns for GXI states for read channel

Symbol	Name	Encoding [30:29]	Description
I	Idle	00	The GXI address channel is idle, that is, no transfers are active nor pending
W	Wait	01	The GXI address channel is waiting on a read or write address transfer
Rd	Read	10	The GXI address channel is completing a read address transfer
Wr	Write	11	The GXI address channel is completing a write transfer

#### Table 4-5 Bit patterns for GXI state for address channel

#### 4.2.2 Profiling Counters

The Profiling Counters provide information about bus activity over a much longer time span than the **AHBMONITOR**[32:29] port. Each counter is 32 bits wide and records the number of occurrences of a particular event, since a software or hardware reset. The count values can be read back through the AHB slave interface. Control registers can be written to the AHB interface to enable, disable, reset the counters, and in some cases, modify the manner in which they count. The counters are used for statistical profiling of software and system setups, for example the number of cache line fills and/or evictions during a particular algorithm. This permits some assessment of how well the bus fabric is managing competition for slave bandwidth.

As each monitor layer registers the target bus signals to minimize the loading effects, the control and configuration of the counters is required to be synchronized to match the pipelined effect. This ensures that the activity monitored coincides with the correct configuration settings. The best example to explain this synchronization is the write to reset the counters; the write that caused the reset does not cause the respective profile counters to increment, but any transfers directly after do.

# Accessing the Profiling Counters

The profiling counters of each layer are accessed through an AHB slave port. They are only connected to the ARM-D and EXPansion bus layers at a base address of 0x101D0000. The control and configuration registers for the profiling counter are also accessible through this base address. Each register in the AHB monitor is word aligned.

— Note —

The enabling and clearing of the profiling counters is synchronized to the registered operation of the associated layers to ensure that the data collected is correct.

# **Counted events**

All the layers contain a number of counters for collecting statistical information, such as number of basic accesses and burst behavior. Certain layers also contain additional counters for layer specific or behavior of interest. For example:

- the ARM-I and ARM-D layers also contain counters for cache related statistics
- the ARM-D and EXP layers contain counters to track accesses to the APB bridges
- for the DMA peripheral layer (DMA0) the transfers to each of the built-in slaves are counted independently as an easy means of determining which component was using the most DMA bandwidth.

There are counters to help determine the mean latency experienced by each bus master in the form of wait states. Latency caused by bus infrastructure or arbitration is typically seen only on the first transfer of a burst. By differentiating between the two causes of wait states for nonsequential transfers, and knowing the number of bursts, you get an indication of the stalling effect of the bus infrastructure.

As each layer, with exception of the GXI, can receive an ERROR response and the ARM-D layer can receive a RETRY response, it is important to define the count behavior in regards to these condition:

- Read / Write counters increment on ERROR, second cycle, and OKAY responses only
- burst counters increment on ERROR, second cycle, and OKAY responses only
- no increments occur with any other response.

As the AMBA AHB specification allows for divergent behavior in reaction to the ERROR specification, the behavior of each of the AHB masters contained within the ARM926EJ-S Development Chip design is shown below to help you understand the profile information collected on each layer:

- **CLCDC** It stops the current burst by issuing a bus idle and enters an error state that issues an interrupt signal. Once the interrupt is cleared the controller begins the frame again.
- **DMAC** Halts the current burst then halts further bus activity and optionally raises an interrupt.

#### **AHB-AHB** bridge

Passes errors back to the source master.

- **ARM926-I** The burst transaction is always completed before an ABORT exception is raised. Following the completion of the ABORT exception handler, the ARM executes a specific instruction to execute the instruction that caused the data abort.
- **ARM926-D** If it occurs on a SWAP instruction, the write is always attempted. For all other cases the BUI, always completes the burst transaction before raising an ABORT exception. Following the completion of the ABORT exception handler the ARM executes a specific instruction to execute the instruction that caused the data abort.

Similarly to the AHB layers, statistical information is also collected for the GXI, such as number of complete read and write transfers and stall trends.

#### **Counted events on ARM-I layer**

The ARM926EJ-S ARM-I BIU performs only a small subset of AHB transfer types. It performs no writes at all. All reads are word-sized, even when not in ARM state. For example, two half-word Thumb instructions are fetched by one word transfer. It performs only burst types SINGLE, INCR4, WRAP8 (I-cache line fills).

There are no BUSY transfers on this layer.

Table 4-6 shows all the events that are recorded on the ARM-I layer. These counters are enabled through the counter enable bit in the AHBMONCtrlReg register and are further controlled by the **DBGACK** and when the track **DBGACK** is asserted. The track **DBGACK**, when set, disables the counters during cycles that the **DBGACK** is asserted. All counters can be reset by writing to the AHBMONRstCntrs register, and preset to their absolute address by writing to the AHBMONPrstCntrs register.

Counter Name	Description
CtArmiRd	Total number of completed read transfers
CtArmiBurstSingle	Number of single word bursts
CtArmiBurstIncr4	Number of 4-word incrementing bursts
CtArmiLineFill	Number of I-cache linefills, that is, CtArmiBurstWrap8 - number of 8-word wrapping bursts
CtArmiWaitTotal	Total number of wait states
CtArmiWaitNonSeqSlave	Number of wait states on the first transfer of a burst that were caused by a slave
CtArmiWaitNonSeqBus	Number of wait states on the first transfer of a burst that were caused by the bus infrastructure
CtArmiWaitThresholdHit	Number of occurrences that a wait-state exceeded a configurable threshold

Table 4-6 Event counters for the ARM-I layer

#### **Counted events on CLCDC layer**

The PrimeCell PL110 CLCDC BIU performs only a small subset of AHB transfer types:

- it performs no writes at all
- all reads are word-sized
- it performs only burst types INCR, INCR4, INCR8, and INCR16
- the unspecified length bursts are used to implement single transfers by the CLCDC.

There are no BUSY transfers on this layer, because the FIFO in this particular implementation is synthesized from flip-flops rather than using a compiled RAM block. However, the RTL does contain busy activity that could affect other configurations.

Table 4-7 shows all the events that are recorded on the CLCDC layer. These counters are enabled through the counter enable bit in the AHBMONCtrlReg register. All counters can be reset by writing to the AHBMONRstCntrs register, and preset to their absolute address by writing to the AHBMONPrstCntrs register.

Counter Name	Description
CtClcdRd	Total number of completed read transfers
CtClcdBurstIncr	Number of unspecified length bursts, this format is used for 1-word transfers)
CtClcdBurstIncr4	Number of 4-word incrementing bursts
CtClcdBurstIncr8	Number of 8-word incrementing bursts
CtClcdBurstIncr16	Number of 16-word incrementing bursts
CtClcdWaitTotal	Total number of wait states
CtClcdWaitNonSeqSlave	Number of wait states on the first transfer of a burst that were caused by a slave
CtClcdWaitNonSeqBus	Number of wait states on the first transfer of a burst that were caused by the bus infrastructure
CtClcdWaitThresholdHit	Number of occurrences that a wait-state exceeded a configurable threshold

#### Table 4-7 CLCDC events

#### Counted events on DMA-0 layer

The PrimeCell PL080 DMAC BIU can perform all active AHB transfer types, that is, reads and writes of size 8, 16, and 32-bits. It performs only burst types INCR, INCR4, INCR8, and INCR16. DMA master number 0 is used to access the three DMA-capable peripherals within the ARM926EJ-S Development Chip (UART, SCI, SSP) or external slaves accessed through the off-chip bridges.

The APB bridge generates the PSEL signal from a direct binary decode of HADDR[15:12]. The resultant decode maps as:

PSEL[15:0] = {PSelExp[10:0], PSelSsp, PSelUart[2:0], PSelSCard}

Table 4-8 shows all the events that are recorded on the DMA-0 layer. These counters are enabled through the counter enable bit in the AHBMONCtrlReg. All counters can be reset by writing to the AHBMONRstCntrs register, and preset to their absolute address by writing to the AHBMONPrstCntrs register.

Counter Name	Description
CtDma0Rd	Total number of read transfers
CtDma0Wr	Total number of write transfers
CtDma0RdUart	Number of read transfers from the UART, there are three selects for UART,
CtDma0WrUart	Number of write transfers to the UART, there are three selects for UART,
CtDma0RdSci	Number of read transfers from the SCI
CtDma0WrSci	Number of write transfers to the SCI
CtDma0RdSsp	Number of read transfers from the SSP
CtDma0WrSsp	Number of write transfers to the SSP
CtDma0BurstIncr	Number of unspecified length bursts
CtDma0BurstIncr4	Number of 4-beat incrementing bursts
CtDma0BurstIncr8	Number of 8-beat incrementing bursts
CtDma0BurstIncr16	Number of 16-beat incrementing bursts
CtDma0WaitTotal	Total number of wait states

#### Table 4-8 DMA 0 events

#### Table 4-8 DMA 0 events (continued)

Counter Name	Description
CtDma0WaitNonSeqSlave	Number of wait states on the first transfer of a burst that were caused by a slave
CtDma0WaitNonSeqBus	Number of wait states on the first transfer of a burst that were caused by the bus infrastructure
CtDma0WaitThresholdHit	Number of occurrences that a wait-state exceeded a configurable threshold

#### Counted events on DMA-1 layer

The PrimeCell PL080 DMAC BIU can perform all active AHB transfer types, that is, reads and writes of size 8, 16, and 32-bits. It performs only burst types INCR, INCR4, INCR8, and INCR16. DMA master number 1 is used to access memory either through the memory controllers within the ARM926EJ-S Development Chip (SMC, MPMC) or external slaves accessed through the off-chip bridges.

Table 4-9 shows all the events that are recorded on the DMA-1 layer. These counters are enabled through the counter enable bit in the AHBMONCtrlReg register. All counters can be reset by writing to the AHBMONRstCntrs register, and preset to their absolute address by writing to the AHBMONPrstCntrs register.

Counter Name	Description
CtDma1Rd	Total number of read transfers
CtDma1Wr	Total number of write transfers
CtDma1BurstIncr	Number of unspecified length bursts
CtDma1BurstIncr4	Number of 4-beat incrementing bursts
CtDma1BurstIncr8	Number of 8-beat incrementing bursts
CtDma1BurstIncr16	Number of 16-beat incrementing bursts
CtDma1WaitTotal	Total number of wait states

#### Table 4-9 DMA 1 events

#### Table 4-9 DMA 1 events (continued)

Counter Name	Description
CtDma1WaitNonSeqSlave	Number of wait states on the first transfer of a burst that were caused by a slave
CtDma1WaitNonSeqBus	Number of wait states on the first transfer of a burst that were caused by the bus infrastructure
CtDma1WaitThresholdHit	Number of occurrences that a wait-state exceeded a configurable threshold

#### Counted events on EXPansion layer

The expansion layer is connected to an AHB-AHB bridge to enable external AHB components to be interfaced to the ARM926EJ-S Development Chip. The AHB-AHB bridge passes all AHB signals between AHB domains, with exception of SPLIT and RETRY responses, which are substituted with stall-cycles with the response signals.

Table 4-10 shows all the events that are recorded on the EXPansion layer. These counters are enabled through the counter enable bit in the AHBMONCtrlReg. All counters can be reset by writing to the AHBMONRstCntrs register, and preset to their absolute address by writing to the AHBMONPrstCntrs register

Counter Name	Description
CtExpRd	Total number of read transfers
CtExpWr	Total number of write transfers
CtExpRdApbDma	Total number of read transfers to the DMA peripherals APB Bridge
CtExpWrApbDma	Total number of write transfers to the DMA peripherals APB Bridge
CtExpRdApbCore	Total number of read transfers to the Core peripherals APB Bridge
CtExpWrApbCore	Total number of write transfers to the Core peripherals APB Bridge
CtExpBurstSingle	Number of single beat bursts
CtExpBurstIncr	Number of undefined length bursts

#### Table 4-10 EXP layer events

Counter Name	Description
CtExpBurstWrap4	Number of 4-beat wrapping bursts
CtExpBurstIncr4	Number of 4-beat incrementing bursts
CtExpBurstWrap8	Number of 8-beat wrapping bursts
CtExpBurstIncr8	Number of 8-beat incrementing bursts
CtExpBurstWrap16	Number of 16-beat wrapping bursts
CtExpBurstIncr16	Number of 16-beat incrementing bursts
CtExpWaitTotal	Total number of wait states
CtExpWaitNonSeqSlave	Number of wait states on the first transfer of a burst that were caused by a slave
CtExpWaitNonSeqBus	Number of wait states on the first transfer of a burst that were caused by the bus infrastructure
CtExpWaitThresholdHit	Number of occurrences that a wait-state exceeded a configurable threshold

#### Table 4-10 EXP layer events (continued)

#### Counted events on ARM-D layer

The ARM926EJ-S ARM-D BIU can perform all active AHB transfer types, that is reads and writes of size 8-, 16- and 32-bits. It performs only burst types SING, INCR, INCR4, INCR8, WRAP8 (Rd). Normal data transfers, cache operations and page table walks can be differentiated by using a combination of transfer direction, burst type and protection signal values.

There are no BUSY transfers on this layer.

Table 4-11 on page 4-19 shows all the events that are recorded on the ARM-D layer. These counters are enabled through the counter enable bit in the AHBMONCtrlReg register (see *AHBMONCtrlReg* on page 4-39) and are further controlled by the **DBGACK** and when the track **DBGACK** is asserted. The track **DBGACK**, when set, disables the counters during cycles that the **DBGACK** is asserted. All counters can be reset by writing to the AHBMONRstCntrs register, and preset to their absolute address by writing to the AHBMONPrstCntrs register.

#### Table 4-11 D layer events

Event Counter Name	Description
CtArmdRd	Total number of read transfers, including cache linefills and page table walks,
CtArmdWr	Total number of write transfers, including cache writebacks
CtArmdRdApbDma	Total number of read transfers to the DMA peripherals APB Bridge
CtArmdWrApbDma	Total number of write transfers to the DMA peripherals APB Bridge
CtArmdRdApbCore	Total number of read transfers to the Core peripherals APB Bridge
CtArmdWrApbCore	Total number of write transfers to the Core peripherals APB Bridge
CtArmdBurstSingle	Number of single word bursts, including page table walks
CtArmdBurstIncr4	Number of 4-word incrementing bursts, including half line cache writebacks
CtArmdBurstIncr8	Number of 8-word incrementing bursts, including full line cache write backs
CtArmdLineFill	Number of D-cache linefills, that is, CtArmdRdBurstWrap8 - number of 8-word wrapping read bursts.
CtArmdCastOut4	Number of half line cache writebacks, that is, CtArmdWrBurstIncr4ProtCBPD - number of 4-word incrementing write bursts with particular HPROT. This counter can also check for the INCR4 being 4-word aligned in order to filter out approximately 75% of the STM bursts that are incorrectly identified as cast-outs
CtArmdCastOut8	Number of full line cache writebacks, that is, CtArmdWrBurstIncr8ProtCBPD - number of 8-word incrementing write bursts with particular HPROT.

Event Counter Name	Description
CtArmdPageWalkD	Number of read transfers for D-side page table walks, that is, CtArmdRdBurstSingProtCBPD - number of single word reads with particular HPROT.
CtArmdPageWalkI	Number of read transfers for I-side page table walk reads ,that is, CtArmdRdBurstSingProtCBPI - number of single word reads with particular HPROT.
CtArmdWaitTotal	Total number of wait states
CtArmdWaitNonSeqSlave	Number of wait states on the first transfer of a burst that were caused by a slave
CtArmdWaitNonSeqBus	Number of wait states on the first transfer of a burst that were caused by the bus infrastructure
CtArmdWaitThresholdHit	Number of occurrences that a wait-state exceeded a configurable threshold

# Table 4-11 D layer events (continued)

#### Counted Events on the MBX GXI Layer

The MBX connects to the MPMC through a dedicated interconnect. The connection performs single unit read and write transfers over logically disjoint data buses. Further details of the interconnect are contained with the MBX TRM.

Table 4-12 shows all the events that are recorded on the MBX GXI bus. These counters are enabled through the counter enable bit in the AHBMONCtrlReg. All counters can be reset by writing to the AHBMONRstCntrs register, and preset to their absolute address by writing to the AHBMONPrstCntrs register.

Counter Name	Description
CtGxiWr	Number of completed write transfers.
CtGxiRd	Number of completed read requests.
CtGxiWrAddrWait	Number of wait cycles suffered by write requests.
CtGxiRdAddrWait	Number of wait cycles suffered by read requests.
CtGxiRdDataWait	Number of wait cycles suffered by pending read transfers.
CtGxiRdAWaitThresholdHit	Number of occurrences that a read request wait-state exceeded a configurable threshold, not a count of how many messages suffer the threshold latency.
CtGxiRdDWaitThresholdHit	Number of occurrences that a read transfer wait-state exceeded a configurable threshold.
CtGxiWrAWaitThresholdHit	Number of occurrences that a write wait-state exceeded a configurable threshold.
CtGxiPageChange	Number of times the transfer crossed a page boundary. The page boundary size can be configured to 2k, 4k, 8k or 16k.
GxiPageSize	Defines the page size that the CtGxiPageChange counter uses to monitor page boundary changes. $2'b00 = 2k$ , $2'b01 = 4k$ , $2'b10 = 8k$ , & $2'b11 = 16k$ .

#### Table 4-12 GXI events

#### Miscellaneous Counted Events with the AHB Monitor

Table 4-13 presents three additional counters included to enable the further evaluation of the system based on the number of cycles elapsed dependent on certain operating conditions. With exception of the CtTotalCycles, these counters are enabled through the counter enable bit in the AHBMONCtrlReg register (see *AHBMONCtrlReg* on page 4-39). The CtTotalCyclesNonDebug counter is controlled also by the **DBGACK** and when the track **DBGACK** is asserted. The track **DBGACK**, when set, disables the counter during cycles that the **DBGACK** is asserted. The latter two counters can be reset by writing to the AHBMONRstCntrs register, and preset to their absolute address by writing to the AHBMONPrstCntrs register.

Counter Name	Description
CtTotalCycles	Number of bus cycles since the last hardware reset
CtTotalCyclesEn	Number of bus cycles that the profile counters have been enabled since the last hardware reset or counter reset
CtTotalCyclesNonDebug	Number of bus cycles that the profile counters have been enabled since the last hardware reset or counter reset discounting debug cycles, based on <b>DBGACK</b> from the ARM processor

#### Table 4-13 Other events

# 4.3 AHB Monitor registers

Many of the registers in the AHB monitor replicate behavior over two or more PWP AHB layers. Therefore to minimize verboseness, the behaviors of the registers that overlap are described together. The generic description is referred to by replacing the reference to the specific AHB layer with *<layer>*:

Ct<layer>Rd Ct<layer>Wr Ct<layer>Rd<x> Ct<layer>Wr<x> Ct<layer>BurstSingle Ct<layer>BurstIncr CtExpBurstWrap4 Ct<layer>BurstIncr4 CtExpBurstWrap8 Ct<layer>BurstIncr8 CtExpBurstWrap16 Ct<layer>BurstIncr16 CtArm<x>LineFill CtArmdCastOut<x> CtArmdPageWalk<x> Ct<layer>WaitTotal Ct<layer>WaitNonSeqSlave Ct<layer>WaitNonSegBus Ct<layer>WaitThresholdHit <layer>WaitThreshold CtGxiWr CtGxiRd CtGxiWrAddrWait CtGxiRd<*layer*>Wait CtGxiPageCount **CtGxiPageSize** AHBMONRstCtrs AHBMONPrstCtrs AHBMONCtr1Reg **CtTotalCycles** CtTotalCyclesEn CtTotalCyclesNonDebug AHBMONPeriphID AHBMONPCellID

The AHB Monitor registers are shown in Table 4-14 on page 4-24.

Unless specified otherwise, the registers are 32-bit wide counters, read only, and reset to 0x0 on reset.

# Table 4-14 AHB Monitor registers

Name	Address	Description
CtArmiRd	0x101D0000	Counter. See <i>Ct</i> < <i>layer</i> > <i>Rd</i> on page 4-29.
CtArmiBurstSingle	0x101D0008	Counter. See Ct <layer>BurstSingle on page 4-30.</layer>
CtArmiBurstIncr4	0x101D0014	Counter. See Ct <layer>BurstIncr4 on page 4-31.</layer>
CtArmiLineFill	0x101D0040	Counter. See CtArm <layer>LineFill on page 4-33.</layer>
CtArmiWaitTotal	0x101D0030	Counter. See Ct <layer>WaitTotal on page 4-34.</layer>
CtArmiWaitNonSeqSlave	0x101D0028	Counter. See Ct <layer>WaitNonSeqSlave on page 4-34.</layer>
CtArmiWaitNonSeqBus	0x101D002C	Counter. See Ct <layer>WaitNonSeqBus on page 4-35.</layer>
CtArmiWaitThresholdHit	0x101D0034	Counter. See Ct <layer>WaitThresholdHit register on page 4-35.</layer>
ArmiWaitThreshold	0x101D0038	4-bit wide R/W Wait Threshold Register. See <i><layer>WaitThreshold</layer> register</i> on page 4-36.
CtClcdRd	0x101D0100	Counter. See Ct <layer>Rd on page 4-29.</layer>
CtClcdBurstIncr	0x101D010C	Counter. See Ct <layer>BurstIncr on page 4-31.</layer>
CtClcdBurstIncr4	0x101D0114	Counter. See Ct <layer>BurstIncr4 on page 4-31.</layer>
CtClcdBurstIncr8	0x101D011C	Counter. See Ct <layer>BurstIncr8 on page 4-32.</layer>
CtClcdBurstIncr16	0x101D0124	Counter. See Ct <layer>BurstIncr16 on page 4-33.</layer>
CtClcdWaitTotal	0x101D0130	Counter. See Ct <layer>WaitTotal on page 4-34.</layer>
CtClcdWaitNonSeqSlave	0x101D0128	Counter. See Ct <layer>WaitNonSeqSlave on page 4-34.</layer>
CtClcdWaitNonSeqBus	0x101D012C	Counter. See Ct <layer>WaitNonSeqBus on page 4-35.</layer>
CtClcdWaitThresholdHit	0x101D0134	Counter. See Ct <layer>WaitThresholdHit register on page 4-35.</layer>
ClcdWaitThreshold	0x101D0138	4-bit wide R/W Wait Threshold Register. See <i><layer>WaitThreshold</layer> register</i> on page 4-36.
CtDma0Rd	0x101D0200	Counter. See Ct <layer>Rd on page 4-29.</layer>
CtDma0Wr	0x101D0204	Counter. See Ct <layer>Wr on page 4-29.</layer>
CtDma0RdUart	0x101D0240	Counter. See <i>Ct</i> < <i>layer</i> > <i>Rd</i> < <i>x</i> > on page 4-29.
CtDma0WrUart	0x101D0244	Counter. See $Ct < layer > Wr < x >$ on page 4-30.
CtDma0RdSci	0x101D0248	Counter. See <i>Ct</i> < <i>layer</i> > <i>Rd</i> < <i>x</i> > on page 4-29.

Name	Address	Description
CtDma0WrSci	0x101D024C	Counter. See <i>Ct</i> < <i>layer</i> > <i>Wr</i> < <i>x</i> > on page 4-30.
CtDma0RdSsp	0x101D0250	Counter. See <i>Ct</i> < <i>layer</i> > <i>Rd</i> < <i>x</i> > on page 4-29.
CtDma0WrSsp	0x101D0254	Counter. See <i>Ct</i> < <i>layer</i> > <i>Wr</i> < <i>x</i> > on page 4-30.
CtDma0BurstIncr	0x101D020C	Counter. See Ct <layer>BurstIncr on page 4-31.</layer>
CtDma0BurstIncr4	0x101D0214	Counter. See Ct <layer>BurstIncr4 on page 4-31.</layer>
CtDma0BurstIncr8	0x101D021C	Counter. See Ct <layer>BurstIncr8 on page 4-32.</layer>
CtDma0BurstIncr16	0x101D0224	Counter. See Ct <layer>BurstIncr16 on page 4-33.</layer>
CtDma0WaitTotal	0x101D0230	Counter. See Ct <layer>WaitTotal on page 4-34.</layer>
CtDma0WaitNonSeqSlave	0x101D0228	Counter. See Ct <layer>WaitNonSeqSlave on page 4-34.</layer>
CtDma0WaitNonSeqBus	0x101D022C	Counter. See Ct <layer>WaitNonSeqBus on page 4-35.</layer>
CtDma0WaitThresholdHit	0x101D0234	Counter. See Ct <layer>WaitThresholdHit register on page 4-35.</layer>
Dma0WaitThreshold	0x101D0238	4-bit wide R/W Wait Threshold Register. See <i><layer>WaitThreshold</layer> register</i> on page 4-36.
CtDma1Rd	0x101D0300	Counter. See <i>Ct</i> < <i>layer</i> > <i>Rd</i> on page 4-29.
CtDma1Wr	0x101D0304	Counter. See <i>Ct</i> < <i>layer</i> > <i>Wr</i> on page 4-29.
CtDma1BurstIncr	0x101D030C	Counter. See <i>Ct</i> < <i>layer</i> > <i>BurstIncr</i> on page 4-31.
CtDma1BurstIncr4	0x101D0314	Counter. See Ct <layer>BurstIncr4 on page 4-31.</layer>
CtDma1BurstIncr8	0x101D031C	Counter. See Ct <layer>BurstIncr8 on page 4-32.</layer>
CtDma1BurstIncr16	0x101D0324	Counter. See Ct <layer>BurstIncr16 on page 4-33.</layer>
CtDma1WaitTotal	0x101D0330	Counter. See Ct <layer>WaitTotal on page 4-34.</layer>
CtDma1WaitNonSeqSlave	0x101D0328	Counter. See Ct <layer>WaitNonSeqSlave on page 4-34.</layer>
CtDma1WaitNonSeqBus	0x101D032C	Counter. See Ct <layer>WaitNonSeqBus on page 4-35.</layer>
CtDma1WaitThresholdHit	0x101D0334	Counter. See Ct <layer>WaitThresholdHit register on page 4-35.</layer>
Dma1WaitThreshold	0x101D0338	4-bit wide R/W Wait Threshold Register. See <i><layer>WaitThreshold</layer> register</i> on page 4-36.
CtExpRd	0x101D0400	Counter. See <i>Ct</i> < <i>layer</i> > <i>Rd</i> on page 4-29.

Name	Address	Description
CtExpWr	0x101D0404	Counter. See <i>Ct</i> < <i>layer</i> > <i>Wr</i> on page 4-29.
CtExpRdApbDma	0x101D0454	Counter. See <i>Ct</i> < <i>layer</i> > <i>Rd</i> < <i>x</i> > on page 4-29.
CtExpWrApbDma	0x101D0458	Counter. See <i>Ct</i> < <i>layer</i> > <i>Wr</i> < <i>x</i> > on page 4-30.
CtExpRdApbCore	0x101D045C	Counter. See <i>Ct</i> < <i>layer</i> > <i>Rd</i> < <i>x</i> > on page 4-29.
CtExpWrApbCore	0x101D0460	Counter. See <i>Ct</i> < <i>layer</i> > <i>Wr</i> < <i>x</i> > on page 4-30.
CtExpBurstSingle	0x101D0408	Counter. See Ct <layer>BurstSingle on page 4-30.</layer>
CtExpBurstIncr	0x101D040C	Counter. See Ct <layer>BurstIncr on page 4-31.</layer>
CtExpBurstWrap4	0x101D0410	Counter. See Ct <layer>BurstIncr4 on page 4-31.</layer>
CtExpBurstIncr4	0x101D0414	Counter. See Ct <layer>BurstIncr4 on page 4-31.</layer>
CtExpBurstWrap8	0x101D0418	Counter. See CtExpBurstWrap8 on page 4-32.
CtExpBurstIncr8	0x101D041C	Counter. See Ct <layer>BurstIncr8 on page 4-32.</layer>
CtExpBurstWrap16	0x101D0420	Counter. See CtExpBurstWrap16 on page 4-32.
CtExpBurstIncr16	0x101D0424	Counter. See Ct <layer>BurstIncr16 on page 4-33.</layer>
CtExpWaitTotal	0x101D0430	Counter. See Ct <layer>WaitTotal on page 4-34.</layer>
CtExpWaitNonSeqSlave	0x101D0428	Counter. See Ct <layer>WaitNonSeqSlave on page 4-34.</layer>
CtExpWaitNonSeqBus	0x101D042C	Counter. See Ct <layer>WaitNonSeqBus on page 4-35.</layer>
CtExpWaitThresholdHit	0x101D0434	Counter. See Ct <layer>WaitThresholdHit register on page 4-35.</layer>
CtExpWaitThreshold	0x101D0438	4-bit wide R/W Wait Threshold Register. See <i><layer>WaitThreshold</layer> register</i> on page 4-36.
CtArmdRd	0x101D0500	Counter. See Ct <layer>Rd on page 4-29.</layer>
CtArmdWr	0x101D0504	Counter. See <i>Ct</i> < <i>layer</i> > <i>Wr</i> on page 4-29.
CtArmdRdApbDma	0x101D0554	Counter. See <i>Ct</i> < <i>layer</i> > <i>Rd</i> < <i>x</i> > on page 4-29.
CtArmdWrApbDma	0x101D0558	Counter. See <i>Ct</i> < <i>layer</i> > <i>Wr</i> < <i>x</i> > on page 4-30.
CtArmdRdApbCore	0x101D055C	Counter. See <i>Ct</i> < <i>layer</i> > <i>Rd</i> < <i>x</i> > on page 4-29.
CtArmdWrApbCore	0x101D0560	Counter. See $Ct < layer > Wr < x >$ on page 4-30.

Name	Address	Description
CtArmdBurstSingle	0x101D0508	Counter. See Ct <layer>BurstSingle on page 4-30.</layer>
CtArmdBurstIncr4	0x101D0514	Counter. See Ct <layer>BurstIncr4 on page 4-31.</layer>
CtArmdBurstIncr8	0x101D051C	Counter. See Ct <layer>BurstIncr8 on page 4-32.</layer>
CtArmdLineFill	0x101D0540	Counter. See CtArm <layer>LineFill on page 4-33.</layer>
CtArmdCastOut4	0x101D0544	Counter. See <i>CtArmdCastOut</i> < <i>x</i> > on page 4-33.
CtArmdCastOut8	0x101D0548	Counter. See <i>CtArmdCastOut</i> < <i>x</i> > on page 4-33.
CtArmdPageWalkD	0x101D054C	Counter. See <i>CtArmdPageWalk</i> < <i>x</i> > on page 4-34.
CtArmdPageWalkI	0x101D0550	Counter. See <i>CtArmdPageWalk</i> < <i>x</i> > on page 4-34.
CtArmdWaitTotal	0x101D0530	Counter. See Ct <layer>WaitTotal on page 4-34.</layer>
CtArmdWaitNonSeqSlave	0x101D0528	Counter. See Ct <layer>WaitNonSeqSlave on page 4-34.</layer>
CtArmdWaitNonSeqBus	0x101D052C	Counter. See Ct <layer>WaitNonSeqBus on page 4-35.</layer>
CtArmdWaitThresholdHit	0x101D0534	Counter. See Ct <layer>WaitThresholdHit register on page 4-35.</layer>
CtArmdWaitThreshold	0x101D0538	Wait Threshold Register. See <i><layer>WaitThreshold register</layer></i> on page 4-36.
CtGxiWr	0x101D0604	Counter. See <i>Ct</i> < <i>layer</i> > <i>Wr</i> on page 4-29.
CtGxiRd	0x101D0600	Counter. See <i>Ct</i> < <i>layer</i> > <i>Rd</i> on page 4-29.
CtGxiWrAddrWait	0x101D0610	Counter. See <i>Ct</i> < <i>layer</i> > <i>Wr</i> < <i>x</i> > on page 4-30.
CtGxiRdAddrWait	0x101D0620	Counter. See <i>Ct</i> < <i>layer</i> > <i>Rd</i> < <i>x</i> > on page 4-29.
CtGxiRdDataWait	0x101D0630	Counter. See <i>Ct</i> < <i>layer</i> > <i>Rd</i> < <i>x</i> > on page 4-29.
CtGxiWrAWaitThresholdHit	0x101D0614	Counter. See <i>Ct</i> < <i>layer</i> > <i>Wr</i> < <i>x</i> > on page 4-30.
CtGxiWrAWaitThreshold	0x101D0618	4-bit wide R/W Wait Threshold Register. See <i>Ct<layer>Wr<x></x></layer></i> on page 4-30.
CtGxiRdAWaitThresholdHit	0x101D0624	Counter. See <i>Ct</i> < <i>layer</i> > <i>Rd</i> < <i>x</i> > on page 4-29.
CtGxiRdAWaitThreshold	0x101D0628	4-bit wide R/W Wait Threshold Register. See <i><layer>WaitThreshold</layer> register</i> on page 4-36.
CtGxiRdDWaitThresholdHit	0x101D0634	Counter. See <i>Ct</i> < <i>layer</i> > <i>Rd</i> < <i>x</i> > on page 4-29.

Name	Address	Description
CtGxiRdDWaitThreshold	0x101D0638	4-bit wide R/W Wait Threshold Register. See <i>Ct<layer>Rd<x></x></layer></i> on page 4-29.
CtGxiPageChange	0x101D0608	Counter. See CtGxiPageChange on page 4-38.
CtGxiPageSize	0x101D0E08	2-bit Read-only register that selects page size used by the page change counter. See <i>GxiPageSize</i> on page 4-38.
CtTotalCycles	0x101D0700	Value of a counter of bus cycles. See CtTotalCycles on page 4-39.
CtTotalCyclesEn	0x101D0704	Value of a counter of bus cycles. See CtTotalCyclesEn on page 4-39.
CtTotalCyclesNonDebug	0x101D0708	Value of a counter of bus cycles. See <i>CtTotalCyclesNonDebug</i> on page 4-39.
AHBMONRstCtrs	0x101D0E00	Counter reset register. See <i>AHBMONRstCtrs</i> on page 4-38. Write-only.
AHBMONCtrlReg	0x101D0E04	3-bit R/W Monitor control register. See <i>AHBMONCtrlReg</i> on page 4-39. Reset value is 0x0.
AHBMONPeriphID0-3	0x101D0FE0	Peripheral identification registers Read-only value 0x00041000. See <i>AHBMONPeriphID 0 to 3</i> on page 4-40.
AHBMONPCellID0-3	0x101D0FF0	PrimeCell identification registers. See <i>AHBMONPCellID</i> on page 4-41. Read-only value is 0xB105F00D.

#### 4.3.1 Ct<layer>Rd

There are six read count registers. Each is associated with a specific AHB layer:

- CtArmdRd
- CtArmiRd
- CtDma0Rd
- CtDma1Rd
- CtClcdRd
- CtExpRd.

The registers contain the total count of completed read transfers of all possible burst types that have occurred on the associated AHB layer. The count is disabled by default and can be controlled through the AHBMONCtrlReg, and reset through the AHBMONRstCtrs. The counters associated with the ARM D and ARM I layers are also controlled by the **DBGACK** in relation to configuration, see *AHBMONCtrlReg* on page 4-39.

#### 4.3.2 Ct<layer>Wr

The write count registers are associated with a AHB layer that contains a master that is write capable.

- CtArmdWr
- CtDma0Wr
- CtDma0Rd
- CtExpWr.

The registers contain the total count of completed write transfers of all possible burst types that have occurred on the associated AHB layer. The count is disabled by default and can be controlled through the AHBMONCtrlReg, and reset through the AHBMONRstCtrs. The counters associated with the ARM D layer are also controlled by the **DBGACK** in relation to configuration, see *AHBMONCtrlReg* on page 4-39.

#### 4.3.3 Ct<layer>Rd<x>

The specific read count registers are associated with an access to a specific APB slave or APB bridge:

- CtDma0RdUart
- CtDma0RdSci
- CtDma0RdSSP
- CtArmdRdApbDma.

These registers contain the total count of completed read transfers of all possible burst types that have occurred on the DMA-0 AHB layer that have accessed a specific APB slave. The count is disabled by default and can be controlled through the AHBMONCtrlReg, and reset through the AHBMONRstCtrs. The counters associated with the ARM D layer are also controlled by **DBGACK** in relation to configuration, see *AHBMONCtrlReg* on page 4-39.

#### 4.3.4 Ct<layer>Wr<x>

The specific write count register are associated with an access to a specific APB slave:

- CtDma0WrUart
- CtDma0WrSci
- CtDma0WrSSP
- CtArmdWrApbDma
- CtArmdWrApbCore
- CtExpWrApbDma
- CtExpWrApbCore.

These registers contain the total count of completed write transfers of all possible burst types that have occurred on the DMA-0 AHB layer that have accessed a specific APB slave. The count is disabled by default and can be controlled through the AHBMONCtrlReg, and reset through the AHBMONRstCtrs. The counters associated with the ARM D layer are also controlled by the **DBGACK** in relation to configuration, see *AHBMONCtrlReg* on page 4-39.

#### 4.3.5 Ct<layer>BurstSingle

The SINGLE burst count registers are associated with a AHB layer that contains a master that is capable of this burst format:

- CtArmdBurstSingle
- CtArmiBurstSingle
- CtExpBurstSingle.

These registers contain the total count, read + write, of completed single burst transfers that have occurred on the associated AHB layer. The count is disabled by default and can be controlled through the AHBMONCtrlReg, and reset through the AHBMONRstCtrs. The counters associated with the ARM D and ARM I layers are also controlled by the **DBGACK** in relation to configuration, see *AHBMONCtrlReg* on page 4-39.

#### 4.3.6 Ct*<layer>*BurstIncr

The read count registers are associated with a specific AHB layer that contains a master that is capable of this burst format.

- CtDma0BurstIncr
- CtDma1BurstIncr
- CtClcdBurstIncr
- CtExpBurstIncr.

These registers contain the total count, read + write, of completed unspecified length burst transfers that have occurred on the associated AHB layer. The count is disabled by default and can be controlled through the AHBMONCtrlReg, and reset through the AHBMONRstCtrs.

# 4.3.7 CtExpBurstWrap4

Only the EXPansion bus contains a master that is capable of issuing a WRAP4 burst transfer, the AHB-AHB bridge, which interfaces external AHB master components to the PWP environment.

This register contains the total count, read + write, of completed WRAP4 burst transfers that have occurred on the EXPansion AHB layer. The count is disabled by default and can be controlled through the AHBMONCtrlReg, and reset through the AHBMONRstCtrs.

#### 4.3.8 Ct<layer>BurstIncr4

The INCR4 burst count registers are associated with a specific AHB layer that contains a master that is capable of this burst format:

- CtArmdBurstIncr4
- CtArmiBurstIncr4
- CtDma0BurstIncr4
- CtDma1BurstIncr4
- CtClcdBurstIncr4
- CtExpBurstIncr4.

These registers contain the total count, read + write, of completed INCR4 burst transfers that have occurred on the associated AHB layer. The count is disabled by default and can be controlled through the AHBMONCtrlReg, and reset through the AHBMONRstCtrs. The counters associated with the ARM D and ARM I layers are also controlled by the **DBGACK** in relation to configuration, see *AHBMONCtrlReg* on page 4-39.

#### 4.3.9 CtExpBurstWrap8

Only the EXPansion bus contains a master that is capable of issuing a WRAP8 burst transfer that is referred to by the burst name, namely the AHB-AHB bridge, which interfaces external AHB master components to the PWP environment. The ARM926PXP also performs WRAP8 burst transfers, but the counts are referred by the associated activity of a cache line fill.

This register contains the total count, read + write, of completed WRAP8 burst transfers that have occurred on the EXPansion AHB layer. The count is disabled by default and can be controlled through the AHBMONCtrlReg, and reset through the AHBMONRstCtrs.

#### 4.3.10 Ct<*layer*>BurstIncr8

The INCR8 burst count registers are associated with a specific AHB layer that contains a master that is capable of this burst format. This description is valid for the following registers:

- CtArmdBurstIncr8
- CtDma0BurstIncr8
- CtDma1BurstIncr8
- CtClcdBurstIncr8
- CtExpBurstIncr8.

These registers contain the total count, read + write, of completed INCR8 burst transfers that have occurred on the associated AHB layer. The count is disabled by default and can be controlled through the AHBMONCtrlReg, and reset through the AHBMONRstCtrs. The counter associated with the ARM D layer is also controlled by the **DBGACK** in relation to configuration, see *AHBMONCtrlReg* on page 4-39.

#### 4.3.11 CtExpBurstWrap16

Only the EXPansion bus contains a master that is capable of issuing a WRAP16 burst transfer, the AHB-AHB bridge, which interfaces external AHB master components to the PWP environment.

This register contains the total count, read + write, of completed WRAP16 burst transfers that have occurred on the EXPansion AHB layer. The count is disabled by default and can be controlled through the AHBMONCtrlReg, and reset through the AHBMONRstCtrs.

# 4.3.12 Ct<layer>BurstIncr16

The INCR16 burst count registers are associated with a specific AHB layer that contains a master that is capable of this burst format:

- CtDma0BurstIncr16
- CtDma1BurstIncr16
- CtClcdBurstIncr16
- CtExpBurstIncr16.

These registers contain the total count, read + write, of completed INCR16 burst transfers that have occurred on the associated AHB layer. The count is disabled by default and can be controlled through the AHBMONCtrlReg, and reset through the AHBMONRstCtrs.

#### 4.3.13 CtArm<layer>LineFill

The ARM926 instruction and data AHB interfaces use the WRAP8 burst format to perform cache line fills. There are two line file counters:

- CtArmdLineFill
- CtArmiLineFill.

These registers contain the total count of completed cache line fill transactions, WRAP8 burst, that have occurred on the associated AHB ARM layer. The count is disabled by default and can be controlled through the AHBMONCtrlReg, and reset through the AHBMONRstCtrs. The counters are also controlled by the **DBGACK** in relation to configuration, see *AHBMONCtrlReg* on page 4-39.

#### 4.3.14 CtArmdCastOut<x>

The ARM926 data AHB interface uses the INCR4 burst format, with specific protection bits set, to perform cache writebacks. The writeback can be either full or half cache line writes:

- CtArmdCastOut4
- CtArmdCastOut8.

These registers contain the total count of completed cache line writeback transactions that have occurred on the ARM-D AHB layer. The count is disabled by default and can be controlled through the AHBMONCtrlReg, and reset through the AHBMONRstCtrs. The counters are also controlled by the **DBGACK** in relation to configuration, see *AHBMONCtrlReg* on page 4-39.

#### 4.3.15 CtArmdPageWalk<x>

The ARM926 data AHB interface uses the SINGLE burst format with a specific protection bits set to perform page table walks for either the instruction or data path:

- CtArmdPageWalkD
- CtArmdPageWalkI.

These registers contain the total count of completed page table walk transactions that have occurred on the ARM-D AHB layer for the Instruction or Data path. The count is disabled by default and can be controlled through the AHBMONCtrlReg, and reset through the AHBMONRstCtrs. The counters are also controlled by the **DBGACK** in relation to configuration, see *AHBMONCtrlReg* on page 4-39.

#### 4.3.16 Ct*<layer>*WaitTotal

The six wait registers are associated with a specific AHB layer:

- CtArmdWaitTotal
- CtArmiWaitTotal
- CtDma0WaitTotal
- CtDma1WaitTotal
- CtClcdWaitTotal
- CtExpWaitTotal.

These registers contain the total count of wait states observed on the associated AHB layer. The count is disabled by default and can be controlled through the AHBMONCtrlReg, and reset through the AHBMONRstCtrs. The counters associated with the ARM D and ARM I layers are also controlled by the **DBGACK** in relation to configuration, see *AHBMONCtrlReg* on page 4-39.

#### 4.3.17 Ct<layer>WaitNonSeqSlave

The NONSEQ slave wait count registers are associated with a specific AHB layer:

- CtArmdWaitNonSeqSlave
- CtArmiWaitNonSeqSlave
- CtDma0WaitNonSeqSlave
- CtDma1WaitNonSeqSlave
- CtClcdWaitNonSeqSlave
- CtExpWaitNonSeqSlave.

These registers contain the total count of wait states incurred on the first transfer of a burst caused by the slave on the associated AHB layer from the matrix or locally. The count is disabled by default and can be controlled through the AHBMONCtrlReg, and
reset through the AHBMONRstCtrs. The counters associated with the ARM D and ARM I layers are also controlled by the **DBGACK** in relation to configuration, see *AHBMONCtrlReg* on page 4-39.

## 4.3.18 Ct<layer>WaitNonSeqBus

The NONSEQ bus wait count registers are associated with a specific AHB layer:

- CtArmdWaitNonSeqBus
- CtArmiWaitNonSeqBus
- CtDma0WaitNonSeqBus
- CtDma1WaitNonSeqBus
- CtClcdWaitNonSeqBus
- CtExpWaitNonSeqBus.

These registers contain the total count of wait states incurred on the first transfer of a burst caused by the bus infrastructure on the associated AHB layer. The count is disabled by default. It can be controlled through AHBMONCtrlReg and reset through AHBMONRstCtrs.

## 4.3.19 Ct<layer>WaitThresholdHit register

The WaitThresholdHit registers are associated with a specific AHB layer:

- CtArmdWaitThresholdHit
- CtArmiWaitThresholdHit
- CtDma0WaitThresholdHit
- CtDma1WaitThresholdHit
- CtClcdWaitThresholdHit
- CtExpWaitThresholdHit
- CtGxiRdAWaitThresholdHit
- CtGxiRdDWaitThresholdHit
- CtGxiWrAWaitThresholdHit.

These registers contain the number of stall instances that exceeded a maximum number of wait states on the associated AHB layer specified by the associated threshold register. The default threshold is 16. The count is disabled by default and can be controlled through the AHBMONCtrlReg, and reset through the AHBMONRstCtrs.

## 4.3.20 <layer>WaitThreshold register

The eight WaitThresholdHit registers are associated with a specific AHB layer:

- ArmdWaitThreshold
- ArmiWaitThreshold
- Dma0WaitThreshold
- Dma1WaitThreshold
- ClcdWaitThreshold
- GxiRdAWaitThreshold
- GxiRdDWaitThreshold
- GxiWrAWaitThreshold.

## Table 4-1 <layer>WaitThreshold

Bits	Name	Туре	Function
[31:4]	-	-	Reserved, read undefined, must be written to with zeros.
[3:0]	< <i>layer</i> >WaitThreshold	Read/write	Contains the threshold for the maximum number of stall cycles that may occur on the associated AHB layer before the associated threshold violation counter is incremented The default threshold value is 0.

## 4.3.21 CtGxiWr

The MBX GXI performs a write transfer in the same cycle as the address cycle, which is acknowledged by the **GAREADY** signal. The MBX initiates a write transfer request by driving **GWRITE** and **GTRANS** HIGH.

This register contains the total count of completed write transfers that have occurred on the MBX GXI Bus. The count is disabled by default. It can be controlled through AHBMONCtrlReg and reset through AHBMONRstCtrs.

## 4.3.22 CtGxiRd

The MBX GXI performs a read transfer completely disjoint from the address cycle. Transfer requests are acknowledged in the address cycle with the **GAREADY** signal, and transfers are completed in subsequent cycles, which are acknowledged by the **GDREADY** signal. The MBX initiates a read transfer request by driving **GWRITE** LOW and **GTRANS** HIGH.

This register contains the total count of completed read transfers that have occurred on the MBX GXI Bus. This register does not contain the total number of accepted transfer requests. The count is disabled by default and can be controlled through the AHBMONCtrlReg, and reset through the AHBMONRstCtrs.

## 4.3.23 CtGxiWrAddrWait

The MBX GXI performs a write transfer in the same cycle as the address cycle, which can be stalled by taking the **GAREADY** signal LOW. The MBX initiates a write transfer request by driving **GWRITE** and **GTRANS** HIGH.

This register contains the total count of stalled write transfers that have occurred on the MBX GXI bus. The count is disabled by default and can be controlled through the AHBMONCtrlReg, and reset through the AHBMONRstCtrs.

## 4.3.24 CtGxiRd<layer>Wait

The MBX GXI performs a read transfer completely disjoint from the address cycle. Transfer requests are acknowledged in the address cycle with the **GAREADY** signal, and transfers can be stalled by driving the **GDREADY** signal LOW. The MBX initiates a read transfer request by driving **GWRITE** LOW and **GTRANS** HIGH.

This description is valid for the following registers:

- CtGxiRdAddrWait
- CtGxiRdDataWait.

These registers contain the total count of wait cycles suffered by read transfers that have occurred on the MBX GXI bus. The count is disabled by default and can be controlled through the AHBMONCtrlReg, and reset through the AHBMONRstCtrs.

# 4.3.25 CtGxiPageChange

The MBX transfers are limited to single word transactions. Page changes are tracked to monitor the behavior of the memory interface of the MBX.

Contains the total count of transfers that causes a page change from the previous transfer. The page size is set by the GxiPageSize register. The count is disabled by default and can be controlled through the AHBMONCtrlReg, and reset through the AHBMONRstCtrs.

## 4.3.26 GxiPageSize

Page changes are tracked to monitor the behavior of the memory interface based on the size defined within this register as shown in Table 4-1.

Bits	Name	Туре	Function
[31:2]	-	-	Reserved, read undefined, must be written to with zeros.
[1:0]	GxiPageSize	Read/write	Defines the page size that the CtGxiPageChange uses. Register encoding is: b00 = 2k b01 = 4k b10 = 8k b11 = 16k.

## Table 4-1 GxiPageSize

## 4.3.27 AHBMONRstCtrs

The AHB Monitor disables all the event counters at reset. To enable collection of statistical data for specific code segments or operations the AHBMONRstCtrs was included to allow a software reset of the counters.

A write of any value resets all counters.

## 4.3.28 AHBMONPrstCtrs

The AHB Monitor disables all the event counters at reset. To enable integration testing of the AHB monitor the AHBMONPrstCtrs was included to allow software to preset the counters with unique identifiers. When preset, each counter is loaded with the address that is used to read it.

A write of any value presets all counters with its absolute address. This action also disables the counters to ensure the values are held.

# 4.3.29 AHBMONCtrlReg

The AHB Monitor disables all the event counters at reset, but enables the Debug output. For normal device operation the information produced by the AHB Monitor is not required. AHBMONCtrlReg was included to enable or disable the AHB monitor module. The Track **DBGACK** bit was included to provide method of discounting bus activity caused by the processor operating in debug mode. It only affects the counters associated with the ARM-D and ARM-I layers, and the CtTotalCyclesNonDebug counter.

## Table 4-2 AHBMONCtrlReg

Bits	Name	Туре	Function
31:3	-	-	Reserved, read undefined, must be written as zeros
2	Track DBGACK	Read/write	When set, it disables ARM x counters when <b>DBGACK</b> is asserted. Default value at reset is 0.
1	Counter Enable	Read/write	Enables all event counters. Default value at reset is 0.
0	Debug Enable	Read/write	Enables the debug output. Default value at reset is 1.

## 4.3.30 CtTotalCycles

This register contains the total count of AHB bus cycles since the last hardware reset. The counter cannot be reset and wraps at the upper boundary.

## 4.3.31 CtTotalCyclesEn

This register contains the total count of AHB Monitor, event counter enabled, AHB bus cycles since the last hardware or software reset. The count is disabled by default and is be controlled through AHBMONCtrlReg[1], and reset through the AHBMONRstCtrs.

# 4.3.32 CtTotalCyclesNonDebug

The CtTotalCyclesNonDebug counter was included to provide a duration count that can be used in association to the ARM-D and ARM-I layers when the track **DBGACK** bit is set in the AHBMONCtrlReg.

This register contains the total count of AHB bus cycles since the last hardware or software reset, with the event counter enabled while **DBGACK** is asserted LOW and AHBMONCtrlReg[2] is asserted HIGH. The count is disabled by default and is be controlled through AHBMONCtrlReg[1], and reset through the AHBMONRstCtrs.

# 4.3.33 AHBMONPeriphID 0 to 3

Bits [7:0] of the four AHBMONPeriphID[3:0] registers form a conceptual 32-bit register that provides a method of identification and version information for the AHB Monitor as shown in Figure 4-3. The bit ranges are shown in Table 4-1.

Actual register bit assignment



Conceptual register bit assignment

#### Figure 4-3 Peripheral ID register

## Table 4-1 AHBMONPeriphID

Bits	Name	Туре	Function
[31:24]	Configuration	Read	This is the configuration option of the peripheral. The configuration value is 0.
[23:20]	Revision	Read	This is the revision number of peripheral. The revision number starts from 0.
[19:12]	Designer	Read	This is the identification of the designer. ARM Limited. is 0x41, ASCII A.
[11:0]	Part number	Read	This identifies the peripheral. The three digit product code is 0x0816.

# 4.3.34 AHBMONPCellID

Bits [7:0] of the four AHBMONPCelIID[3:0] registers form a conceptual 32-bit register that is used as a standard cross-peripheral identification system as shown in Figure 4-4. It is set at the value of 0xB105F00D.



onceptual register bit assignment

Figure 4-4 PrimeCell ID register

# 4.4 AHB Monitor signals on pads

The output signals are shown in Table 4-1.

# Table 4-1 Output pad signal descriptions

Name	Description
AHBMONITOR[32:29]	GXI bus subpacket
AHBMONITOR[28:23]	ARM data bus subpacket
AHBMONITOR[22:19]	ARM instruction bus subpacket
AHBMONITOR[18:14]	DMA 0 bus subpacket
AHBMONITOR[13:9]	DMA 1 bus subpacket
AHBMONITOR[8:4]	Expansion bus subpacket
AHBMONITOR[3:0]	LCD bus subpacket

# Chapter 5 Color LCD Controller (CLCDC)

This chapter describes the display controller in the ARM926EJ-S Development Chip. It contains the following sections:

- *About the CLCDC* on page 5-2
- *Functional description* on page 5-4
- *CLCD signals on pads* on page 5-31.

# 5.1 About the CLCDC

The PrimeCell Smart Color LCD Controller PL110 (CLCDC) is an *Advanced Microcontroller Bus Architecture* (AMBA) compliant *System-on-a-Chip* (SoC) peripheral that is developed, tested, and licensed by ARM. The CLCDC connects to the AHB bus matrix.

The release version used is PL110 CLCDC r0p0-00alp0. For detailed information on the controller, see the *ARM PrimeCell Color LCD Controller (PL110) Technical Reference Manual*. The base address for the CLCDC registers is 0x10120000.

The CLCDC performs translation of pixel-coded data into the required formats and timings to drive a variety of single/dual mono and color LCDs.

Support is provided for passive *Super Twisted Nematic* (STN) and active *Thin Film Transistor* (TFT) LCD display types.

STN displays	STN display panels require algorithmic pixel pattern generation to
	provide pseudo gray-scaling on mono, or color creation on color
	displays.

**TFT displays** TFT display panels require the digital color value of each pixel to be applied to the display data inputs.

Packets of pixel coded data are fed using the AMBA AHB interface, to two independent, programmable, 32-bit wide, DMA FIFOs that act as input data flow buffers.

The buffered pixel coded data is then unpacked using a pixel serializer.

Depending on the LCD type and mode, the unpacked data can represent:

- an actual true display gray or color value
- an address to a 256x16 bit wide palette ram gray or color value.

In the case of STN displays, either a value obtained from the addressed palette location or the true value is passed to the gray-scaling generators. The hardware coded gray-scale algorithm logic sequences the addressed pixels activity over a programmed number of frames to provide the effective display appearance.

For TFT displays, either an addressed palette value or true color value is passed directly to the output display drivers, bypassing the gray-scaling algorithmic logic.

Besides data formatting, the CLCDC provides a set of programmable display control signals, that include:

- LCD panel power enable
- pixel clock
- horizontal and vertical synchronization pulses
- display bias.

The CLCDC uses the external clock source **CLCDCLKEXT** for timing the pixel clock.

The CLCDC data output can be converted to a VGA display signal by adding an external *Digital to Analog Converter* (DAC).

- upper or lower panel DMA FIFO underflow
- base address update signification
- vertical compare
- bus error.

There is also a single combined interrupt that is raised when any of the individual interrupts become active. The combined interrupt signal is output to interrupt 16 of the VIC.

# 5.1.1 Hardware cursor support

The PL110 controller in the ARM926EJ-S Development Chip has been extended to include a hardware cursor extension that reduces software overheads associated with maintaining a cursor image in the CLCDC frame buffer (see *Hardware cursor extension to PL110* on page 5-7).

# 5.2 Functional description

Simplified block diagrams of the CLCDC and the external interface are shown in Figure 5-1 and Figure 5-2 on page 5-5.



Figure 5-1 CLCDC internal organization



Figure 5-2 CLCDC block diagram

# 5.2.1 Registers

The base address of the ARM PrimeCell CLCDC is 0x10120000.

The following locations are reserved, and must not be used during normal operation:

- locations 0x10120050–0x101201FC are reserved for possible future extensions
- locations 0x10120400–0x101207FF are reserved for test purposes
- locations 0x10120C30–0x10120FDC are reserved for possible future extensions.

The following locations have a different function in the ARM926EJ-S Development Chip PL110 than that used is the standard PL110 controller:

- locations 0x10120018–0x1012001C are swapped (see Table 5-1).
- locations 0x10120800–0x10120C2C are used for the hardware cursor (see *Hardware cursor registers* on page 5-17).
- locations 0x10120FE0-0x10120FFC are the CLCD Peripheral ID and PrimeCell ID registers.

Address (Dev. Chip)	Reset value (Dev. Chip)	Description in PL110 TRM	Difference for CLCDC in ARM926EJ-S Development Chip
0x10120018	0x0	LCDControl, LCD panel pixel parameters	CLCDC TRM lists address as 0x1012001C
0x1012001C	0x0	LCDIMSC, interrupt mask set and clear	CLCDC TRM lists address as 0x10120018
0x10120800- 0x10120C2C	0x0	Not present	Hardware cursor registers from PL111 (see the <i>ARM926EJ-S Technical Reference Manual</i> for details)
0x10120FE0	0x93	CLCDPeriphID0	CLCDC TRM lists value as 0x10
0x10120FE4	0x10	CLCDPeriphID1	CLCDC TRM lists value as 0x11

## Table 5-1 PrimeCell CLCDC register differences

# 5.3 Hardware cursor extension to PL110

The PL110 controller in the ARM926EJ-S Development Chip has been extended to include a hardware cursor extension.

## 5.3.1 Hardware cursor extension

Before the hardware cursor was introduced, moving the cursor required software to:

- save an image of the area under the next cursor position
- update the area with the cursor image
- repair the last cursor position with a previously saved image.

With a cursor size of 64x64 and 24-bit color, each cursor move involved reading and writing approximately 75KB of data. The hardware cursor, however, provides a completely separate image buffer for the cursor, and superimposes the cursor image on the LCD output stream at the current cursor (X,Y) coordinate. To move the hardware cursor, the software driver supplies a new cursor coordinate. Because the frame buffer requires no modification, this significantly reduces the software overhead.

The cursor image is held in the CLCDC in a 256x32-bit dual-port RAM. The contents are programmed through the CLCDC AMBA AHB slave interface.

Figure 5-3 shows a block diagram of the hardware cursor.



## Figure 5-3 Hardware cursor block diagram

# Operation

All cursor programming registers are accessed through the CLCDC slave interface. The cursor image is held in the CLCDC in a 256x32-bit dual-port RAM.

When enabled, the hardware cursor uses the horizontal and vertical synchronization signals, along with a pixel clock enable and various display parameters to calculate the current scan coordinate such as:

- Horizontal Back Porch (HBP)
- Vertical Back Porch (VBP)
- *Horizontal ACtive line* (HAC)
- Vertical Active Column (VAC)
- *Pixels-Per-Line* (PPL)
- Lines-Per-Panel (LPP).

When the display point is inside the bounds of the cursor image, the cursor replaces frame buffer pixels with cursor pixels.

The image RAM offers single cycle performance to enable the read to take place in the clock cycle preceding its use, and maintains the data output until the next access. This removes the requirement for a holding register.

When the last cursor pixel is displayed, an interrupt is generated that can be used by software as an indication that it is safe to modify the cursor image. This enables software controlled animations to be performed without flickering for frame synchronized cursors.

## Supported cursor sizes

Table 5-2 shows the two cursor sizes that are supported.

X Pixels	Y Pixels	Bits per pixel	Words per line	Words in cursor image
32	32	2	2	64
64	64	2	4	256

Table 5-2 Supported cursor images

## Movement

The following descriptions assume that both the screen and cursor origins are at the top left of the visible screen (the first visible pixel scanned each frame). Each pixel coordinate is assumed to be the top left corner of the pixel as shown in Figure 5-4.



#### Figure 5-4 Hardware cursor movement

The ClcdCrsrXY Register controls the cursor position on the cursor overlay. This provides separate fields for X and Y ordinates.

The ClcdCrsrConfig Register (see *Cursor Configuration Register* on page 5-20) provides a FrameSync bit controlling the visible behavior of the cursor.

With FrameSync inactive, the cursor responds immediately to any change in the programmed ClcdCrsrXY value. Some transient smearing effects are likely to be visible if the cursor is moved across the LCD scan line.

With FrameSync active, the cursor only updates its position after a vertical synchronization has occurred. This provides clean cursor movement, but the cursor position only updates once a frame

The ClcdCrsrXY Register (see *Cursor XY Position Register* on page 5-21) is programmed with positive binary values that enable the cursor image to be located anywhere on the visible screen image. The cursor image is clipped automatically at the screen limits when it extends beyond the screen image to the right or bottom (see X1,Y1 in Figure 5-5 on page 5-10). The checked pattern shows the visible portion of the cursor. Because the ClcdCrsrXY Register values are positive integers, to emulate cursor clipping on the left and top of screen, a Clip Index Register, ClcdCrsrClipXY, is provided. This determines which point of the cursor image is positioned at the ClcdCrsrXY coordinate. For clipping functions on the Y axis, ClcdCrsrXY(X) is zero, and Clip(X) is programmed to provide the offset into the cursor image (X2 and X3). The equivalent function is provided to clip on the X axis at the top of the display (Y2).

For cursors that are not clipped at the X=0 or Y=0 lines, program the Clip Index Register X and Y fields with zero to display the cursor correctly. See Clip(X4,Y4) for the effect of incorrect programming.



Figure 5-5 Hardware cursor clipping

## Image format

The LCD frame buffer supports three packing formats, but the hardware cursor image requirement has been simplified to support only LBBP. This is little-endian byte, big-endian pixel for Windows CE mode.

The Image RAM start address (IBase) is 0x10120800.

The displayed cursor coordinate system is expressed in terms of (X,Y). 64x64 is an extension of the 32x32 format shown in Figure 5-6.

				TOP				
	(0,0)	(1,0)	(2,0)		(29,0)	(30,0)	(31,0)	
	(0,1)	(1,1)	(2,1)	,,	(29,1)	(30,1)	(31,1)	
	(0,2)	(1,2)	(2,2)		(29,2)	(30,2)	(31,2)	
LEFT	)		, , , ,		, , , ,	,, , ,	,, , ,	RIGHT
	(0,29)	(1,29)	(2,29)		(29,29)	(30,29)	(31,29)	
	(0,30)	(1,30)	(2,30)		(29,30)	(30,30)	(31,30)	
	(0,31)	(1,31)	(2,31)		(29,31)	(30,31)	(31,31)	

BOTTOM

Figure 5-6 Hardware cursor image format

For 32x32 bit pixels, four cursors are held in memory, each with the same pixel format. Table 5-3 lists the base addresses for the four cursors.

AddressDescription0x10120800Cursor0 start address0x10120900Cursor1 start address0x10120A00Cursor2 start address0x10120B00Cursor3 start address

Table 5-3 32x32 cursor base addresses

Table 5-4 and Table 5-5 on page 5-13 list the LBBP buffer to pixel mapping for Cursor0.

Offset from CLCDC base	Dataword								
at 0x10120800	[31:30]	[29:28]	[27:26]	[25:24]	[23:22]	[21:20]	[19:18]	[17:16]	
+0	(12,0)	(13,0)	(14,0)	(15,0)	(8,0)	(9,0)	(10,0)	(11,0)	
+4	(28,0)	(29,0)	(30,0)	(31,0)	(24,0)	(25,0)	(26,0)	(27,0)	
+(8*y)	(12 <b>,</b> y)	(13,y)	(14 <b>,</b> y)	(15,y)	(8,y)	(9,y)	(10,y)	(11 <b>,</b> y)	
+(8*y)+4	(28,y)	(29,y)	(30,y)	(31,y)	(24,y)	(25,y)	(26,y)	(27 <b>,</b> y)	
+0xF8	(12,31)	(13,31)	(14,31)	(15,31)	(8,31)	(9,31)	(10,31)	(11,31)	
+0xFC	(28,31)	(29,31)	(30,31)	(31,31)	(24,31)	(25,31)	(26,31)	(27,31)	

Table 5-4 LBBP buffer	to pixel mapping	32x32 Cursor0 fo	r datawords [31:16]

\_

Offset from CLCDC	Dataword								
base at 0x10120800	[15:14]	[13:12]	[]11:10]	[9:8]	[7:6]	[5:4]	[3:2]	[1:0]	
+0	(4,0)	(5,0)	(6,0)	(7,0)	(0,0)	(1,0)	(2,0)	(3,0)	
+4	(20,0)	(21,0)	(22,0)	(23,0)	(16,0)	(17,0)	(18,0)	(19,0)	
+(8*y)	(4 <b>,</b> y)	(5,y)	(6,y)	(7,y)	(0,y)	(1,y)	(2,y)	(3,y)	
+(8*y)+4	(20,y)	(21,y)	(22,y)	(23,y)	(16,y)	(17,y)	(18,y)	(19,y)	
+0xF8	(4,31)	(5,31)	(6,31)	(7,31)	(0,31)	(1,31)	(2,31)	(3,31)	
+0xFC	(20,31)	(21,31)	(22,31)	(23,31)	(16,31)	(17,31)	(18,31)	(19,31)	

## Table 5-5 LBBP buffer to pixel mapping 32x32 Cursor0 for datawords [15:0]

Table 5-6 and Table 5-7 on page 5-14 list the format in which a single 64-bit cursor can be held.

# Table 5-6 LBBP buffer to pixel mapping 64x64 for datawords [31:16]

Offset from CLCDC	Dataword								
base at 0x10120800	[31:30]	[29:28]	[27:26]	[25:24]	[23:22]	[21:20]	[19:18]	[17:16]	
+0	(12,0)	(13,0)	(14,0)	(15,0)	(8,0)	(9,0)	(10,0)	(11,0)	
+0x4	(28,0)	(29,0)	(30,0)	(31,0)	(24,0)	(25,0)	(26,0)	(27,0)	
+0x8	(44,0)	(45,0)	(46,0)	(47,0)	(40,0)	(41,0)	(42,0)	(43,0)	
+0xC	(60,0)	(61,0)	(62,0)	(63,0)	(56,0)	(57,0)	(58,0)	(59,0)	
+16*y+0	(12,y)	(13 <b>,</b> y)	(14 <b>,</b> y)	(15,y)	(8,y)	(9,y)	(10,y)	(11,y)	
+16*y+4	(28,y)	(29,y)	(30,y)	(31,y)	(24 <b>,</b> y)	(25,y)	(26,y)	(27,y)	
+16*y+8	(44 <b>,</b> y)	(45,y)	(46,y)	(47,y)	(40,y)	(41,y)	(42,y)	(43,y)	
+16*y+12	(60,y)	(61,y)	(62,y)	(63,y)	(56,y)	(57,y)	(58,y)	(59,y)	
+0x3FC	(60,63)	(61,63)	(62,63)	(63,63)	(56,63)	(57,63)	(58,63)	(59,63)	

Offset from CLCDC	Dataword								
base at 0x10120800	[15:14]	[13:12]	[11:10]	[9:8]	[7:6]	[5:4]	[3:2]	[1:0]	
+0	(4,0)	(5,0)	(6,0)	(7,0)	(0,0)	(1,0)	(2,0)	(3,0)	
+0x4	(20,0)	(21,0)	(22,0)	(23,0)	(16,0)	(17,0)	(18,0)	(19,0)	
+0x8	(36,0)	(37,0)	(38,0)	(39,0)	(32,0)	(33,0)	(34,0)	(35,0)	
+0xC	(52,0)	(53,0)	(54,0)	(55,0)	(48,0)	(49,0)	(50,0)	(51,0)	
+16*y+0	(4,y)	(5,y)	(6,y)	(7,y)	(0,y)	(1,y)	(2,y)	(3,y)	
+16*y+4	(20,y)	(21 <b>,</b> y)	(22 <b>,</b> y)	(23,y)	(16,y)	(17 <b>,</b> y)	(18,y)	(19 <b>,</b> y)	
+16*y+8	(36,y)	(37 <b>,</b> y)	(38,y)	(39,y)	(32,y)	(33,y)	(34 <b>,</b> y)	(35,y)	
+16*y+12	(52,y)	(53,y)	(54 <b>,</b> y)	(55,y)	(48,y)	(49,y)	(50,y)	(51,y)	
+0x3FC	(52,63)	(53,63)	(54,63)	(55,63)	(48,63)	(49,63)	(50,63)	(51,63)	

Table 5-7 LBBP buffer to pixel mapping 64x64 for datawords [15:0]

# Software format for Windows CE

The software low-level cursor mask is split into two memory areas providing separate AND and XOR buffers. These buffers are held as single bit memory images, and must be combined by software to form a unified cursor image that is then copied to the cursor image buffer when required.

The hardware cursor does not support full color cursor images because of practical limitations on the size of the image dual-port RAM.

The software AND and XOR masks both follow the same format. Table 5-8 on page 5-15 lists the format for 32x32 pixels and Table 5-9 on page 5-15 the format for 64x64 pixels.

External memory offset	Data bit to pixel correspondence							
External memory onset	[7]	[6]	[5]	[4]	[3]	[2]	[1]	[0]
+0	(0,0)	(1,0)	(2,0)	(3,0)	(4,0)	(5,0)	(6,0)	(7,0)
+1	(8,0)	(9,0)	(10,0)	(11,0)	(12,0)	(13,0)	(14,0)	(15,0)
+2	(16,0)	(17,0)	(18,0)	(19,0)	(20,0)	(21,0)	(22,0)	(23,0)
+3	(24,0)	(25,0)	(26,0)	(27,0)	(28,0)	(29,0)	(30,0)	(31,0)
	-	-	-	-	-	-	-	-
+127	(24,31)	(25,31)	(26,31)	(27,31)	(28,31)	(29,31)	(30,31)	(31,31)

## Table 5-8 32x32 software mask storage

## Table 5-9 64x64 software mask storage

External memory offset	Data bit to pixel correspondence								
External memory onset	[7]	[6]	[5]	[4]	[3]	[2]	[1]	[0]	
+0	(0,0)	(1,0)	(2,0)	(3,0)	(4,0)	(5,0)	(6,0)	(7,0)	
+1	(8,0)	(9,0)	(10,0)	(11,0)	(12,0)	(13,0)	(14,0)	(15,0)	
+2	(16,0)	(17,0)	(18,0)	(19,0)	(20,0)	(21,0)	(22,0)	(23,0)	
+3	(24,0)	(25,0)	(26,0)	(27,0)	(28,0)	(29,0)	(30,0)	(31,0)	
+4	(32,0)	(33,0)	(34,0)	(35,0)	(36,0)	(37,0)	(38,0)	(39,0)	
+5	(40,0)	(41,0)	(42,0)	(43,0)	(44,0)	(45,0)	(46,0)	(47,0)	
+6	(48,0)	(49,0)	(50,0)	(51,0)	(52,0)	(53,0)	(54,0)	(55,0)	
+7	(56,0)	(57,0)	(58,0)	(59,0)	(60,0)	(61,0)	(62,0)	(63,0)	
	-	-	-	-	-	-	-	-	
+511	(56,63)	(57,63)	(58,63)	(59,63)	(60,63)	(61,63)	(62,63)	(63,63)	

# **Pixel encoding**

-

Each pixel of the cursor requires two bits of information that are interpreted as Color0, Color1, Transparent, and Transparent inverted.

In the coding scheme, bit 1 selects between color and transparent (AND mask) and bit 0 selects variant (XOR mask).

Table 5-10 lists the pixel encoding bit assignments.

## Table 5-10 Pixel encoding

Bits	Description
[00]	Color0. The cursor color is displayed according to the <i>Red-Green-Blue</i> (RGB) value programmed into the CrsrPalette0 Register.
[01]	Color1. The cursor color is displayed according to the RGB value programmed into the CrsrPalette1 Register.
[10]	Transparent. The cursor pixel is transparent, so is displayed unchanged. This enables the visible cursor to assume shapes that are not square.
[11]	Transparent inverted. The cursor pixel assumes the complementary color of the frame pixel that is displayed. This can be used to ensure that the cursor is visible regardless of the color of the frame buffer image.

# 5.3.2 Hardware cursor registers

Table 5-1 lists the hardware cursor registers.

## Table 5-1 PrimeCell CLCDC register summary

Name	Address	Туре	Reset value	Description
CursorImage	0x10120800- 0x10120BFC	R/W	0x00000000	See Cursor Image RAM Register on page 5-18
ClcdCrsrCtrl	0x10120C00	R/W	0x00	See Cursor Control Register on page 5-18
ClcdCrsrConfig	0x10120C04	R/W	0x0	See Cursor Configuration Register on page 5-20
ClcdCrsrPalette0	0x10120C08	R/W	0x000000	See Cursor Palette Registers on page 5-20
ClcdCrsrPalette1	0x10120C0C	R/W	0x000000	See Cursor Palette Registers on page 5-20
ClcdCrsrXY	0x10120C10	R/W	0x00000000	See Cursor XY Position Register on page 5-21
ClcdCrsrClip	0x10120C14	R/W	0x0000	See Cursor Clip Position Register on page 5-22
-	0x10120C18- 0x10120C1C	-	-	Reserved
ClcdCrsrIMSC	0x10120C20	R/W	0x0	See Cursor Interrupt Mask Set/Clear Register on page 5-23
ClcdCrsrICR	0x10120C24	WO	0x0	See Cursor Interrupt Clear Register on page 5-24
ClcdCrsrRIS	0x10120C28	RO	0x0	See Cursor Raw Interrupt Status Register on page 5-25
ClcdCrsrMIS	0x10120C2C	RO	0x0	See Cursor Masked Interrupt Status Register on page 5-26
-	0x10120C30- 0x10120FDC	-	-	Reserved
CLCDPeriphID0	0x10120FE0	RO	0x11	See Peripheral Identification Registers on page 5-27
CLCDPeriphID1	0x10120FE4	RO	0x11	See Peripheral Identification Registers on page 5-27
CLCDPeriphID2	0x10120FE8	RO	0x04	See Peripheral Identification Registers on page 5-27
CLCDPeriphID3	0x10120FEC	RO	0x00	See Peripheral Identification Registers on page 5-27
CLCDPCellID0	0x10120FF0	RO	0x0D	See PrimeCell Identification Registers on page 5-29
CLCDPCellID1	0x10120FF4	RO	0xF0	See PrimeCell Identification Registers on page 5-29
CLCDPCellID2	0x10120FF8	RO	0x05	See PrimeCell Identification Registers on page 5-29
CLCDPCellID3	0x10120FFC	RO	0xB1	See PrimeCell Identification Registers on page 5-29

## **Cursor Image RAM Register**

The CursorImage Register is read and write. It contains 256-word wide values which are used to define the image or images overlaid by the hardware cursor mechanism. The image must always be stored in LBBP mode (little-endian byte, big-endian pixel) mode, as described in *Image format* on page 5-11. Two bits are used to encode color and transparency for each pixel in the cursor.

Depending on the state of bit 0 in the ClcdCrsrConfig Register (see *Cursor Configuration Register* on page 5-20), the cursor image RAM contains either four 32x32 cursor images, or a single 64x64 cursor.

The two colors defined for the cursor are mapped onto values from the ClcdCrsrPalette0 and ClcdCrsrPalette1 Registers (see *Cursor Palette Registers* on page 5-20).

# **Cursor Control Register**

The ClcdCrsrCtrl Register is read and write. It provides access to frequently used cursor functions, such as display on/off control for the cursor, and the cursor number for 32x32 bit cursors.

Figure 5-7 shows the register bit assignments.



## Figure 5-7 ClcdCrsrCtrl Register bit assignments

Table 5-2 lists the register bit assignments.

## Table 5-2 ClcdCrsrCtrl Register bit assignments

Bit	Name	Function
[31:6]	-	Reserved, read undefined, do not modify.
[5:4]	CrsrNumber[1:0]	Cursor Image number. This field provides an offset into the cursor image buffer, to enable one of four $32x32$ cursors to be addressed. The images each occupy one quarter of the image memory, with Cursor0 from location 0, followed by Cursor1 from address $0x100$ , Cursor2 from $0x200$ and Cursor3 from $0x300$ . If the cursor size is $64x64$ this field has no effect because there is only space for one cursor of this size in the image buffer. If the cursor size is $32x32$ : 11 = Cursor3 10 = Cursor2 01 = Cursor1 00 = Cursor0.
		<ul> <li>Similar synchronization.</li> <li>Similar synchronization rules apply to the cursor number as apply to the cursor coordinates:</li> <li>if CrsrFramesync is 1, the displayed cursor image is only changed during the vertical frame blanking period.</li> <li>if CrsrFrameSync is 0, the cursor image index is changed immediately, even if the cursor is currently being scanned.</li> </ul>
[3:1]	-	Reserved, read undefined, do not modify.
[0]	CrsrOn	1 = Cursor is displayed. 0 = Cursor not displayed.

# **Cursor Configuration Register**

The ClcdCrsrConfig Register is read and write. It provides overall configuration information for the hardware cursor.

Figure 5-8 shows the register bit assignments.



## Figure 5-8 ClcdCrsrConfig Register bit assignments

Table 5-3 lists the register bit assignments.

## Table 5-3 ClcdCrsrConfig Register bit assignments

Bit	Name	Function
[31:2]	-	Reserved, read undefined, do not modify
[1]	CrsrFrameSync	0 = Cursor coordinates asynchronous 1 = Cursor coordinates synchronized to frame synchronization pulse
[0]	CrsrSize	0 = 32x32 pixel cursor 1 = 64x64 pixel cursor

## **Cursor Palette Registers**

The ClcdCrsrPalette0 and ClcdCrsrPalette1 Registers are read and write. They provide color palette information for the visible colors of the cursor:

- Colour0 is mapped through CrsrPalette0
- Colour1 is mapped through CrsrPalette1.

The registers provide 24-bit RGB values that are displayed according to the abilities of the LCD panel in the same way as the frame-buffers palette output is displayed.

In mono STN, only Red[7:4] are significant and, in STN color Red[7:4], Blue[7:4] and Green[7:4] are significant. In 24 bits per pixel, all 24 bits of the palette registers are significant.

31	24	23	16 15		8 7		0
	Undefined	Blue		Green		Red	

Figure 5-9 shows the register bit assignments.

## Figure 5-9 ClcdCrsrPalette0 and ClcdCrsrPalette1 Register bit assignments

Table 5-4 lists the register bit assignments.

Table 5-4 ClcdCrsrPalette0 and ClcdCrsrPalette1 Register bit assignments

Bit	Name	Function
[31:24]	-	Reserved, read undefined, do not modify
[23:16]	Blue	Blue color component
[15:8]	Green	Green color component
[7:0]	Red	Red color component

## **Cursor XY Position Register**

The ClcdCrsrXY Register is read and write. It defines the distance of the top-left edge of the cursor from the top-left side of the cursor overlay.

Figure 5-10 shows the register bit assignments.



# Figure 5-10 ClcdCrsrXY Register bit assignments

Table 5-5 lists the register bit assignments.

## Table 5-5 ClcdCrsrXY Register bit assignments

Bit	Name	Function
[31:28]	-	Reserved, read undefined, do not modify.
[27:26]	CrsrY (expansion)	Reserved for coordinate expansion. Must be written as zero.
[25:16]	CrsrY	Y ordinate of the cursor origin measured in pixels. When 0, the top edge of the cursor is at the top of the display.
[15:12]	-	Reserved, read undefined, do not modify.
[11:10]	CrsrX (expansion)	Reserved for coordinate expansion. Must be written as zero.
[9:0]	CrsrX	X ordinate of the cursor origin measured in pixels. When 0, the left edge of the cursor is at the left edge of the display.

If CrsrFrameSync is 0, the cursor position changes immediately, even if the cursor is currently being scanned.

If CrsrFramesync is 1, the cursor position is only changed during the next vertical frame blanking period.

## **Cursor Clip Position Register**

The ClcdCrsrClip Register is read and write. It defines the distance from the top-left edge of the cursor image, to the first displayed pixel in the cursor image.

Figure 5-11 shows the register bit assignments.



## Figure 5-11 ClcdCrsrClip Register bit assignments

Table 5-6 lists the register bit assignments.

Bit	Name	Function
[31:14]	-	Reserved, read undefined, do not modify.
[13:8]	CrsrClipY	Distance from top of cursor image to the first displayed pixel in cursor. When 0, the first displayed pixel is from the top line of the cursor image.
[7:6]	-	Reserved, read undefined, do not modify.
[5:0]	CrsrClipX	Distance from left edge of cursor image to the first displayed pixel of cursor. When 0, the first pixel of the cursor line is displayed.

#### Table 5-6 ClcdCrsrClip Register bit assignments

Different synchronization rules apply to the Cursor Clip Registers than apply to the cursor coordinates.

If CrsrFrameSync is 0, the cursor clip point is changed immediately, even if the cursor is currently being scanned.

If CrsrFramesync is 1, the displayed cursor image is only changed during the vertical frame blanking period, providing that the cursor position has been updated since the Clip Register was programmed. Therefore, when programming, the Clip Register must be written before the Position Register (ClcdCrsrXY) to ensure that in a given frame, the clip and position information is coherent.

## **Cursor Interrupt Mask Set/Clear Register**

The ClcdCrsrIMSC Register is read and write. It is used to enable the cursor interrupt to the processor.

Figure 5-12 shows the register bit assignments.



## Figure 5-12 ClcdCrsrIMSC Register bit assignments

## Table 5-7 lists the register bit assignments.

## Table 5-7 ClcdCrsrIMSC Register bit assignments

Bit	Name	Function
[31:1]	-	Reserved, read undefined, do not modify.
[0]	CrsrIM	When set, the cursor interrupts the processor immediately after reading of the last word of cursor image. When clear, the cursor never interrupts the processor.

## **Cursor Interrupt Clear Register**

The ClcdCrsrICR Register is write-only. It is used by software to clear the cursor interrupt status and the cursor interrupt signal to the processor.

Figure 5-13 shows the register bit assignments.



CrsrIC -----

## Figure 5-13 ClcdCrsrICR Register bit assignments

Table 5-8 lists the register bit assignments.

## Table 5-8 ClcdCrsrICR Register bit assignments

Bit	Name	Function
[31:1]	-	Reserved, do not modify.
[0]	CrsrIC	When set the cursor interrupt status is cleared. Writing 0 to this bit has no effect.

# **Cursor Raw Interrupt Status Register**

The ClcdCrsrRIS Register is read-only. It is set to indicate a cursor interrupt, and, when enabled, controls the state of the interrupt signal to the system interrupt controller.

—— Note ———

The ClcdCrsrRIS Register is valid regardless of the state of the CrsrIMSC bit.

Figure 5-14 shows the register bit assignments.



## Figure 5-14 ClcdCrsrRIS Register bit assignments

Table 5-9 lists the register bit assignments.

## Table 5-9 ClcdCrsrRIS Register bit assignments

Bit	Name	Function	
[31:1]	-	Reserved, read undefined.	
[0]	CrsrRIS	The cursor interrupt status is set immediately after the last data read from the cursor image for the current frame. This bit is cleared by writing to the CrsrIC bit in the ClcdCrsrICR Register. See <i>Cursor Interrupt Clear Register</i> on page 5-24.	

# **Cursor Masked Interrupt Status Register**

The ClcdCrsrMIS Register is read-only. It is set to indicate a cursor interrupt providing that the interrupt bit is not masked.

Figure 5-15 shows the register bit assignments.



# Figure 5-15 ClcdCrsrMIS Register bit assignments

Table 5-10 lists the register bit assignments.

## Table 5-10 ClcdCrsrMIS Register bit assignments

Bit	Name	Function
[31:1]	-	Reserved, read undefined.
[0]	CrsrMIS	The cursor interrupt status is set immediately after the last data read from the cursor image for the current frame, providing that the corresponding bit in the ClcdCrsrIMSC Register is set. The bit remains clear if the ClcdCrsrIMSC Register is clear. This bit is cleared by writing to the ClcdCrsrICR Register. See <i>Cursor Interrupt Clear</i> <i>Register</i> on page 5-24.

# **Peripheral Identification Registers**

The CLCDPeriphID0-3 Registers are four 8-bit read-only registers that span address locations 0xFE0-0xFEC. The registers can conceptually be treated as a single 32-bit register. The registers provide the peripheral options listed in Table 5-11.

Bit	Function
PartNumber[11:0]	Identifies the peripheral. The three-digit product code 0x11 is used.
DesignerID[19:12]	Identifies the designer. ARM Limited is 0x41, ASCII A.
Revision[23:20]	Identifies the revision number of the peripheral. The revision number starts from 0 and is revision dependent.
Configuration[31:24]	Identifies the configuration option of the peripheral. The configuration value is 0.

## Table 5-11 Peripheral Identification Register options

Figure 5-16 shows the register bit assignments.



## Figure 5-16 CLCDPeriphID0-3 Register bit assignments

The CLCDPeriphID0 Register is read-only. It is hard-coded and the fields in the register determine the reset value. Table 5-12 lists the register bit assignments.

Table 5-12 CLCDPeriphID0 Register bit assignments

Bit	Name	Function
[31:8]	Reserved	Reserved, read undefined
[7:0]	PartNumber0	These bits read back as 0x11

The CLCDPeriphID1 Register is read-only. It is hard-coded and the fields in the register determine the reset value. Table 5-13 lists the register bit assignments.

Table 5-13 CLCDPeriphID1 Register bit assignments

Bit	Name	Function
[31:8]	Reserved	Reserved, read undefined
[7:4]	Designer0	These bits read back as 0x1
[3:0]	PartNumber1	These bits read back as 0x1

The CLCDPeriphID2 Register is read-only. It is hard-coded and the fields in the register determine the reset value. Table 5-14 lists the register bit assignments.

#### Table 5-14 CLCDPeriphID2 Register bit assignments

Bit	Name	Function
[31:8]	Reserved	Reserved, read undefined
[7:4]	Revision	These bits read back as 0x0
[3:0]	Designer1	These bits read back as 0x4

The CLCDPeriphID3 Register is read-only. It is hard-coded and the fields in the register determine the reset value. Table 5-15 lists the register bit assignments.

Table 5-15 CLCDPeriphID3 Register bit assignments

Bit	Name	Function
[31:8]	Reserved	Reserved, read undefined
[7:0]	Configuration	These bits read back as 0x0
## **PrimeCell Identification Registers**

The CLCDPCellID0-3 Registers are four 8-bit read-only registers that span address locations 0xFF0-0xFFC. The registers can conceptually be treated as a single 32-bit register. The register is used as a standard cross-peripheral identification system. Figure 5-17 shows the register bit assignments.



## Figure 5-17 CLCDCPCellID0-3 Register bit assignments

The CLCDPCellID0 Register is read-only. It is hard-coded and the fields in the register determine the reset value. Table 5-16 lists the register bit assignments.

### Table 5-16 CLCDPCellID0 Register bit assignments

Bit	Name	Function
[31:8]	Reserved	Reserved, read undefined
[7:0]	CLCDPCellID0	These bits read back as 0x0D

The CLCDPCellID1 Register is read-only. It is hard-coded and the fields in the register determine the reset value. Table 5-17 lists the register bit assignments.

#### Table 5-17 CLCDPCellID1 Register bit assignments

Bit	Name	Function
[31:8]	Reserved	Reserved, read undefined
[7:0]	CLCDPCellID1	These bits read back as 0xF0

The CLCDPCellID2 Register is read-only. It is hard-coded and the fields in the register determine the reset value. Table 5-18 lists the register bit assignments.

Table 5-18 CLCDPCellID2 Register bit assignments

Bit	Name	Function
[31:8]	Reserved	Reserved, read undefined
[7:0]	CLCDPCellID2	These bits read back as 0x05

The CLCDPCellID3 Register is read-only. It is hard-coded and the fields in the register determine the reset value. Table 5-19 lists the register bit assignments.

#### Table 5-19 CLCDPCellID3 Register bit assignments

Bit	Name	Function
[31:8]	Reserved	Reserved, read undefined
[7:0]	CLCDPCellID3	These bits read back as 0xB1

# 5.4 CLCD signals on pads

The only external input signal to the CLCDC is the external clock signal **CLCDCLKEXT**.

Table 5-20 lists the output interface signals.

	······ · ······· ····· ····· ····· ·····
Signal name	Description
CLPOWER	LCD panel power enable
CLLP	Line synchronization pulse (STN)/horizontal synchronization pulse (TFT)
CLCP	LCD panel clock
CLFP	Frame pulse (STN)/vertical synchronization pulse (TFT)
CLAC	STN AC bias drive or TFT data enable output
CLD[23:0]	LCD panel data
CLLE	Line end signal

#### Table 5-20 External pad output signals

Color LCD Controller (CLCDC)

# Chapter 6 MOVE Coprocessor

This chapter describes the MOVE graphic coprocessor in the ARM926EJ-S Development Chip. It contains the following section:

• *About the MOVE Coprocessor* on page 6-2.

\_\_\_\_\_Note \_\_\_\_\_

Details of the MOVE coprocessor function are only available to licensees. Contact ARM for information on licensing.

The release version used is MOVE r3p0-00bet0.

## 6.1 About the MOVE Coprocessor

The MOVE coprocessor is a video encoding acceleration coprocessor designed to accelerate *Motion Estimation* (ME) algorithms within block-based video encoding schemes such as MPEG4 and H.263. This is done by providing support for the execution of *Sum of Absolute Differences* (SAD) calculations, which account for most of the processing activity within an ME algorithm. These algorithms require many comparisons between 8x8 pixel blocks to be made between a current frame and a reference frame.

The MOVE interprets a set of coprocessor instructions that are part of the ARM instruction set. The ARM coprocessor instructions enable the ARM processor to:

- transfer data between the MOVE and memory, using Load Coprocessor instructions (LDC)
- transfer data between the MOVE and ARM registers, using MOVE to coprocessor instructions (MCR), and MOVE to ARM instructions (MRC).

The ARM processor acts as an address generator and data pump for the MOVE. The MOVE consists of:

- a register bank
- a data path
- control logic.

Figure 6-1 on page 6-3 shows the major blocks of the MOVE.



Figure 6-1 MOVE overview

MOVE Coprocessor

# Chapter 7 MBX HR-S Graphics Accelerator

This chapter describes the ARM MBX HR-S Graphics Accelerator present in the ARM926EJ-S Development Chip. It contains the following sections:

- *About the ARM MBX HR-S* on page 7-2
- *Memory map and registers* on page 7-6.

## 7.1 About the ARM MBX HR-S

The ARM MBX HR-S is an *Advanced Microcontroller Bus Architecture* (AMBA) compliant *System-on-a-Chip* (SoC) component. Figure 7-1 shows a top-level block diagram of the ARM MBX HR-S. The MBX component connects directly to the MPMC and the AHB bus matrix.



### Figure 7-1 ARM MBX HR-S top level block diagram

The ARM MBX consists of the following modules:

- Tile Accelerator (TA)
- event manager
- Vertex Geometry Processor (VGP)
- display list parser
- *Hidden Surface Removal* (HSR) engine
- texture shading unit
- texture cache
- pixel blender.

The release version used is r1p2. The base address for the MBX registers is 0x40000000. The modules are described in more detail in the *ARM MBX HR-S Graphics Core Technical Reference Manual*.

The ARM MBX HR-S operates on 3D scene data (sent as batches of triangles) that are transformed and lit either by the *Central Processing Unit* (CPU) or by the VGP. Triangles are written directly to the TA on a *First In First Out* (FIFO) basis so that the CPU is not stalled. The TA performs advanced culling on triangle data by writing the tiled non-culled triangles to the external memory.

The event manager uses SmartBuffer technology so that any level of scene complexity can be handled in a fixed buffer size.

The HSR engine reads the tiled data and implements per-pixel HSR with full Z-accuracy. The resulting visible pixels are textured and shaded in *Internal True Color* (ITC) before rendering the final image for display.

— Note —

The ARM MBX HR-S has the following interfaces:

- the register block interface is an AMBA *Advanced High-performance Bus* (AHB) slave interface
- the memory interface is a simple handshake protocol that is defined as the MBX memory interface.

## 7.1.1 Features of the ARM MBX HR-S

The ARM MBX HR-S has the following features:

- deferred texturing
- screen tiling
- flat and Gouraud shading
- perspective correct texturing
- specular highlights
- 32-bit Z-buffer
- 32-bit ARGB internal rendering and layer buffering
- full tile blend buffer
- Z-load and store mode
- per-vertex fog
- 16-bit RGB textures, 1555, 565, 4444, 8332, 88
- 32-bit RGB textures, 8888
- YUV 422 textures
- PVR-TC compressed textures
- one-bit textures for text acceleration
- point, bilinear, trilinear and anisotropic filtering
- full range of OpenGL and D3D blend modes
- Dot3 bump mapping
- alpha test
- zero cost full scene anti-aliasing
- 2Dvia3D.

The ARM MBX HR-S provides the following benefits:

- low memory bandwidth
- high-quality images on low-resolution displays
- suitable for UMA system
- easy integration with AMBA multi-layer AHB.

## 7.1.2 Functional overview

PowerVR technology is implemented as a *display list renderer*. Groups of polygons are batched together into a display list before being processed by the 3D rendering hardware. This is fundamentally different to the approach used by conventional systems, because it enables a scene to be partitioned into small *tiles* or *regions*, each of which is rendered independently. This has the following benefits:

## Performance

Because the region is only a small subset of the whole scene, the ARM MBX HR-S can implement key operations on-chip without frequent access to external memory. *Hidden Surface Removal* (HSR), or Z-buffering, is done with an on-chip Z-buffer and display pixel processing and blending also uses an on chip *frame buffer tile* as a local storage. This means that the majority of external memory accesses normally performed by a conventional 3D system are eliminated. All the on-chip processing is performed at high depth and pixel accuracy at full clock rate, without having to wait for Z-buffer or frame buffer memory accesses that slow down conventional 3D systems.

## **Deferred texturing**

In PowerVR systems, the HSR is completed in the first phase of the pipeline before texturing and shading. Because of this, only visible pixels to be finally drawn in the display memory are textured and shaded. This eliminates both the redundant work performed and, most importantly, the redundant texture fetches from memory required by conventional 3D systems.

## Accuracy and image quality

Z-buffering and pixel blending are done entirely on-chip, so they can be performed at high precision with no performance degradation or increase in memory bandwidth requirements. In PowerVR all pixel blend operations are performed with true color precision, irrespective of the number of translucent layers or the bit-depth of the frame buffer (Internal True Color). This results in high image quality without performance loss

## 7.2 Memory map and registers

The MBX HR-S memory map is described in the following sections:

- MBX HR-S registers
- AHB slave interface
- *GX port memory interface* on page 7-7.

## 7.2.1 MBX HR-S registers

The MBX control registers are located starting at memory location 0x140000000.

For detailed information on the MBX registers, see the ARM MBX HR-S Graphics Core Technical Reference Manual.

## 7.2.2 AHB slave interface

The ARM MBX HR-S can be placed anywhere within a SoC memory map, and is defined by the SoC architect. Its main SoC interface has an input address range of 16MB that is arranged as shown in Table 7-1.

-

Description	Memory address range	
Registers	0x40000000-0x407FFFFF	
TA data	0x40800000-0x409FFFFF	
TA 2D data	0x40A00000-0x40BFFFFF	
TA control	0x40C00000-0x40FFFFF	

able 7-	1 MBX	HR-S	memory	/ map
---------	-------	------	--------	-------

## 7.2.3 GX port memory interface

The MBX HR-S contains an MMU that maps the 8192 4KB pages making up the 32MB linear address space of the MBX into 4KB (potentially) fragmented pages in the 4GB system memory space.

Translation is performed using a table with 8KB entries, one for each 4KB page in a 32MB linear address space. Each entry is a word, so 32KB must be allocated for the translation table. Table entries are byte-aligned.

The translation table resides in the 4GB fragmented address space. Eight static registers are provided that point to eight 4KB pages containing the table. A 256-entry, four-way set associative cache of the translation table is maintained within the MBX HR-S core.

The MMU is bypassed on reset. The 32MB linear address space is mapped directly into the bottom of the 4GB address space. When enabled, approximately 256 cycles are required to initialize the cache. A flag, made available in the MMU enable register, is set when the cache is ready. If the cache is subsequently disabled, the MMU returns to the bypass state.

To update the translation table the MMU must first be disabled. The table can then be changed and the MMU re-enabled. This procedure is required to invalidate all table entries in the cache.

Figure 7-2 on page 7-8 shows the MMU address translation.



### Figure 7-2 MMU address translation

# Chapter 8 Direct Memory Access Controller (DMAC)

This chapter describes DMAC present in the ARM926EJ-S Development Chip. It contains the following section:

- About the Direct Memory Access Controller (PL080) on page 8-2
- Functional description on page 8-4
- DMA signals on pads on page 8-7.

## 8.1 About the Direct Memory Access Controller (PL080)

The DMAC is an *Advanced Microcontroller Bus Architecture* (AMBA) compliant *System-on-Chip* (SoC) peripheral that is developed, tested, and licensed by ARM Limited.

The DMAC is an AMBA AHB module, and has two masters and one slave that connect to the AHB bus matrix.

The release version used is PL080 DMAC REL1v1. The base address for the DMAC registers is 0x10130000. For more information on the controller, see the *ARM PrimeCell DMA (PL080) Technical Reference Manual*.

## 8.1.1 Features of the PrimeCell DMAC

The PrimeCell DMAC offers:

- Compliance to the *AMBA Specification* for easy integration into SoC implementation.
- Eight DMA channels. Each channel can support a unidirectional transfer.
- 16 DMA requests. The PrimeCell DMAC provides 16 peripheral DMA request lines.
- Single DMA and burst DMA request signals. Each peripheral connected to the PrimeCell DMAC can assert either a burst DMA request or a single DMA request. The DMA burst size is set by programming the PrimeCell DMAC.
- Memory-to-memory, memory-to-peripheral, peripheral-to-memory, and peripheral-to-peripheral transfers.
- Scatter or gather DMA is supported through the use of linked lists.
- Hardware DMA channel priority. Each DMA channel has a specific hardware priority. DMA channel 0 has the highest priority down to channel 7 that has the lowest priority. If requests from two channels become active at the same time the channel with the highest priority is serviced first.
- AHB slave DMA programming interface. The PrimeCell DMAC is programmed by writing to the DMA control registers over the AHB slave interface.
- Two AHB bus masters for transferring data. These interfaces are used to transfer data when a DMA request goes active.
- 32-bit AHB master bus width.
- Incrementing or non-incrementing addressing for source and destination.

- Programmable DMA burst size. The DMA burst size can be programmed to more efficiently transfer data. Usually the burst size is set to half the size of the FIFO in the peripheral.
- Internal four-word FIFO per channel.
- Supports 8, 16, and 32-bit wide transactions.
- Big-endian and little-endian support. The PrimeCell DMAC defaults to little-endian mode on reset.
- Separate and combined DMA error and DMA count interrupt requests. An interrupt to the processor can be generated on a DMA error or when a DMA count has reached 0 (this is usually used to indicate that a transfer has finished). The following interrupt request signals are used to do this:
  - **DMACINTTC** is used to signal when a transfer has completed.
  - **DMACINTERR** is used to signal when an error has occurred.
  - DMACINTR combines both the DMACINTTC and DMACINTERR interrupt request signals. The DMACINTR interrupt request can be used in systems that have few interrupt controller request inputs.
- Interrupt masking. The DMA error and DMA terminal count interrupt requests can be masked.
- Raw interrupt status. The DMA error and DMA count raw interrupt status can be read prior to masking.
- Identification registers that uniquely identify the PrimeCell DMAC. These can be used by an operating system to automatically configure itself.

— Note —

The DMA system cannot access the TCM memory located in the ARM926EJ-S Development Chip.

## 8.2 Functional description





Figure 8-1 DMAC interface block diagram

Table 8-1 DMA channel allocation

## 8.2.1 Peripheral integration

DMA requester	DMA channel
UART0 Tx	15
UART0 Rx	14
UART1 Tx	13
UART1 Rx	12
UART2 Tx	11
UART2 Rx	10
SSP Tx	9
SSP Rx	8
SCI Tx	7
SCI Rx	6
External DMA request [5:0]	5:0

The allocation of the DMAC peripheral request lines is defined in Table 8-1.

The master interfaces of the DMAC both drive single master AHBs. Therefore:

- the **HGRANT** inputs are tied HIGH
- the **HBUSREQ** outputs are left unconnected.

The only interrupt from the DMAC that is connected to the VIC is the combined interrupt source **DMACINTR**. The remaining interrupt sources, **DMAINTERR** and **DMAITTC**, are left unconnected.

## 8.2.2 Registers

The PrimeCell DMAC enables peripheral-to-memory, memory-to-peripheral, peripheral-to-peripheral, and memory-to-memory transactions. Each DMA stream is configured to provide unidirectional DMA transfers for a single source and destination. For example, a bidirectional serial port requires one stream for transmit and one for receive. The source and destination areas can each be either a memory region or a peripheral, and can be accessed through the same AHB master, or one area by each master.

The base address for the PrimeCell DMAC is 0x10130000.

# 8.3 DMA signals on pads

The pad input and output signals for the DMAC are shown in Table 8-1. These signals are for connection to external DMA capable peripherals.

Name	Туре	Description
DMACBREQ[5:0]	Input	DMA burst transfer request.
DMACSREQ[5:0]	Input	DMA single transfer request.
DMACLBREQ[5:0]	Input	DMA last burst transfer request.
DMACLSREQ[5:0]	Input	DMA last single transfer request.
DMACLR[5:0]	Output	DMA request acknowledge clear.
DMACTC[5:0]	Output	DMA terminal count. Indicates that the transaction is complete and the packet of data is transferred.

## Table 8-1 DMA request and response signal descriptions

Direct Memory Access Controller (DMAC)

# Chapter 9 General Purpose Input Output (GPIO)

This chapter describes the GPIOs in the ARM926EJ-S Development Chip. It contains the following sections:

- About the ARM PrimeCell GPIO (PL061) on page 9-2
- *Functional description* on page 9-3
- GPIO signals on pads on page 9-5.

## 9.1 About the ARM PrimeCell GPIO (PL061)

The PrimeCell GPIO is an *Advanced Microcontroller Bus Architecture* (AMBA) compliant *System-on-Chip* (SoC) peripheral that is developed, tested, and licensed by ARM. The four GPIOs connect to the core APB.

The release version used is PL061 GPIO 1v0. The base address for the GPIO registers are 0x101E4000, 0x101E5000, 0x101E6000, and 0x101E7000. For more information on the controller, see the *ARM PrimeCell GPIO (PL061) Technical Reference Manual*.

The PrimeCell GPIO provides eight programmable general purpose inputs or outputs that you can control through an APB bus interface.

Four GPIO PrimeCells are instantiated to give a 32-bit wide port. An interrupt interface is provided to configure any number of pins as interrupt sources. You can generate interrupts depending on a level, or a transitional value of a pin. At system reset, PrimeCell GPIO lines default to inputs. The PrimeCell GPIO interfaces with input and output pad cells using a data input, data output, and output enable per pad.

## 9.1.1 Features of the PrimeCell GPIO

The PrimeCell GPIO offers:

- Compliance to the *AMBA Specification (Rev 2.0)* onwards for easy integration into SoC implementation.
- Individually programmable input/output pins, default to input at reset.
- Programmable interrupt generation capability, from a transition or a level condition, on any number of pins.

 Note
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 Each of the four GPIO blocks has a connection to the VIC.

- Bit masking in both read and write operations through address lines.
- Identification registers that uniquely identify the PrimeCell GPIO.

## 9.2 Functional description

Figure 9-1 shows the PrimeCell GPIO control circuit and external interfaces for one of the four GPIO interfaces.



## Figure 9-1 GPIO output control

The GPIO interrupts to the VIC are:

6	GPIO0
7	GPIO1
8	GPIO2
9	GPIO3.

—— Note ———

For GPIO3, the **GPAFIN[6:0]** signals are not used, but the **GPAFIN[7]** signal is connected to the system controller **BATOK** signal.

For GPIO0, GPIO1, and GPIO2, none of the GPAFIN[7:0] signals are not used

### 9.2.1 Registers

The base address of the PrimeCell GPIO's are:

GPIO0	0x101E4000
GPIO1	0x101E5000
GPIO2	0x101E6000
GPIO2	0x101E7000.

Some locations within the memory range are reserved:

- offsets 0x424–0xFCC are reserved for possible future extensions and test purposes
- offsets 0xFD0–0xFDC are reserved for future ID expansion.

### 9.2.2 Implementation details

Table 9-1 describes the tied-off or unused signals. Replace x with 0–3 for GPIO0–GPIO3.

Name	Source/ destination	Description
nGPAFENx[7:0]	HIGH	Hardware control output enable, active LOW. If not utilized these pins must be tied HIGH.
GPAFOUTx[7:0]	HIGH	Hardware control data input. If not utilized these pins can be tied LOW or HIGH.
GPAFINx[7:0]	Not used	Hardware control data output.
		For GPIO3, the <b>GPAFIN</b> [7] signal is output to the <b>BATOK</b> signal in the system controller.

### Table 9-1 On-chip signal descriptions

# 9.3 GPIO signals on pads

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Table 9-2 describes the signals from the PrimeCell GPIO to input/output pads of the chip.

Name	Description
GPx_[7:0]	These I/O signals are the output from the GPIO0, GPIO1, GPIO2, and GPIO3. The <b>GPIOEN</b> [7:0] signals in the PL061 control the data direction.

### Table 9-2 Pad signal descriptions

General Purpose Input Output (GPIO)

# Chapter 10 Multi-Port Memory Controller (MPMC)

This chapter describes the MPMC in the ARM926EJ-S Development Chip. It contains the following sections:

- About the ARM PrimeCell MPMC (GX175) on page 10-2
- *Functional description* on page 10-6
- *MPMC signals on pads* on page 10-8.

## 10.1 About the ARM PrimeCell MPMC (GX175)

The PrimeCell MPMC is an *Advanced Microcontroller Bus Architecture* (AMBA) compliant *System-on-Chip* (SoC) peripheral that is developed, tested, and licensed by ARM Limited. It connects to the AHB bus matrix.

The release version used for the controller is GX175 MPMC r0p0-00alp2. The base address for the MPMC control registers is 0x10110000. For more information on the memory controller, see the *ARM PrimeCell Multiport Memory Controller (GL175) Technical Reference Manual.* 

## 10.1.1 Features of the PrimeCell MPMC

The PrimeCell MPMC offers:

- AMBA 32-bit AHB compliancy.
- Dedicated MBX Interface Port for direct connection to the ARM range of MBX 3D Graphics Cores.
- Dynamic memory interface supports SDRAM and low-power variants.
- Asynchronous static memory device support including RAM, ROM, and Flash, with or without asynchronous page mode.
- Specifically designed for cached processors.
- Designed to work with noncritical word first, and critical word first processors, such as the ARM926EJ-S.
- Read and write buffers to reduce latency and to improve performance.
- Five AHB interfaces for accessing external memory.
- 8-bit, 16-bit, and 32-bit wide static memory support.
- 16-bit and 32-bit wide databus SDRAM.
- Static memory features include:
  - asynchronous page mode read
  - programmable wait states
  - bus turnaround cycles
  - output enable, and write enable delays
  - extended wait.
- Four chip selects for synchronous memory and four chip selects for static memory devices.

- Power-saving modes dynamically control **MPMCCKEOUT** and **MPMCCLKOUT**.
- Dynamic memory self-refresh mode supported by a *Power Management Unit* (PMU) interface or by software.
- Controller supports 2K, 4K, and 8K row address synchronous memory parts. That is, typical 512Mb, 256Mb, 128Mb, and 16Mb parts, with 8, 16, or 32 DQ (data) bits per device.
- Two reset domains enable dynamic memory contents to be preserved over a soft reset.
- A separate AHB interface for programming the MPMC registers. Enables the MPMC registers to be situated in memory with other system peripheral registers.
- Locked AHB transactions supported.
- Support for all AHB burst types.
- Little and big-endian support.
- Support for the *External Bus Interface* (EBI) that enables the memory controller pads to be shared.
- PrimeCell ID support.

– Note –

Synchronous static memory devices (burst mode devices) are not supported and DDR SDRAM devices are not supported.

## 10.1.2 Supported dynamic memory devices

This section provides examples of dynamic memory devices that are supported by the PrimeCell MPMC.

\_\_\_\_\_ Note \_\_\_\_\_

This is not an exhaustive list of supported devices.

The following JEDEC SDRAM devices are supported:

- 16Mb devices:
  - Micron MT48LC1M16A1S
  - Samsung K4S160822D-G/F
  - Samsung K4S641632C.
- 64Mb devices:
  - Micron MT48LC2M32B2-6
  - Micron MT28S4M162C-10
  - Elpida VDP4564323-10
  - Hitachi HM5264805F-75.
- 128Mb devices:
  - Micron MT48LC4M32B2
  - Micron MT48LC16M8A2
  - Micron MT48LC8M16A2.
- 256Mb devices:
  - Elpida VPP45256163-10
  - Micron MT48LC16M16A2-8E
  - Hitachi HM522532F-B6
  - Hitachi HM5225805B-75.
- 512Mb device:
  - Elpida HM5257805B-A6.

The following 64Mb devices are supported:

- Micron MT28S4M16LC-10
- Micron MT28S4M16LC-12.

The following JEDEC low-power SDRAM devices are supported:

- 64Mb Micron MT48LC2M32LFFC-8
- 128Mb Infineon HYB25L128160AC.

## 10.1.3 Supported static memory devices

This section provides examples of static memory devices that are supported by the PrimeCell MPMC.

——— Note ————

This is not an exhaustive list of supported devices. Static devices on the MPMC cannot be used as boot memory.

The PrimeCell MPMC supports the following devices:

- 128Mb Samsung K3N9V100M-YC
- 128Mb Samsung K3P9V100M-YC
- 256Kb IDT IDT71V256SA20Y
- 256Kb Micron MT28F004b5-672
- 1Mb Micron MTSC2568-12
- 4Mb Samsung K6F8016R6M
- 4Mb Samsung K6R4016CK-12
- 8Mb Samsung K6T8016C3M-70
- 8Mb Samsung K6F8008R2M
- 4Mb Micron MT28F004B5
- 8Mb Intel 28F800F3 and the 4Mb Intel E28F320J3A110.

## 10.2 Functional description

Figure 10-1 shows a block diagram of the PrimeCell MPMC. For details on the static memory multiplexor, see *Functional description* on page 13-5.



Figure 10-1 MPMC PrimeCell block diagram
## 10.2.1 Implementation details

The following outputs are unconnected:

- MPMCDLLCALIBREQ
- MPMCDQSOUT[1:0]
- nMPMCCLKOUT[3:0]
- nMPMCDQSOUTEN[3:0]
- MPMCEBIREQ.

—— Note ———

Booting from memory controlled by the MPMC is not supported. Configuration signals relating to configuring the reset state of the MPMC are not used. You must configure the MPMC before you use it to control memory on either the dynamic or static memory buses.

The **MPMCx** signals from the configuration block (shown in *MPMC PrimeCell block diagram* on page 10-6) are reserved for future use and are not supported in this release of the ARM926EJ-S Development Chip.

## 10.3 MPMC signals on pads

The pad interface and control signals are described in Table 10-1.

## Table 10-1 Pad interface and control signal descriptions

Name	Туре	Source/ destination	Description
MPMCADDROUT[25:15]	Output	MPMC/SSMC	Address output. Used for static memory devices.
		multiplexor	Note
			SDRAM memories only use <b>MPMCADDROUT</b> [14:0]. Static memories use bits <b>MPMCADDROUT</b> [25:0].
MPMCADDROUT[14:0]	Output	Pad and MPMC/SSMC multiplexor	Address output. Used for both static and SDRAM devices.
MPMCCKEOUT[3:0]	Output	Pad	SDRAM clock enables. Used for SDRAM devices.
MPMCCLKOUT[3:0]	Output	Pad	SDRAM clock out. Used for SDRAM devices.
MPMCDATAIN[31:0]	Input	Pad and MPMC/SSMC multiplexor	Read data from memory. Used for the static memory controller, the dynamic memory controller and the TIC.
MPMCDATAOUT[31:0]	Output	Pad and MPMC/SSMC multiplexor	Data output to memory. Used for the static memory controller, the dynamic memory controller and the TIC.
MPMCDATAOUTEN[3:0]	Output	Pad and MPMC/SSMC multiplexor	Enable data out onto external memory bus byte lanes.
MPMCDQMOUT[3:0]	Output	Pad	Data mask output to SDRAMs. Used for SDRAM devices.
MPMCFBCLKIN[3:0]	Input	Pad	SDRAM feedback clock in. Used for SDRAM devices.
MPMCRPVHHOUT	Output	Pad	Voltage control for Micro Syncflash reset signal (RP).
nMPMCBLSOUT[3:0]	Output	MPMC/SSMC multiplexor	Byte lane select, active LOW, for static memories. Used for static memory devices.
nMPMCCASOUT	Output	Pad	Column address strobe. Used for SDRAM devices.
nMPMCDYCSOUT[3:0]	Output	Pad	SDRAM chip selects. Used for SDRAM devices.
nMPMCOEOUT	Output	MPMC/SSMC multiplexor	Output enable for static memories. Used for static memory devices.

Name	Туре	Source/ destination	Description
nMPMCRASOUT	Output	Pad	Row address strobe. Used for SDRAM devices.
nMPMCRPOUT	Output	Pad	Reset power down to SyncFlash memory. Used for the dynamic memory controller.
nMPMCSTCSOUT[3:0]	Output	MPMC/SSMC multiplexor	Static memory chip selects. Default active LOW. Used for static memory devices.
nMPMCWEOUT	Output	Pad and MPMC/SSMC multiplexor	Write enable. During test mode acts as test acknowledge signal. Used for SDRAM and static memories.

## Table 10-1 Pad interface and control signal descriptions (continued)

Multi-Port Memory Controller (MPMC)

# Chapter 11 Real-Time Clock (RTC)

This chapter describes the Real Time Clock (RTC) PrimeCell in the ARM926EJ-S Development Chip. It contains the following sections:

- About the Real Time Clock on page 11-2
- *Functional description* on page 11-3.

## 11.1 About the Real Time Clock

The PrimeCell *Real Time Clock* (RTC) PL031 is an *Advanced Microcontroller Bus Architecture* (AMBA) compliant *System-on-a-Chip* (SoC) peripheral that is developed, tested, and licensed by ARM. The RTC connects to the core APB.

The RTC comprises:

- an AMBA APB interface
- a 32-bit counter
- a 32-bit match register
- a 32-bit comparator.

The CPU reads and writes data, and control and status information through the AMBA APB interface.

The 32-bit counter is incremented on successive rising edges of the input clock **CLK1HZ**. Counting in one second intervals is achieved by using an internal 1Hz clock signal for **CLK1HZ**. The counter is free-running. On reset, the counter:

- counts up from one
- reaches the maximum value, 0xFFFFFFF
- wraps around to zero and continues incrementing.

RTC is loaded or updated by writing to the load register, RTCLR.

Reading the data register, RTCDR, gives the current value of the RTC.

The match register is programmed by writing to RTCMR. The counter and match values are compared in a comparator. When both values are equal, the interrupt **RTCINTR** is asserted HIGH. The CPU can use the interrupt to implement a basic time alarm function. The interrupt is cleared by writing any data value to the interrupt clear register RTCICR. The value in the match register can be read at any time.

## 11.2 Functional description

The release version used is PL031 RTC 1v0. The base address for the RTC control registers is 0x101E8000. For more information on the controller, see the *ARM PrimeCell Timer Module (SP804) Technical Reference Manual*.

The PrimeCell RTC can be used to provide a basic alarm function or long time base counter. This is achieved by generating an interrupt signal after counting for a programmed number of cycles of a real-time clock input. Counting in one second intervals is achieved by use of a 1Hz clock input to the PrimeCell RTC. Figure 11-1 shows the block diagram of the PrimeCell RTC.



Figure 11-1 PrimeCell RTC

## 11.2.1 Registers

The base address of the PrimeCell RTC is 0x101E8000.

The following locations are reserved, and must not be used during normal operation:

- locations at offsets 0x20–0x7C and 0x94–0xFCC are reserved for possible future extensions
- locations at offsets 0x80–0x90 are reserved for test purposes
- locations at offsets 0xFD0–0xFDC are reserved for future identification registers.

#### 11.2.2 Interrupts

A single, maskable, active HIGH interrupt **RTCINTR** is generated by the PrimeCell RTC when a match occurs between the counter and the equivalent match value:

- This interrupt is enabled or disabled by changing the mask bit in RTCIMSC. To enable the interrupt, set bit 0 HIGH.
- The status of the interrupt mask can be read from bit 0 of RTCMIS.
- Writing 1 to bit 0 of RTCICR clears the RTCINTR flag.
- The RTC interrupt, RTCINTR, is output to the interrupt controller.
- The RTC interrupt drives interrupt line 10 of the VIC.

# Chapter 12 Smart Card Interface (SCI)

This chapter describes the SCI in the ARM926EJ-S Development Chip. It contains the following sections:

- About the ARM SCI on page 12-2
- *Functional description* on page 12-4
- SCI signals on pads on page 12-6.

## 12.1 About the ARM SCI

The PrimeCell Smart Card Interface (SCI) PL131 is an *Advanced Microcontroller Bus Architecture* (AMBA) compliant *System-on-a-Chip* (SoC) peripheral that is developed, tested, and licensed by ARM. The SCI connects to the DMA APB.

The release version used is PL131 SCI 1v0. The base address for the SCI control registers is 0x101F0000. For more detailed information on the controller, see the *ARM PrimeCell Smart Card Interface Technical Reference Manual*.

The following features are provided by the PrimeCell SCI:

- Compliance to the *AMBA Specification (Rev 2.0)* onwards for easy integration into System-on-a-Chip (SoC) implementation.
- Supports asynchronous T0 and T1 transmission protocols.
- Supports clock rate conversion factor F = 372 or 512, with bit rate adjustment factors D = 1, 2, 4, 8, and 16 supported.
- Eight character deep buffered TX and RX paths.
- Direct interrupts for TX and RX FIFO level monitoring.
- Independent masking of all interrupts.

The interrupt signals are combined and a single interrupt is output to the VIC.

• Support for Direct Memory Access (DMA).

The SCI transmit DMA request is connected to DMA channel 11. The receive request is connected to DMA channel 10.

- Interrupt status register.
- Hardware initiated card deactivation sequence on detection of card removal.
- Software initiated card deactivation sequence on transaction complete.
- Limited support for synchronous smart cards through registered input/output.
- Identification registers that uniquely identify the PrimeCell SCI. These can be used by an operating system to automatically configure itself.

## 12.1.1 Programmable parameters

The following key parameters are programmable:

- Smart Card clock frequency
- communication baud rate
- protocol convention
- card activation time
- card deactivation time
- check for maximum time for first character of Answer To Reset (ATR) reception
- check for maximum duration of ATR character stream
- check for maximum time for receipt of first character of data stream
- check for maximum time permitted between characters
- character guard time
- block guard time
- transmit character retry
- receive character retry
- transmit FIFO tide level
- receive FIFO tide level
- clock stop time
- clock start time
- clock inactive level.

Additional test registers and modes are implemented to provide efficient testing.

## 12.2 Functional description



The block diagram of the SCI is shown in Figure 12-1.

#### Figure 12-1 SCI block diagram

#### 12.2.1 Registers

The base address of the PrimeCell SCI is 0x101F0000.

The following locations are reserved, and must not be used during normal operation:

- locations at offset 0x101F0088-0x101F0EFC are reserved and must not be used
- locations at offsets 0x101F0F00–0x101F0F10 are reserved for test purposes
- locations at offsets 0x101F0F14-0x101F0FCC are reserved and must not be used
- locations at offsets 0x101F0FD0-0x101F0FDC are reserved for possible future extensions.

## 12.2.2 DMA

SCI Tx DMA requests go to DMA channel 7. SCI Rx requests go to channel 6.

## 12.2.3 Interrupts

There are fifteen interrupts generated within the PrimeCell SCI. The interrupt mask set or clear register, SCIIMSC, provides a way of masking each of these individual interrupts. Setting the appropriate mask bit HIGH enables the interrupt, all of these are active HIGH.

Individual interrupts are shown in Table 12-1.

Tab	ما	12-	1 h	nte	rri	inte
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Name	Description
SCICARDININTR	SCI Card In interrupt
SCICARDOUTINTR	SCI Card Out interrupt
SCICARDUPINTR	SCI Card powered Up interrupt
SCICARDDNINTR	SCI Card powered Down interrupt
SCITXERRINTR	SCI Transmit Error interrupt
SCIATRSTOUTINTR	SCI Answer-To-Reset Start Time Out interrupt
SCIATRDTOUTINTR	SCI Answer-To-Reset data stream Duration Time Out
SCIBLKTOUTINTR	SCI Block Time Out interrupt
SCICHTOUTINTR	SCI Character Time Out interrupt
SCIRTOUTINTR	SCI Read Time Out interrupt
SCIRORINTR	SCI Overrun interrupt
SCICLKSTPINTR	SCI Clock Stopped interrupt
SCICLKACTINTR	SCI Clock Active interrupt
SCIRXTIDEINTR	SCI Receive FIFO Tide level interrupt
SCITXTIDEINTR	SCI Transmit FIFO Tide level interrupt.

A single interrupt, SCIINTR, that is the combinatorial OR of the fifteen individual interrupts is output to the VIC interrupt line 15.

## 12.3 SCI signals on pads

The SCI interface signals connected to the input/output pads are listed in Table 12-2.

## Table 12-2 SCI signals

Name	Туре	Description
SCICLKIN	Input	PrimeCell SCI clock input.
SCIDATAIN	Input	PrimeCell SCI serial data input.
nSCICLKOUTEN	Output	Tristate output buffer control (active LOW).
SCICLKOUT	Output	Clock output.
nSCIDATAOUTEN	Output	Data output enable (typically drives an open-drain configuration, active LOW).
nSCICLKEN	Output	Tristate control for external off-chip buffer (active LOW).
nSCIDATAEN	Output	Tristate control for external off-chip buffer (active LOW).
SCIVCCEN	Output	Supply voltage controls (active HIGH).
nSCICARDRST	Output	Reset to card (active LOW).
SCIFCB	Output	Function code bit, used in conjunction with nSCICARDRST.
SCIDETECT	Input	Card detects signal from card interface device (active HIGH).

# Chapter 13 Synchronous Static Memory Controller (SSMC)

This chapter describes the SSMC in the ARM926EJ-S Development Chip. It contains the following sections:

- About the ARM PrimeCell SSMC (PL093) on page 13-2
- *Functional description* on page 13-5
- SSMC signals on pads on page 13-9.

## 13.1 About the ARM PrimeCell SSMC (PL093)

The PrimeCell Synchronous Static Memory Controller (SSMC) is an Advanced Microcontroller Bus Architecture (AMBA) compliant System-on-Chip peripheral that is developed, tested, and licensed by ARM. The SSMC connects to the AHB bus matrix.

The release version used is PL093 SSMC r0p0-00ltd0. The base address for the SSMC control registers is 0x10100000. For more information on the controller, see the *ARM PrimeCell Static Memory Controller (PL093) Technical Reference Manual*. For further information on AMBA refer to the *AMBA Specification*.

## 13.1.1 Features of the PrimeCell SSMC

The PrimeCell SSMC macro block offers the following features:

- soft macrocell available in both VHDL and Verilog
- fully scan insertable design
- functional verification using ARM BusTalk functional test environment
- compatibility with AMBA AHB on-chip bus systems.

The PrimeCell SSMC supports:

- asynchronous static memory-mapped devices including RAM, ROM, and flash
- synchronous static memory-mapped devices including synchronous burst flash
- asynchronous page mode read operation in nonclocked memory subsystems
- asynchronous burst mode read access to burst mode ROM and flash devices
- 8, 16, and 32-bit wide external memory data paths
- little-endian and big-endian memory architectures
- AHB burst transfers
- independent configuration for up to eight memory banks, each up to 64MB
- programmable wait states (up to 31)
- programmable bus turnaround cycles (up to 15)
- programmable output enable and write enable delays (up to 15)
- write enable and byte lane select outputs for use with 32, 16, or 8-bit SRAM devices
- independent byte lane control for each memory bank

- external asynchronous wait control
- configurable size at reset for boot memory bank using external control pins
- system testing using externally applied TIC vectors through built-in TIC AMBA master block
- support to interface to another memory controller using an *External Bus Interface* (EBI)
- multiple memory clock frequencies available, HCLK, HCLK/2, and HCLK/3
- eight word, 32-bit, wrapping reads from 16-bit or 32-bit memory.

## 13.1.2 Programmable parameters

The following key parameters are programmable for each memory bank:

- external memory width, 8, 16, or 32-bit
- burst mode operation
- write protection
- external wait control enable
- external wait polarity
- write WAIT states for static RAM devices
- read WAIT states for static RAM and ROM devices
- initial burst read WAIT state for burst devices
- subsequent burst read WAIT state for burst devices
- read byte lane enable control
- bus turn-around (idle) cycles
- output enable and write enable output delays.

## 13.1.3 Supported memory devices

The PrimeCell SSMC can be connected to synchronous and asynchronous memory devices.

The following devices are examples of the type of asynchronous devices that can connect to the PrimeCell SSMC:

AMD	16Mb page mode flash, Am29PL160C (2M x 8B only)
Micron	4Mb flash MT28F004B5
Samsung	128Mb ROM K3N9V(U)10000M-YC
	4Mb SRAM K6R4016C1C
	8Mb SRAM K6T8016C3M

The following devices are examples of the type of synchronous devices that can connect to the PrimeCell SSMC:

Intel	3V synchronous Strata flash, 28F640K3.
Micron	2Mx16 burst flash, MT28F322D15.
	2Mx16 burst flash, MT28F322D18.
	2Mx16 burst flash, MT28F322D20.
AMD	<ul> <li>3V-only high-performance burst mode and page mode flash memories:</li> <li>8Mb (512K x 16-bit boot sector, Am29BL802C)</li> </ul>
	• 16Mb (1M x 16-bit boot sector, Am29BL162C).

## 13.2 Functional description

The SSMC core performs read and write accesses to external memory through the AMBA AHB slave interface. Figure 13-1 shows a block diagram of the SSMC core. Figure 13-2 on page 13-6 and Figure 13-3 on page 13-7 shows the data and control signal multiplexing.



## Figure 13-1 SSMC interface block diagram

If the select signal **CFGMPMCnSMC** is HIGH, the MPMC controller is used in place of the SSMC. The multiplexing circuitry for the static address, data, and control signals is shown in Figure 13-2 and Figure 13-3 on page 13-7.



## Figure 13-2 Address and control multiplexor



Figure 13-3 Data multiplexor

## 13.2.1 Implementation details

Table 13-1 describes the internal signals that are configurable or tied off.

## Table 13-1 Internal signal descriptions

Signal name	Туре	Source/ destination	Description
SMBIGENDIAN	Input	Configuration control	This static configuration bit indicates the type of endianness of the memory system: 0 = little-endian 1 = big-endian.
SMBUSBACKOFFEBI	Input	LOW	Release bus signal, tells SSMC to release bus. Only used when <b>EXTBUSMUX</b> is tied to one.
SMBUSGNTEBI	Input	LOW	Bus grant signal, indicates that the SSMC is granted control of the external bus. Only used when <b>EXTBUSMUX</b> is tied to one.
SMBUSREQEBI	Output	Not used	Bus request signal, indicates that the SSMC has requested use of the external bus. Only used when <b>EXTBUSMUX</b> is tied to one.
SMEXTBUSMUX	Input	LOW	This static configuration bit indicates if the internal bus multiplexor (DBI) is used, or if an external bus multiplexor (for example EBI) is used instead: 0 = internal bus multiplexor 1 = external bus multiplexor
SMMEMCLK	Input	Configuration control	Memory clock.
SMMEMCLKRATIO[1:0 ]	Input	Configuration control	Defines ratio of <b>SMMEMCLK</b> to <b>HCLK</b> : 00 - <b>SMMEMCLK = HCLK</b> 01 - <b>SMMEMCLK = HCLK</b> /2 10 - <b>SMMEMCLK = HCLK</b> /3 11 - Reserved
nSMBURSTWAIT[7:1]	Input	HIGH	Synchronous burst wait input used by the external device to delay a synchronous burst transfer.
SMCS[7:0]	Output	Not used	Active HIGH chip selects.

## 13.3 SSMC signals on pads

Table 13-2 describes	the signals to the	input/output pads.
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## Table 13-2 Pad signals

Signal name	Direction	Description
nSMBURSTWAIT[0]	Input	Synchronous burst wait input used by the external device to delay a synchronous burst transfer.
SMBLS7POL	Input	This is used to define the reset value of bit 6 in SMBCR7 ( <b>nSMBLS</b> ): 0 = <b>nSMBLS</b> is active low (default) 1 = <b>nSMBLS</b> is active high.
SMCANCELWAIT	Input	This signal enables the system to recover from an externally waited transfer that takes longer than expected to finish. Active HIGH.
SMDATAIN[31:0]	Input	External input data bus used to read data from memory bank.
SMDATAOUT[31:0]	Input	External output data used to write data from SSMC to memory bank.
SMFBCLK	Input	The feedback clock from the memory devices.
SMMWCS7[1:0]	Input	These static configuration bits indicate the memory width used for boot memory bank one:
		00 = 8-bit
		01 = 16-bit
		10 = 32-bit
		11 = reserved.
SMWAIT	Input	Wait mode input from external memory controller. Active HIGH or active LOW (default), as programmed in the SSMC control registers for each bank.
nSMCS0	Output	Chip select for bank 0 of external memory, default active LOW.
nSMCS1	Output	Chip select for bank 1of external memory, default active LOW.
nSMCS2	Output	Chip select for bank 2 of external memory, default active LOW.
nSMCS3	Output	Chip select for bank 3 of external memory, default active LOW.
nSMCS4	Output	Chip select for bank 4 of external memory, default active LOW.
nSMCS5	Output	Chip select for bank 5 of external memory, default active LOW.

Signal name	Direction	Description
nSMCS6	Output	Chip select for bank 6 of external memory, default active LOW.
nSMCS7	Output	Chip select for bank 7 of external memory, default active LOW.
nSMDATAEN[3:0]	Output	Tristate input/output pad enable for the byte lanes of the external memory data bus <b>SMDATA[31:0]</b> , active LOW. Enables the byte lanes [31:24], [23:16], [15:8], and [7:0] of the data bus independently.
nSMOEN	Output	Output enable for external memory banks, active LOW.
nSMWEN	Output	Write enable for the external memory banks, active LOW.
SMADDR[25:0]	Output	External memory address bus, to external memory banks.
SMADDRVALID	Output	External address valid output, used to indicate when the address output is stable during synchronous burst transfers.
SMBAA	Output	External burst address advance signal. Used to advance the address count in the external memory device.
nSMBLS[3:0]	Output	Byte lane select signals, active LOW. The signals <b>nSMBLS[3:0]</b> select byte lanes [31:24], [23:16], [15:8], and [7:0] on the data bus.
SMCLK[3:0]	Output	The clocks output to synchronous memory devices.

## Table 13-2 Pad signals (continued)

# Chapter 14 Synchronous Serial Port (SSP)

This chapter describes the SSP in the ARM926EJ-S Development Chip. It contains the following sections:

- About the ARM PrimeCell SSP (PL022) on page 14-2
- *Functional description* on page 14-4
- SSP signals on pads on page 14-6.

## 14.1 About the ARM PrimeCell SSP (PL022)

The PrimeCell Synchronous Serial Port (SSP) is an Advanced Microcontroller Bus Architecture (AMBA) slave block that connects to the DMA APB. The PrimeCell SSP is an AMBA compliant System-on-Chip (SoC) peripheral that is developed, tested, and licensed by ARM.

The release version used is PL022 SSP REL1v2. The base address for the SSP control registers is 0x101F4000. For more information on the controller, see the *ARM PrimeCell Synchronous Serial Port Controller (PL022) Technical Reference Manual*.

The PrimeCell SSP is a master or slave interface that enables synchronous serial communication with slave or master peripherals having one of the following:

- a Motorola SPI-compatible interface
- a Texas Instruments synchronous serial interface
- a National Semiconductor Microwire interface.

In both master and slave configurations, the PrimeCell SSP performs:

- parallel-to-serial conversion on data written to an internal 16-bit wide, 8-location deep transmit FIFO
- serial-to-parallel conversion on received data, buffering it in a similar 16-bit wide, 8-location deep receive FIFO.

Interrupts are generated to:

- request servicing of the transmit and receive FIFO
- inform the system that a receive FIFO over-run has occurred
- inform the system that data is present in the receive FIFO after an idle period has expired.

## 14.1.1 Features of the PrimeCell SSP

The PrimeCell SSP has the following features:

- Compliance to the *AMBA Specification (Rev 2.0)* for easy integration into SoC implementation.
- Master or slave operation.
- Programmable clock bit rate and prescale.
- Separate transmit and receive first-in, first-out memory buffers, 16 bits wide, 8 locations deep.

- Programmable choice of interface operation, SPI, Microwire, or TI synchronous serial.
- Programmable data frame size from 4 to 16 bits.
- Independent masking of transmit FIFO, receive FIFO, and receive overrun interrupts.
- Internal loopback test mode available.
- Support for *Direct Memory Access* (DMA).
- Identification registers that uniquely identify the PrimeCell SSP. These can be used by an operating system to automatically configure itself.

Figure 14-1 shows a block diagram of the PrimeCell SSP and the pad interface.



Figure 14-1 PrimeCell SSP block diagram

## 14.2 Functional description

This section describes the function of the SSP controller.

For detailed information on the internal organization and the SSP registers, see the ARM PrimeCell Synchronous Serial Port Controller (PL022) Technical Reference Manual.

## 14.2.1 Using an external reference clock

In the slave mode of operation, the **SSPCLKIN** signal from the external master is double synchronized and then delayed to detect an edge. It takes three **SSPCLKs** to detect an edge on **SSPCLKIN**. **SSPTXD** has less setup time to the falling edge of **SSPCLKIN** on which the master is sampling the line. The setup and hold times on **SSPRXD** with reference to **SSPCLKIN** must be more conservative to ensure that it is at the right value when the actual sampling occurs within the SSPMS. To ensure correct device operation, **SSPCLKIN**.

The frequency selected for **SSPCLK** must accommodate the desired range of bit clock rates. The ratio of minimum **SSPCLK** frequency to **SSPCLKOUT** maximum frequency in the case of the slave mode is 12 and for the master mode it is two.

To generate a maximum bit rate of 1.8432Mbps in the Master mode, the frequency of **SSPCLK** must be at least 3.6864MHz. With an **SSPCLK** frequency of 3.6864MHz, the SSPCPSR register has to be programmed with a value of two and the SCR[7:0] field in the SSPCR0 register must be programmed as zero.

To work with a maximum bit rate of 1.8432Mbps in the slave mode, the frequency of **SSPCLK** must be at least 22.12MHz. With an **SSPCLK** frequency of 22.12MHz, the SSPCPSR register can be programmed with a value of 12 and the SCR[7:0] field in the SSPCR0 register can be programmed as zero. Similarly the ratio of **SSPCLK** maximum frequency to **SSPCLKOUT** minimum frequency is 254x256.

The minimum frequency of **SSPCLK** is governed by the following equations, both of which have to be satisfied:

F<sub>SSPCLK</sub>(min) => 2 x F<sub>SSPCLKOUT</sub>(max) [for master mode]

F<sub>SSPCLK</sub>(min) => 12 x F<sub>SSPCLKIN</sub>(max) [for slave mode].

The maximum frequency of **SSPCLK** is governed by the following equations, both of which have to be satisfied:

F<sub>SSPCLK</sub>(max) <= 254 x 256 x F<sub>SSPCLKOUT</sub>(min) [for master mode]

F<sub>SSPCLK</sub>(max) <= 254 x 256 x F<sub>SSPCLKIN</sub>(min) [for slave mode]

## 14.2.2 Registers

The base address of the PrimeCell SSP is 0x101F4000.

The following locations are reserved, and must not be used during normal operation:

- locations at offsets 0x028–0x07C and 0xFD0–0xFDC are reserved for possible future extensions
- locations at offsets 0x080–0x088 are reserved for test purposes.

#### 14.2.3 Interrupts

There are five interrupts generated by the PrimeCell SSP. Four of these are individual, maskable, active HIGH interrupts:

SSPRXINTR	PrimeCell SSP receive FIFO service interrupt request.
SSPTXINTR	PrimeCell SSP transmit FIFO service interrupt request.
SSPRORINTR	PrimeCell SSP receive overrun interrupt request.

**SSPRTINTR** PrimeCell SSP time out interrupt request.

The fifth is a combined single interrupt **SSPINTR**.

#### \_\_\_\_\_ Note \_\_\_\_\_

Only the combined interrupt is connected to the interrupt controller. VIC interrupt line 11 is used for the SSP interrupt.

The status of the individual interrupt sources can be read from SSPRIS and SSPMIS registers.

## 14.2.4 DMA

SSP transmit requests use DMA channel 9. SSP receive requests use DMA channel 8.

## 14.3 SSP signals on pads

The signals connected to pads are listed in Table 14-1.

Table	14-1	Pad	signal	descri	ntions
able	14-1	гau	Signai	uesch	μιισπο

Name	Туре	Description
SSPFSSOUT	Output	PrimeCell SSP frame, or slave select output (master).
SSPCLKOUT	Output	PrimeCell SSP clock output (master).
SSPRXD	Input	PrimeCell SSP receive data input.
SSPTXD	Output	PrimeCell SSP transmit data output.
nSSPCTLOE	Output	Output enable signal (active LOW) for <b>SSPCLKOUT</b> output from the PrimeCell SSP. This output is cleared when the device is in master mode and set when the device is in slave mode.
SSPFSSIN	Input	PrimeCell SSP frame input (slave).
SSPCLKIN	Input	PrimeCell SSP clock input (slave).
nSSPOE	Output	Output enable signal (active LOW) to indicate when SSPTXD is valid.
SSPCLKEXT	Input	External clock reference for peripheral. This signal can be selected instead of the internal clock reference.

# Chapter 15 Dual Timer/Counters

This chapter describes the SP804 timer/counters in the ARM926EJ-S Development Chip. It contains the following section:

- About the ARM Dual-Timer module (SP804) on page 15-2
- *Functional description* on page 15-3.

## 15.1 About the ARM Dual-Timer module (SP804)

The ARM Dual-Timer module is an *Advanced Microcontroller Bus Architecture* (AMBA) compliant *System-on-Chip* (SoC) peripheral developed, tested, and licensed by ARM Limited. For more information, see the *AMBA Specification (Rev 2.0)*.

The release state of the ARM Dual-Timer module used in the ARM926EJ-S Development Chip is SP804-r1p0. The base address for the Dual-Timer control registers are 0x101E2000 and 0x101E3000.

The module is an AMBA slave module and connects to the core APB. The Dual-Timer module consists of two programmable 32/16-bit down counters that can generate interrupts on reaching zero.

#### 15.1.1 Features

The features of the Dual-Timer module are:

- Compliance to the *AMBA Specification (Rev 2.0)* for easy integration into an SoC implementation.
- Two 32/16-bit down counters with free-running, periodic, and one-shot modes.
- Common clock with separate clock-enables for each timer gives flexible control of the timer intervals.
- Interrupt output generation on timer count reaching zero.
- Identification registers that uniquely identify the Dual-Timer module. These can be used by software to automatically configure itself.

## 15.2 Functional description

This section gives a basic overview of the Dual-Timer module operation.

The Dual-Timer module consists of two identical programmable *Free Running Counters* (FRCs) that can be configured for 32-bit or 16-bit operation and one of three timer modes;

- free-running
- periodic
- one-shot.

The FRCs operate from a common timer clock, a buffered version of **HCLK** with each FRC having its own clock enable input, **TIMCLKEN1** and **TIMCLKEN2**. Each FRC also has a prescaler that can divide down the enabled timer clock rate by 1, 16, or 256. This enables the count rate for each FRC to be controlled independently using their individual clock enables and prescalers.

The operation of each Timer module is identical. A Timer module can be programmed for a 32-bit or 16-bit counter size and one of three timer modes using the Control Register. The three timer modes are:

Free-running	The counter operates continuously and wraps around to its maximum value each time that it reaches zero.
Periodic	The counter operates continuously by reloading from the Load Register each time that the counter reaches zero.
One-shot	The counter is loaded with a new value by writing to the Load Register. The counter decrements to zero and then halts until it is reprogrammed.

The timer count is loaded by writing to the Load Register and, if enabled, the timer count decrements at a rate determined by the timer clock, **TIMCLKENx**, and the prescaler setting. When the Timer counter is already running, writing to the Load Register causes the counter to immediately restart from the new value.

An alternative way of loading the Timer count is by writing to the Background Load Register. This has no immediate effect on the current count but the counter continues to decrement. On reaching zero, the Timer count is reloaded from the new load value if it is in periodic mode.

When the Timer count reaches zero an interrupt is generated. The interrupt is cleared by writing to the Interrupt Clear Register. The external interrupt signals can be masked off by the Interrupt Mask Registers.

The current counter value can be read from the Value Register at any time.

Figure 15-1 shows a simplified block diagram of the module. At reset, the timers are clocked by an external reference on the **REFCLK32K** input. You can use the system controller to change the timer reference to the **TIMCLKEXT** input signal (see *Clock control* on page 2-13).

In Figure 15-1, test logic is not shown for clarity.

– Note –––––



#### Figure 15-1 Simplified block diagram

#### 15.2.1 Interrupts

The interrupt signals from the two counters are combined and output to VIC interrupt line 10.

## 15.2.2 Programmable parameters

The following Dual-Timer module parameters are programmable:

- free-running, periodic, or one-shot timer modes
- 32-bit or 16-bit timer operation
- prescaler divider of 1, 16, or 256
- interrupt generation enable and disable
- interrupt masking.

#### 15.2.3 Registers

The base address of the PrimeCell timers are:

**Timer01** 0x101E2000.

**Timer23** 0x101E3000.

Some locations within the memory range are reserved:

- offsets 0x40–0xEFC
- offsets 0xF08–0xFDC.

For detailed information on the timer registers, see the *ARM Dual-Timer Module* (SP804) Technical Reference Manual.

Dual Timer/Counters
# Chapter 16 UART Controller

This chapter describes the UART peripherals in the ARM926EJ-S Development Chip. It contains the following sections:

- About the ARM PrimeCell UART (PL011) on page 16-2
- *Functional description* on page 16-4
- UART signals on pads on page 16-8.

# 16.1 About the ARM PrimeCell UART (PL011)

The PrimeCell UART is an *Advanced Microcontroller Bus Architecture* (AMBA) compliant *System-on-Chip* (SoC) peripheral that is developed, tested, and licensed by ARM.

The release version used is PL011 UART 1v3. The base address for the UART control registers are 0x101F1000, 0x101F2000, and 0x101F3000. For more information on the controller, see the *ARM PrimeCell UART (PL011) Technical Reference Manual*.

The PrimeCell UART is an AMBA slave module, and connects to the DMA APB. The PrimeCell UART includes an *Infrared Data Association* (IrDA) *Serial InfraRed* (SIR) protocol *ENcoder/DECoder* (ENDEC).

The features of the PrimeCell UART are covered under the following headings:

- Features of the PrimeCell UART
- *Programmable parameters* on page 16-6
- *Variations from the 16C550 UART* on page 16-7.

—— Note ———

Because of changes in the programmer's model, the PrimeCell UART (PL011) is not backwards compatible with the previous PrimeCell UART PL010.

## 16.1.1 Features of the PrimeCell UART

The PrimeCell UART provides:

- Compliance to the *AMBA Specification (Rev 2.0)* onwards for easy integration into SoC implementation.
- Programmable use of PrimeCell UART or IrDA SIR input/output.
- Separate 16x8 transmit and 16x12 receive *First-In, First-Out memory buffers* (FIFOs) to reduce CPU interrupts.
- Programmable FIFO disabling for 1-byte depth.
- Programmable baud rate generator. This enables division of the reference clock by (1x16) to (65535 x16) and generates an internal x16 clock. The divisor can be a fractional number enabling you to use any clock with a frequency >3.6864MHz as the reference clock.
- Standard asynchronous communication bits (start, stop, and parity). These are added prior to transmission and removed on reception.

• Independent masking of transmit FIFO, receive FIFO, receive timeout, modem status, and error condition interrupts.

\_\_\_\_\_ Note \_\_\_\_\_

The interrupts signals from each UART are combined into a single interrupt that is output to the VIC.

- Support for *Direct Memory Access* (DMA).
- False start bit detection.
- Line break generation and detection.
- Support of the modem control functions CTS, DCD, DSR, RTS, DTR, and RI.
- Programmable hardware flow control.
- Fully-programmable serial interface characteristics:
  - data can be 5, 6, 7, or 8 bits
  - even, odd, stick, or no-parity bit generation and detection
  - 1 or 2 stop bit generation
  - baud rate generation, dc up to UARTCLK\_max\_freq/16
- IrDA SIR ENDEC block providing:
  - programmable use of IrDA SIR or PrimeCell UART input/output
  - support of IrDA SIR ENDEC functions for data rates up to 115.2Kbits/second half-duplex
  - support of normal 3/16 and low-power  $(1.41-2.23\mu s)$  bit durations
  - programmable internal clock generator enabling division of reference clock by 1–256 for low-power mode bit duration.
- Identification registers that uniquely identify the PrimeCell UART. These can be used by an operating system to automatically configure itself.

# 16.2 Functional description

Figure 16-1 shows a block diagram of the PrimeCell UARTs and the interface connections.

— Note —

Not all of the UART1 and UART2 signals are connected to the pads. Other than the tied-off signals, the operation of UART1 and UART2 is the same as UART0.



Figure 16-1 PrimeCell UART block diagram

#### 16.2.1 Clock signals

The UARTs can be clocks from an internal reference or the external reference clock **UARTCLKEXT** can be selected.

The frequency selected for **UARTCLK** must accommodate the required range of baud rates:

**F**<sub>UARTCLK</sub> (min) >= 16 x baud\_rate (max)

 $F_{UARTCLK}(max) \le 16 \times 65535 \times baud_rate (min)$ 

For example, for a range of baud rates from 110–460 800 baud the **UARTCLK** frequency must be within the range 7.3728–115MHz.

The frequency of **UARTCLK** must also be within the required error limits for all baud rates to be used.

There is also a constraint on the ratio of clock frequencies for **PCLK** to **UARTCLK**. The frequency of **UARTCLK** must be no more than 5/3 times faster than the frequency of **PCLK**:

 $\mathbf{F}_{\mathbf{UARTCLK}} \ll \frac{5}{3} \times \mathbf{F}_{\mathbf{PCLK}}$ 

This gives sufficient time to write the received data to the receive FIFO.

## 16.2.2 Registers

There are three PrimeCell UARTs in the ARM926EJ-S Development Chip. The base addresses are:

UART0	0x101F1000.
UART1	0x101F2000.
UART3	0x101F3000.

The following locations are reserved, and must not be used during normal operation:

- locations at offsets 0x008–0x014, and 0x01C are reserved and must not be accessed
- locations at offsets 0x04C–0x07C are reserved for possible future extensions
- locations at offsets 0x080–0x08C are reserved for test purposes
- locations at offsets 0x90–0xFCC are reserved for future test purposes
- location used at offsets 0xFD0-0xFDC are used for future identification registers
- location used at offsets 0xFE0–0xFFC are used for identification registers.

## **Programmable parameters**

The following key parameters are programmable:

- communication baud rate, integer, and fractional parts
- number of data bits
- number of stop bits
- parity mode
- FIFO enable (16 deep) or disable (1 deep)
- FIFO trigger levels selectable between 1/8, 1/4, 1/2, 3/4, and 7/8.
- internal nominal 1.8432MHz clock frequency (1.42–2.12MHz) to generate low-power mode shorter bit duration
- hardware flow control.

Additional test registers and modes are implemented for integration testing.

## 16.2.3 Interrupts

The interrupts signals from each UART are combined into a single interrupt that is output to the VIC:

<b>UART0</b>	VIC interrupt line 12
UART1	VIC interrupt line 13
UART2	VIC interrupt line 14.

#### 16.2.4 DMA

The DMA requests from each UART are combined into two DMA channels:

UART0 Tx	DMA channel 15
UARTO Rx	DMA channel 14
UART1 Tx	DMA channel 13
UART1 Rx	DMA channel 12
UART2 Tx	DMA channel 11
UART2 Rx	DMA channel 10.

#### 16.2.5 Implementation details

The following inputs are tied off:

- nUART1DCD is tied HIGH
- **nUART1DSR** is tied HIGH
- **nUART1RI** is tied HIGH
- **SIRIN1** is tied LOW
- **nUART2DCD** is tied HIGH
- **nUART2DSR** is tied HIGH
- **nUART2RI** is tied HIGH
- **SIRIN2** is tied LOW.

The following outputs are unconnected:

- nUART1DTR
- nUART1Out1
- nUART1Out2
- nSIROUT1
- nUART2DTR
- nUART2Out1
- nUART2Out2
- nSIROUT2.

## Variations from the 16C550 UART

The PrimeCell UART varies from the industry-standard 16C550 UART device as follows:

- receive FIFO trigger levels are 1/8, 1/4, 1/2, 3/4, and 7/8
- the internal register map address space, and the bit function of each register differ
- the deltas of the modem status signals are not available.

The following 16C550 UART features are not supported:

- 1.5 stop bits (1 or 2 stop bits only are supported)
- independent receive clock.

# 16.3 UART signals on pads

The signals connected to pads are listed in Table 16-1.

Name	Direction	Description	
nUART0CTS nUART1CTS nUART2CTS	Input	UART Clear To Send modem status signal, active LOW. The condition of this signal can be read from the UARTFR register.	
nUART0DCD	Input	UART Data Carrier Detect modem status signal, active LOW. The condition of this signal can be read from the UARTFR register. ( <b>nUARTDCD</b> is tied HIGH on UART1 and UART2.)	
nUART0DSR	Input	UART Data Set Ready modem status signal, active LOW The condition of this signal can be read from the UARTFR register. ( <b>nUARTDSR</b> is tied HIGH on UART1 and UART2.)	
nUARTORI	Input	UART Ring Indicator modem status signal, active LOW. The condition of this signal can be read from the UARTFI register. ( <b>RI</b> is tied HIGH on UART1 and UART2.)	
SIRIN0	Input	SIR Received Serial Data Input. In the idle state, the signal remains in the marking state 1. When a light pulse is received which represents a logic 0, this signal is a 0. ( <b>SIRIN</b> is tied LOW on UART1 and UART2.)	
UARTORXD UART1RXD UART2RXD	Input	UART Received Serial Data signal.	
UARTCLKEXT	Input	External clock reference for peripheral. This signal can be selected instead of the internal clock reference.	
nSIROUT0	Output	SIR Transmitted Serial Data Output, active LOW. In the idle state, this signal remains 0 (the marking state). When this signal is set to 1, an infrared light pulse is generated which represents a logic 0 (spacing state). (SIROUT is not used on UART1 and UART2.)	

## Table 16-1 Pad signal descriptions

Name	Direction	Description	
nUART0DTR	Output UART Data Terminal Ready modem status sign LOW.		
		The reset value is 0.	
		( <b>nUARTDTR</b> is not used on UART1 and UART2.)	
nUART0Out1	Output	UART modem status signal, active LOW.	
nUART0Out2		The reset value is 0.	
		(nUARTOut1 is not used on UART1 and UART2.)	
UARTOTXD	Output	UART Transmit Serial Data.	
UART1TXD		Defaults to the marking state 1, when reset.	
UART2TXD			
nUARTORTS	Output	UART Request To Send modem status signal, active	
nUART1RTS		LOW.	
nUART2RTS		The reset value is 0.	

## Table 16-1 Pad signal descriptions (continued)

UART Controller

# Chapter 17 Vectored Interrupt Controller (VIC)

This chapter describes the vectored-interrupt controller in the ARM926EJ-S Development Chip. It contains the following sections:

- About the ARM PrimeCell Vectored Interrupt Controller (PL190) on page 17-2
- Functional description on page 17-4
- *VIC signals on pads* on page 17-11.

# 17.1 About the ARM PrimeCell Vectored Interrupt Controller (PL190)

The PrimeCell *Vectored Interrupt Controller* (VIC) is an *Advanced Microcontroller Bus Architecture* (AMBA) compliant, *System-on-Chip* (SoC) peripheral that is developed, tested, and licensed by ARM.

The release version used is PL190 VIC 1v1. The base address for the VIC control registers is 0x10140000. For more information on the controller, see the *ARM PrimeCell Vector Interrupt Controller (PL190) Technical Reference Manual*.

The PrimeCell VIC provides an interface to the interrupt system, and improves interrupt latency in two ways:

- moves the interrupt controller to the AMBA AHB bus
- provides vectored interrupt support for high-priority interrupt sources.

## 17.1.1 Features of the PrimeCell VIC

The PrimeCell VIC has the following features:

- compliance to the AMBA Specification (Rev 2.0) onwards for easy integration into System-on-Chip (SoC) implementation
- support for 32 standard interrupts
- support for 16 vectored IRQ interrupts
- hardware interrupt priority
- IRQ and FIQ generation
- AHB mapped for faster interrupt response
- software interrupt generation
- test registers
- raw interrupt status
- interrupt request status
- interrupt masking
- privileged mode support
- vector interrupt controller daisy chaining support.

The PrimeCell *Vectored Interrupt Controller* (VIC) provides a software interface to the interrupt system. In an ARM system, two levels of interrupt are available:

- Fast Interrupt Request (FIQ) for fast, low latency interrupt handling
- Interrupt Request (IRQ) for more general interrupts.

Only a single FIQ source at a time is generally used in a system, to provide a true low-latency interrupt. This has the following benefits:

- You can execute the interrupt service routine directly without determining the source of the interrupt.
- Interrupt latency is reduced. You can use the banked registers available for FIQ interrupts more efficiently, because a context save is not required.

There are 32 interrupt lines. The VIC uses a bit position for each different interrupt source. The software can control each request line to generate software interrupts.

There are 16 vectored interrupts. These interrupts can only generate an IRQ interrupt. The vectored and nonvectored IRQ interrupts provide an address for an *Interrupt Service Routine* (ISR). Reading from the vector interrupt address register, VICVectAddr, provides the address of the ISR, and updates the interrupt priority hardware that masks out the current and any lower priority interrupt requests. Writing to the VICVectAddr register, indicates to the interrupt priority hardware that the current interrupt is serviced, permitting lower priority interrupts to go active.

The FIQ interrupt has the highest priority, followed by interrupt vector 0 to interrupt vector 15. Nonvectored IRQ interrupts have the lowest priority. A programmed interrupt request enables you to generate an interrupt under software control. This register is typically used to downgrade an FIQ interrupt to an IRQ interrupt.

The priority of the FIQ over IRQ is set by the ARM. The VIC can raise both an FIQ and an IRQ at the same time.

The IRQ and FIQ request logic has an asynchronous path. This permits interrupts to be asserted when the clock is disabled.

# 17.2 Functional description



Figure 17-1 shows a block diagram of the PrimeCell VIC interface.

## Figure 17-1 VIC block diagram

\_\_\_\_\_Note \_\_\_\_\_

A secondary interrupt controller can be implemented in external logic and connected to one of the **VICINTSOURCE[31:24]** signals. Use a secondary interrupt controller if there are too many external peripherals to manage with only the **VICINTSOURCE[31:24]** signals.

# 17.2.1 Interrupt request logic

The interrupt request logic receives the interrupt requests from the peripheral and combines them with the software interrupt requests. It then masks out the interrupt requests that are not enabled, and routes the enabled interrupt requests to either IRQ or FIQ. Figure 17-2 shows a block diagram of the interrupt request logic.



Figure 17-2 Interrupt request logic

## 17.2.2 Nonvectored FIQ interrupt logic

The nonvectored FIQ interrupt logic generates the FIQ interrupt signal by combining the FIQ interrupt requests in the interrupt controller and any requests from daisy-chained interrupt controllers. Figure 17-3 shows a block diagram of the nonvectored FIQ interrupt logic.



#### Figure 17-3 Nonvectored FIQ interrupt logic

## 17.2.3 Nonvectored IRQ interrupt logic

The nonvectored IRQ interrupt logic combines the nonvectored interrupt requests to generate the nonvectored IRQ interrupt signal. This signal is then sent to the IRQ vector address and priority logic. Figure 17-4 shows a block diagram of the nonvectored IRQ interrupt logic.



#### Figure 17-4 Nonvectored IRQ interrupt logic

# 17.2.4 Vectored interrupt block

There are 16 vectored interrupt blocks. The vectored interrupt blocks receive the IRQ interrupt requests and set **VectIRQx** if the following are true:

- the selected interrupt is active
- the selected interrupt is the currently highest requesting interrupt.

Each vectored interrupt block also provides a **VectorAddrx[31:0]** output for use in the interrupt priority block. Figure 17-5 shows a block diagram of two of the vectored interrupt blocks.



Figure 17-5 Vectored interrupt block

# 17.2.5 Interrupt priority logic

The interrupt priority block prioritizes the following requests:

- nonvectored interrupt requests
- vectored interrupt requests
- external interrupt requests.

The highest-priority request generates an IRQ interrupt if the interrupt is not currently being serviced. Figure 17-6 shows a block diagram of the interrupt priority logic.

— Note — — —

nVICIRQIN is the daisy-chained IRQ request input.



#### Figure 17-6 Interrupt priority logic

## 17.2.6 Vectored interrupts

A vectored interrupt is only generated if the following are true:

- it is enabled in the interrupt enable register, VICIntEnable
- it is set to generate an IRQ interrupt in the interrupt select register, VICIntSelect
- it is enabled in the relevant vector control register, VICVectCntl0-VICVectCntl15].

This prevents multiple interrupts being generated from a single interrupt request if the controller is incorrectly programmed.

## 17.2.7 Software interrupts

The software can control the source interrupt lines to generate software interrupts. These interrupts are generated before interrupt masking, in the same way as external source interrupts. Software interrupts are cleared by writing to the software interrupt clear register, VICSoftIntClear (see *Interrupt control registers*). This is normally done at the end of the interrupt service routine.

## 17.2.8 Interrupt control registers

The base address of the PrimeCell VIC is 0x10140000.

— Note —

To ensure that the vector address register can be read in a single instruction, the PrimeCell VIC base address must be 0xFFFFF000, the upper 4K of memory. Placing the PrimeCell VIC anywhere else in memory increases interrupt latency as the ARM processor is unable to access the VICVectorAddr register using a single instruction.

Use the MMU in the ARM926EJ-S to cause the VIC to appear at 0xFFFFF000.

# 17.2.9 Implementation details

The tied off or unused signals are shown in Table 17-1.

Name	Source/ destination	Description
VICVECTADDRIN [31:0]	LOW	Connects to the <b>VICVECTADDROUT[31:0]</b> signal of the previous VIC if daisy chaining is used. Connects to LOW if the VIC is not daisy-chained.
VICVECTADDROUT [31:0]	Not used	Connects to the <b>VICVECTADDRIN[31:0]</b> signal of the next VIC if daisy chaining is used. Left unconnected if the VIC is not daisy-chained.
nVICIRQIN	HIGH	Connects to the <b>nVICIRQ</b> signal of the previous VIC if daisy chaining is used. Connects to HIGH if the VIC is the last in the daisy chain, or if VIC is not daisy-chained.
nVICFIQIN	HIGH	Connects to the <b>nVICFIQ</b> signal of the previous VIC if daisy chaining is used. Connects to HIGH if the VIC is the last in the daisy chain, or if VIC is not daisy-chained.
VICINTSOURCE [20]	LOW	Interrupt source inputs

## Table 17-1 Tied off or unused signals

# 17.3 VIC signals on pads

The interrupt request signals connected to pads are listed in Table 17-2.

Table 17-2 Interrupt controller pad signals

PrimeCell name	Dev. chip signal name	Description
VICINTSOURCE [31:21]	VICINTSOURCE [31:21]	Interrupt source input
VICINTSOURCE [20]	Not used externally	Tied LOW internally
VICINTSOURCE [19]	Not used externally	Interrupt source input from on-chip controllers
VICINTSOURCE [18]	PWRFAIL	Interrupt source input (can be driven by an external power-fail detection logic)
VICINTSOURCE [17:0]	Not used externally	Interrupt source input from on-chip controllers

Vectored Interrupt Controller (VIC)

# Chapter 18 ARM Vector Floating Point Coprocessor (VFP9)

This chapter describes the VFP9 coprocessor present in the ARM926EJ-S Development Chip. It contains the following sections:

- About the VFP9-S coprocessor on page 18-2
- *VFP9-S system control and status registers* on page 18-4.

# 18.1 About the VFP9-S coprocessor

The VFP9-S coprocessor is an implementation of the *Vector Floating-point Architecture version 2* (VFPv2). The release version used is VFP9-S r1p1.

The coprocessor provides low-cost floating-point computation that is fully compliant with the *ANSI/IEEE Std 754-1985, IEEE Standard for Binary Floating-Point Arithmetic*, referred to in this document as the IEEE 754 standard. The VFP9-S coprocessor supports all addressing modes described in section C5 of the *ARM Architecture Reference Manual*.

The VFP9-S coprocessor is optimized for:

– Note –

- high data transfer bandwidth through 32-bit split load and store buses
- fast hardware execution of a high percentage of operations on normalized data resulting in higher overall performance while providing full IEEE 754 standard support when required
- divide and square root operations in parallel with other arithmetic operations to reduce the impact of long-latency operations
- near IEEE 754 standard compatibility in RunFast mode without support code assistance, providing determinable run-time calculations for all input data
- low power consumption, small die size, and reduced kernel code.

The VFP9-S coprocessor is an ARM enhanced numeric coprocessor that provides IEEE 754 standard-compatible operations. Designed to be incorporated with the ARM9E family of cores, the VFP9-S coprocessor provides full support of single-precision and double-precision add, subtract, multiply, divide, and multiply with accumulate operations. Conversions between floating-point data formats and ARM integer word format are provided, with special operations to perform the conversion in round-toward-zero mode for high-level language support.

The VFP9-S coprocessor provides a performance-power-area solution for embedded applications and high performance for general-purpose applications, such as Java.

This document is intended to be read in conjunction with the Vector Floating-point Architecture section of the *ARM Architecture Reference Manual*. Only VFP9-S-specific implementation issues are described in this section.

For more information on the coprocessor, see the ARM VFP9 Coprocessor Technical Reference Manual.

# 18.2 ARMv5TE coprocessor extensions

There are four coprocessor extensions used with the VFP9:

- **FMDRR** The FMDRR instruction transfers data from two ARM registers to a VFP9-S double-precision register. The ARM registers do not have to be contiguous.
- **FMRRD** The FMRRD instruction transfers data in a VFP9-S double-precision register to two ARM registers. The ARM registers do not have to be contiguous.
- **FMSRR** The FMSRR operation transfers data in two ARM registers to two consecutively numbered single-precision VFP9-S registers, Sm and S(m + 1). The ARM registers do not have to be contiguous.
- **FMRRS** The FMRRS operation transfers data in two consecutively numbered single-precision VFP9-S registers to two ARM registers. The ARM registers do not have to be contiguous.

# 18.3 VFP9-S system control and status registers

The VFP9-S coprocessor provides sufficient information for processing all exception conditions encountered by the hardware. In an exceptional situation, the hardware provides:

- the exceptional instruction
- the instruction that was issued to the VFP9-S coprocessor before the exception was detected
- exception status information
  - type of exception
  - number of remaining short vector iterations after an exceptional iteration.

Five VFP9-S registers support exceptional conditions:

- Floating-point System ID Register (FPSID)
- Floating-point Status and Control Register (FPSID)
- Floating-point Exception Register (FPEXC).
- Floating-point Instruction Register (FPINST)
- Floating-point Instruction Register 2 (FPINST2)

These registers are designed to be used with the support code software available from ARM Limited. As a result, this document does not fully specify exception handling in all cases.

In addition, the source data registers for an exceptional instruction are available to the support code. However, some or all of the other data registers in the ARM9E processor and the VFP9-S coprocessor might be modified and not in the state they were in at the time the exceptional instruction was issued.

Access to the FPEXC, FPINST, and FPINST2 registers is possible only in a privileged mode, and does not trigger exceptions. Use the FMRX instruction to store these registers and the FMXR instruction to load them. Table 18-1 describes access to these registers.

Register	FMXR/FMRX <reg> field encoding</reg>	Exception processing trigger?	Legal modes
FPSID	0000	No	Any
FPSCR	0001	No	Any
FPEXC	1000	No	Privileged
FPINST	1001	No	Privileged
FPINST2	1010	No	Privileged

## Table 18-1 Access to control registers

# 18.4 Modes of operation

The VFP9-S coprocessor provides full IEEE 754 standard compatibility through a combination of hardware and software. There are rare cases that require significant additional compute time to resolve correctly according to the requirements of the IEEE 754 standard. For instance, the VFP9-S coprocessor does not process subnormal input values directly. To provide correct handling of subnormal inputs according to the IEEE 754 standard, a trap is made to support code to process the operation. Using the support code for processing this operation can require hundreds of cycles. In some applications this is unavoidable, because compliance with the IEEE 754 standard is essential to proper operation of the program. In many other applications, especially in the embedded market, strict compliance to the IEEE 754 standard is unnecessary, while determinable runtime, low interrupt latency, and low power are of more importance. The following sections describe the two VFP9-S coprocessor modes of operation:

- Full-compliance mode
- Flush-to-Zero mode on page 18-7
- *Default NaN mode* on page 18-7
- *RunFast Mode* on page 18-8.

#### 18.4.1 Full-compliance mode

When the VFP9-S coprocessor is in Full-compliance mode, all operations that cannot be processed according to the IEEE 754 standard use support code for assistance. The operations requiring support code are:

- Any CDP operation involving a subnormal input when not in Flush-to-Zero mode. Enable Flush-to-Zero mode by setting the FZ bit, FPSCR[24].
- Any CDP operation involving a NaN input when not in Default NaN mode. Enable Default NaN mode by setting the DN bit, FPSCR[25].
- Any CDP operation that has the potential of generating an underflow condition when not in Flush-to-Zero mode.
- Any CDP operation when Inexact exceptions are enabled. Enable Inexact exceptions by setting the IXE bit, FPSCR[12].
- Any CDP operation that can cause an overflow while Overflow exceptions are enabled. Enable Overflow exceptions by setting the OFE bit, FPSCR[10].
- Any CDP operation that involves an invalid combination as the result of a product overflow when Invalid Operation exceptions are enabled. Enable Invalid Operation exceptions by setting the IOE bit, FPSCR[8].

• A float-to-integer conversion that has the potential to create an integer that cannot be represented in the destination integer format when Invalid Operation exceptions are enabled.

The support code:

- determines the nature of the exception
- determines if processing is required to perform the computation
- calls a user trap handler
- transfers control to the user trap handler if the enable bit for the detected exception is set
- writes the result to the destination register, updates the FPSCR register, and returns to the user code if the exception enable bit is not set.

## 18.4.2 Flush-to-Zero mode

Setting the FZ bit, FPSCR[24], enables Flush-to-Zero mode and increases performance on very small inputs and results. In Flush-to-Zero mode, the VFP9-S coprocessor treats all subnormal input operands of arithmetic CDP operations as positive zeros in the operation. Exceptions that result from a zero operand are signaled appropriately. FABS, FCMP, and FNEG are not considered arithmetic CDP operations, and are not affected by Flush-to-Zero mode. A result that is tiny, as described in the IEEE 754 standard, for the destination precision is smaller in magnitude than the minimum normal value *before rounding* and is replaced with a positive zero. The IDC flag, FPSCR[7], indicates when an input flush occurs. The UFC flag, FPSCR[3], indicates when a result flush occurs.

## 18.4.3 Default NaN mode

Setting the DN bit, FPSCR[25] enables Default NaN mode. In Default NaN mode, the result of any operation that involves an input NaN or generated a NaN result returns the default NaN. Propagation of the fraction bits is maintained only by FABS, FNEG, and FCPY operations, all other CDP operations ignore any information in the fraction bits of an input NaN.

## 18.4.4 RunFast Mode

RunFast mode is the combination of the following conditions:

- the VFP9-S coprocessor is in Flush-to-Zero mode
- the VFP9-S coprocessor is in Default NaN mode
- all exception enable bits are cleared.

In RunFast mode the VFP9-S coprocessor:

- processes subnormal input operands as positive zeros
- processes results that are *tiny* before rounding, that is, between the positive and negative minimum normal values for the destination precision, as positive zeros
- processes input NaNs as default NaNs
- returns the default result specified by the IEEE 754 standard for overflow, division-by-zero, invalid, or inexact operations fully in hardware and without additional latency
- processes all operations in hardware without trapping to support code.

RunFast mode enables the programmer to write code for the VFP9-S coprocessor that runs in a determinable time without support code assistance, regardless of the characteristics of the input data. In RunFast mode, no user exception traps are available. However, the exception flags in the FPSCR register are compliant with the IEEE 754 standard for Inexact, Overflow, Invalid Operation, and Division-by-Zero exceptions. The underflow flag is modified for Flush-to-Zero mode. Each of these flags is set by an exceptional condition and can be cleared only by a write to the FPSCR register.

# Chapter 19 Watchdog Timer

This chapter describes the Watchdog timer in the ARM926EJ-S Development Chip. It contains the following sections:

- About the Watchdog module (SP805) on page 19-2
- *Functional description* on page 19-3.

# 19.1 About the Watchdog module (SP805)

The Watchdog module is an *Advanced Microcontroller Bus Architecture* (AMBA) compliant *System-on-Chip* (SoC) peripheral developed, tested, and licensed by ARM Limited.

The release state of the Watchdog Module used in the ARM926EJ-S Development Chip is SP805-r1p0. The base address for the Watchdog control registers is 0x101E1000. For more information on the controller, see the *ARM PrimeCell Watchdog Controller* (SP805) Technical Reference Manual.

The Watchdog module is an AMBA slave module and connects to the core APB. The Watchdog module consists of a 32-bit down counter with a programmable timeout interval that has the capability to generate an interrupt and a reset signal on timing out. It is intended to be used to apply a reset to a system in the event of a software failure.

## 19.1.1 Features

The features of the Watchdog module are:

- Compliance to the *AMBA Specification (Rev 2.0)* for easy integration into an SoC implementation.
- 32-bit down counter with a programmable timeout interval.
- Separate Watchdog clock with clock enable for flexible control of the timeout interval.
- Interrupt output generation on timeout.
- Reset signal generation on timeout if the interrupt from the previous timeout remains unserviced by software.
- Lock register to protect registers from being altered by runaway software.
- Identification registers that uniquely identify the Watchdog module. These can be used by software to automatically configure itself.

# 19.2 Functional description



Figure 19-1 shows a simplified block diagram of the Watchdog module.

## Figure 19-1 Simplified block diagram

The Watchdog module is based around a 32-bit down counter that is initialized from the Reload Register, WdogLoad. The counter decrements by one on each positive clock edge of **WDOGCLK** when the clock enable **WDOGCLKEN** is HIGH. When the counter reaches zero, an interrupt is generated. On the next enabled **WDOGCLK** clock edge the counter is reloaded from the WdogLoad Register and the count down sequence continues. If the interrupt is not cleared by the time that the counter next reaches zero then the Watchdog module asserts the reset signal, **WDOGRES**, and the counter is stopped.

**WDOGCLK** can be equal to or be a sub-multiple of the **PCLK** frequency. However, the positive edges of **WDOGCLK** and **PCLK** must be synchronous and balanced.

The Watchdog module interrupt and reset generation can be enabled or disabled as required by use of the Control Register, WdogControl. When the interrupt generation is disabled then the counter is stopped. When the interrupt is re-enabled then the counter starts from the value programmed in WdogLoad, and not from the last count value.

Write access to the registers in the Watchdog module can be disabled by the use of the Watchdog module Lock Register, WdogLock. Writing a value of 0x1ACCE551 to the register enables write accesses to all of the other registers. Writing any other value

disables write accesses to all registers except the Lock Register. This feature protects the Watchdog module registers from being spuriously changed by runaway software that might otherwise disable the Watchdog module operation.

#### 19.2.1 Programmable parameters

The following Watchdog module parameters are programmable:

- interrupt generation enable/disable
- interrupt masking
- reset signal generation enable and/disable
- interrupt interval.

## 19.2.2 Watchdog registers

The base address of the Watchdog module is 0x101E1000.

The following locations are reserved, and must not be used during normal operation:

- 0x101E1018-0x101E1BFC
- 0x101E1F08—0x101E1FDC.

For detailed information on the Watchdog registers, see the ARM PrimeCell Watchdog Controller (SP805) Technical Reference Manual.

# Appendix A Signals on Pads

This appendix lists the signals on the ARM926EJ-S Development Chip pads. It contains the following section:

• *Pad signals by function* on page A-2.

# A.1 Pad signals by function

Table A-1 lists the pad signals and the signal characteristics:

- The **Function** column identifies the major functional block.
- The **Type** column indicates the signal direction:
  - I Input
  - **IPU** Input with internal pull-up
  - O Output
  - **B** Bidirectional I/O
  - **T** Tristate output
  - **PIO** Power to I/O
  - PC Power to core.
- The **Drive** column indicates the drive strength in mA.
- The **BGA** column is the pad identifier.

#### — Note —

BGA pads not listed are ground. See Figure B-1 on page B-2 for more information on pin numbering and layout.

Function	Signal	Description	Туре	Drive	BGA
AHB M1	HADDRM1[0]	Address bus	Т	8	AK31
AHB M1	HADDRM1[1]	Address bus	Т	8	AK32
AHB M1	HADDRM1[2]	Address bus	Т	8	AG30
AHB M1	HADDRM1[3]	Address bus	Т	8	AK33
AHB M1	HADDRM1[4]	Address bus	Т	8	AG29
AHB M1	HADDRM1[5]	Address bus	Т	8	AK34
AHB M1	HADDRM1[6]	Address bus	Т	8	AE28
AHB M1	HADDRM1[7]	Address bus	Т	8	AJ31
AHB M1	HADDRM1[8]	Address bus	Т	8	AJ32

#### Table A-1 Pad signals
Function	Signal	Description	Туре	Drive	BGA
AHB M1	HADDRM1[9]	Address bus	Т	8	AJ33
AHB M1	HADDRM1[10]	Address bus	Т	8	AF30
AHB M1	HADDRM1[11]	Address bus	Т	8	AH31
AHB M1	HADDRM1[12]	Address bus	Т	8	AE30
AHB M1	HADDRM1[13]	Address bus	Т	8	AH32
AHB M1	HADDRM1[14]	Address bus	Т	8	AF29
AHB M1	HADDRM1[15]	Address bus	Т	8	AH33
AHB M1	HADDRM1[16]	Address bus	Т	8	AH34
AHB M1	HADDRM1[17]	Address bus	Т	8	AG31
AHB M1	HADDRM1[18]	Address bus	Т	8	AE29
AHB M1	HADDRM1[19]	Address bus	Т	8	AG32
AHB M1	HADDRM1[20]	Address bus	Т	8	AD29
AHB M1	HADDRM1[21]	Address bus	Т	8	AG33
AHB M1	HADDRM1[22]	Address bus	Т	8	AD30
AHB M1	HADDRM1[23]	Address bus	Т	8	AG34
AHB M1	HADDRM1[24]	Address bus	Т	8	AF31
AHB M1	HADDRM1[25]	Address bus	Т	8	AF32
AHB M1	HADDRM1[26]	Address bus	Т	8	AD28
AHB M1	HADDRM1[27]	Address bus	Т	8	AF33
AHB M1	HADDRM1[28]	Address bus	Т	8	AC28
AHB M1	HADDRM1[29]	Address bus	Т	8	AF34
AHB M1	HADDRM1[30]	Address bus	Т	8	AC29
AHB M1	HADDRM1[31]	Address bus	Т	8	AE33
AHB M1	HBURSTM1[0]	Transfer burst length	Т	8	AD33
AHB M1	HBURSTM1[1]	Transfer burst length	Т	8	AB29

Function	Signal	Description	Туре	Drive	BGA
AHB M1	HBURSTM1[2]	Transfer burst length	Т	8	AD34
AHB M1	HBUSREQM1	Master bus request	0	8	AL32
AHB M1	HDATAM1[0]	Data bus	В	8	AB32
AHB M1	HDATAM1[1]	Data bus	В	8	AB33
AHB M1	HDATAM1[2]	Data bus	В	8	AB34
AHB M1	HDATAM1[3]	Data bus	В	8	Y28
AHB M1	HDATAM1[4]	Data bus	В	8	AA31
AHB M1	HDATAM1[5]	Data bus	В	8	Y29
AHB M1	HDATAM1[6]	Data bus	В	8	AA32
AHB M1	HDATAM1[7]	Data bus	В	8	Y30
AHB M1	HDATAM1[8]	Data bus	В	8	AA33
AHB M1	HDATAM1[9]	Data bus	В	8	AA30
AHB M1	HDATAM1[10]	Data bus	В	8	Y31
AHB M1	HDATAM1[11]	Data bus	В	8	Y32
AHB M1	HDATAM1[12]	Data bus	В	8	Y33
AHB M1	HDATAM1[13]	Data bus	В	8	W28
AHB M1	HDATAM1[14]	Data bus	В	8	Y34
AHB M1	HDATAM1[15]	Data bus	В	8	W29
AHB M1	HDATAM1[16]	Data bus	В	8	W32
AHB M1	HDATAM1[17]	Data bus	В	8	W33
AHB M1	HDATAM1[18]	Data bus	В	8	W34
AHB M1	HDATAM1[19]	Data bus	В	8	V29
AHB M1	HDATAM1[20]	Data bus	В	8	V31
AHB M1	HDATAM1[21]	Data bus	В	8	W30
AHB M1	HDATAM1[22]	Data bus	В	8	V33

Function	Signal	Description	Туре	Drive	BGA
AHB M1	HDATAM1[23]	Data bus	В	8	V28
AHB M1	HDATAM1[24]	Data bus	В	8	U33
AHB M1	HDATAM1[25]	Data bus	В	8	V30
AHB M1	HDATAM1[26]	Data bus	В	8	U32
AHB M1	HDATAM1[27]	Data bus	В	8	U28
AHB M1	HDATAM1[28]	Data bus	В	8	U31
AHB M1	HDATAM1[29]	Data bus	В	8	T34
AHB M1	HDATAM1[30]	Data bus	В	8	Т33
AHB M1	HDATAM1[31]	Data bus	В	8	U29
AHB M1	HGRANTM1	Arbiter bus grant	Ι	-	AJ30
AHB M1	HLOCKM1	Locked sequence	0	8	AF28
AHB M1	HPROTM1[0]	Protection Control	Т	8	AC31
AHB M1	HPROTM1[1]	Protection Control	Т	8	AC32
AHB M1	HPROTM1[2]	Protection Control	Т	8	AA28
AHB M1	HPROTM1[3]	Protection Control	Т	8	AC33
AHB M1	HREADYM1	Transfer finished	Ι	-	AA29
AHB M1	HRESPM1[0]	Transfer response	Ι	-	AC34
AHB M1	HRESPM1[1]	Transfer response	Ι	-	AB30
AHB M1	HSIZEM1[0]	Transfer size	Т	8	AD32
AHB M1	HSIZEM1[1]	Transfer size	Т	8	AC30
AHB M1	HTRANSM1[0]	Transfer type	Т	8	AD31
AHB M1	HTRANSM1[1]	Transfer type	Т	8	AB28
AHB M1	HWRITEM1	Write transfer	Т	8	AE34
AHB M2	HADDRM2[0]	Address bus	Т	8	N32
AHB M2	HADDRM2[1]	Address bus	Т	8	M34

|--|

Function	Signal	Description	Туре	Drive	BGA
AHB M2	HADDRM2[2]	Address bus	Т	8	M33
AHB M2	HADDRM2[3]	Address bus	Т	8	R28
AHB M2	HADDRM2[4]	Address bus	Т	8	M32
AHB M2	HADDRM2[5]	Address bus	Т	8	P30
AHB M2	HADDRM2[6]	Address bus	Т	8	M31
AHB M2	HADDRM2[7]	Address bus	Т	8	P29
AHB M2	HADDRM2[8]	Address bus	Т	8	L34
AHB M2	HADDRM2[9]	Address bus	Т	8	L33
AHB M2	HADDRM2[10]	Address bus	Т	8	L32
AHB M2	HADDRM2[11]	Address bus	Т	8	P28
AHB M2	HADDRM2[12]	Address bus	Т	8	L31
AHB M2	HADDRM2[13]	Address bus	Т	8	N30
AHB M2	HADDRM2[14]	Address bus	Т	8	K34
AHB M2	HADDRM2[15]	Address bus	Т	8	N29
AHB M2	HADDRM2[16]	Address bus	Т	8	K32
AHB M2	HADDRM2[17]	Address bus	Т	8	N28
AHB M2	HADDRM2[18]	Address bus	Т	8	J34
AHB M2	HADDRM2[19]	Address bus	Т	8	J33
AHB M2	HADDRM2[20]	Address bus	Т	8	J32
AHB M2	HADDRM2[21]	Address bus	Т	8	M30
AHB M2	HADDRM2[22]	Address bus	Т	8	J31
AHB M2	HADDRM2[23]	Address bus	Т	8	M28
AHB M2	HADDRM2[24]	Address bus	Т	8	H34
AHB M2	HADDRM2[25]	Address bus	Т	8	H33
AHB M2	HADDRM2[26]	Address bus	Т	8	H32

Function	Signal	Description	Туре	Drive	BGA
AHB M2	HADDRM2[27]	Address bus	Т	8	M29
AHB M2	HADDRM2[28]	Address bus	Т	8	H31
AHB M2	HADDRM2[29]	Address bus	Т	8	L30
AHB M2	HADDRM2[30]	Address bus	Т	8	G34
AHB M2	HADDRM2[31]	Address bus	Т	8	L28
AHB M2	HBURSTM2[0]	Transfer burst length	Т	8	L29
AHB M2	HBURSTM2[1]	Transfer burst length	Т	8	F33
AHB M2	HBURSTM2[2]	Transfer burst length	Т	8	K29
AHB M2	HBUSREQM2	Master bus request	0	8	T28
AHB M2	HDATAM2[0]	Data bus	В	8	J28
AHB M2	HDATAM2[1]	Data bus	В	8	E34
AHB M2	HDATAM2[2]	Data bus	В	8	E33
AHB M2	HDATAM2[3]	Data bus	В	8	E32
AHB M2	HDATAM2[4]	Data bus	В	8	J29
AHB M2	HDATAM2[5]	Data bus	В	8	E31
AHB M2	HDATAM2[6]	Data bus	В	8	H30
AHB M2	HDATAM2[7]	Data bus	В	8	D32
AHB M2	HDATAM2[8]	Data bus	В	8	H29
AHB M2	HDATAM2[9]	Data bus	В	8	F28
AHB M2	HDATAM2[10]	Data bus	В	8	C31
AHB M2	HDATAM2[11]	Data bus	В	8	D30
AHB M2	HDATAM2[12]	Data bus	В	8	G28
AHB M2	HDATAM2[13]	Data bus	В	8	F27
AHB M2	HDATAM2[14]	Data bus	В	8	F29
AHB M2	HDATAM2[15]	Data bus	В	8	G27

Function	Signal	Description	Туре	Drive	BGA
AHB M2	HDATAM2[16]	Data bus	В	8	C30
AHB M2	HDATAM2[17]	Data bus	В	8	E27
AHB M2	HDATAM2[18]	Data bus	В	8	B30
AHB M2	HDATAM2[19]	Data bus	В	8	A30
AHB M2	HDATAM2[20]	Data bus	В	8	E29
AHB M2	HDATAM2[21]	Data bus	В	8	F26
AHB M2	HDATAM2[22]	Data bus	В	8	D29
AHB M2	HDATAM2[23]	Data bus	В	8	E26
AHB M2	HDATAM2[24]	Data bus	В	8	C29
AHB M2	HDATAM2[25]	Data bus	В	8	G26
AHB M2	HDATAM2[26]	Data bus	В	8	B29
AHB M2	HDATAM2[27]	Data bus	В	8	A29
AHB M2	HDATAM2[28]	Data bus	В	8	E28
AHB M2	HDATAM2[29]	Data bus	В	8	G25
AHB M2	HDATAM2[30]	Data bus	В	8	D28
AHB M2	HDATAM2[31]	Data bus	В	8	E25
AHB M2	HGRANTM2	Arbiter bus grant	Ι	-	R29
AHB M2	HLOCKM2	Locked sequence	0	8	N33
AHB M2	HPROTM2[0]	Protection Control	Т	8	F32
AHB M2	HPROTM2[1]	Protection Control	Т	8	F31
AHB M2	HPROTM2[2]	Protection Control	Т	8	F30
AHB M2	HPROTM2[3]	Protection Control	Т	8	K28
AHB M2	HREADYM2	Transfer finished	Ι	-	G29
AHB M2	HRESPM2[0]	Transfer response	Ι	-	J30
AHB M2	HRESPM2[1]	Transfer response	Ι	-	H28

Function	Signal	Description	Туре	Drive	BGA
AHB M2	HSIZEM2[0]	Transfer size	Т	8	K30
AHB M2	HSIZEM2[1]	Transfer size	Т	8	F34
AHB M2	HTRANSM2[0]	Transfer type	Т	8	G32
AHB M2	HTRANSM2[1]	Transfer type	Т	8	G31
AHB M2	HWRITEM2	Write transfer	Т	8	G33
AHB S	HADDRS[0]	Address bus	Ι	-	D7
AHB S	HADDRS[1]	Address bus	Ι	-	F10
AHB S	HADDRS[2]	Address bus	Ι	-	A6
AHB S	HADDRS[3]	Address bus	Ι	-	G10
AHB S	HADDRS[4]	Address bus	Ι	-	B6
AHB S	HADDRS[5]	Address bus	Ι	-	E9
AHB S	HADDRS[6]	Address bus	Ι	-	C6
AHB S	HADDRS[7]	Address bus	Ι	-	F9
AHB S	HADDRS[8]	Address bus	Ι	-	D6
AHB S	HADDRS[9]	Address bus	Ι	-	G9
AHB S	HADDRS[10]	Address bus	Ι	-	A5
AHB S	HADDRS[11]	Address bus	Ι	-	Н5
AHB S	HADDRS[12]	Address bus	Ι	-	E4
AHB S	HADDRS[13]	Address bus	Ι	-	J7
AHB S	HADDRS[14]	Address bus	Ι	-	E3
AHB S	HADDRS[15]	Address bus	Ι	-	E2
AHB S	HADDRS[16]	Address bus	Ι	-	E1
AHB S	HADDRS[17]	Address bus	Ι	-	J5
AHB S	HADDRS[18]	Address bus	Ι	-	G6
AHB S	HADDRS[19]	Address bus	Ι	-	J6

Table A-I Fau Signals (Continueu)	Table A-1	Pad signals	(continued)
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Function	Signal	Description	Туре	Drive	BGA
AHB S	HADDRS[20]	Address bus	Ι	-	F5
AHB S	HADDRS[21]	Address bus	Ι	-	K7
AHB S	HADDRS[22]	Address bus	Ι	-	F4
AHB S	HADDRS[23]	Address bus	Ι	-	K6
AHB S	HADDRS[24]	Address bus	Ι	-	F3
AHB S	HADDRS[25]	Address bus	Ι	-	K5
AHB S	HADDRS[26]	Address bus	Ι	-	F1
AHB S	HADDRS[27]	Address bus	Ι	-	L7
AHB S	HADDRS[28]	Address bus	Ι	-	G5
AHB S	HADDRS[29]	Address bus	Ι	-	L6
AHB S	HADDRS[30]	Address bus	Ι	-	G4
AHB S	HADDRS[31]	Address bus	Ι	-	G3
AHB S	HBURSTS[0]	Transfer burst length	Ι	-	M6
AHB S	HBURSTS[1]	Transfer burst length	Ι	-	Н3
AHB S	HBURSTS[2]	Transfer burst length	Ι	-	M5
AHB S	HDATAS[0]	Data bus	В	8	B13
AHB S	HDATAS[1]	Data bus	В	8	F15
AHB S	HDATAS[2]	Data bus	В	8	C13
AHB S	HDATAS[3]	Data bus	В	8	G15
AHB S	HDATAS[4]	Data bus	В	8	A12
AHB S	HDATAS[5]	Data bus	В	8	F14
AHB S	HDATAS[6]	Data bus	В	8	B12
AHB S	HDATAS[7]	Data bus	В	8	C12
AHB S	HDATAS[8]	Data bus	В	8	D12
AHB S	HDATAS[9]	Data bus	В	8	E13

Function	Signal	Description	Туре	Drive	BGA
AHB S	HDATAS[10]	Data bus	В	8	B11
AHB S	HDATAS[11]	Data bus	В	8	G14
AHB S	HDATAS[12]	Data bus	В	8	C11
AHB S	HDATAS[13]	Data bus	В	8	F13
AHB S	HDATAS[14]	Data bus	В	8	D11
AHB S	HDATAS[15]	Data bus	В	8	A10
AHB S	HDATAS[16]	Data bus	В	8	B10
AHB S	HDATAS[17]	Data bus	В	8	G13
AHB S	HDATAS[18]	Data bus	В	8	C10
AHB S	HDATAS[19]	Data bus	В	8	G12
AHB S	HDATAS[20]	Data bus	В	8	A9
AHB S	HDATAS[21]	Data bus	В	8	E12
AHB S	HDATAS[22]	Data bus	В	8	B9
AHB S	HDATAS[23]	Data bus	В	8	F12
AHB S	HDATAS[24]	Data bus	В	8	С9
AHB S	HDATAS[25]	Data bus	В	8	D9
AHB S	HDATAS[26]	Data bus	В	8	A8
AHB S	HDATAS[27]	Data bus	В	8	E11
AHB S	HDATAS[28]	Data bus	В	8	B8
AHB S	HDATAS[29]	Data bus	В	8	G11
AHB S	HDATAS[30]	Data bus	В	8	D8
AHB S	HDATAS[31]	Data bus	В	8	F11
AHB S	HMASTLOCKS	Locked sequence	Ι	-	J3
AHB S	HPROTS[0]	Protection Control	Ι	-	H2
AHB S	HPROTS[1]	Protection Control	Ι	-	N7

Tuble A I I ad Signals (continued)
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Function	Signal	Description	Туре	Drive	BGA
AHB S	HPROTS[2]	Protection Control	Ι	-	H1
AHB S	HPROTS[3]	Protection Control	Ι	-	N6
AHB S	HREADYS	Transfer finished	В	8	E10
AHB S	HRESPS[0]	Transfer response	Т	8	B7
AHB S	HRESPS[1]	Transfer response	Т	8	C7
AHB S	HSELS	Slave select	Ι	-	N5
AHB S	HSIZES[0]	Transfer size	Ι	-	L5
AHB S	HSIZES[1]	Transfer size	Ι	-	H4
AHB S	HTRANSS[0]	Transfer type	Ι	-	M7
AHB S	HTRANSS[1]	Transfer type	Ι	-	G1
AHB S	HWRITES	Write transfer	Ι	-	G2
AHB Monitor	AHBMONITOR[0]	Debug information	0	8	F25
AHB Monitor	AHBMONITOR[1]	Debug information	0	8	B28
AHB Monitor	AHBMONITOR[2]	Debug information	0	8	G24
AHB Monitor	AHBMONITOR[3]	Debug information	0	8	D27
AHB Monitor	AHBMONITOR[4]	Debug information	0	8	F24
AHB Monitor	AHBMONITOR[5]	Debug information	0	8	C27
AHB Monitor	AHBMONITOR[6]	Debug information	0	8	B27
AHB Monitor	AHBMONITOR[7]	Debug information	0	8	A27
AHB Monitor	AHBMONITOR[8]	Debug information	0	8	E24
AHB Monitor	AHBMONITOR[9]	Debug information	0	8	D26
AHB Monitor	AHBMONITOR[10]	Debug information	0	8	G23
AHB Monitor	AHBMONITOR[11]	Debug information	0	8	C26
AHB Monitor	AHBMONITOR[12]	Debug information	0	8	E23
AHB Monitor	AHBMONITOR[13]	Debug information	0	8	B26

Function	Signal	Description	Туре	Drive	BGA
AHB Monitor	AHBMONITOR[14]	Debug information	0	8	F23
AHB Monitor	AHBMONITOR[15]	Debug information	0	8	A26
AHB Monitor	AHBMONITOR[16]	Debug information	0	8	C25
AHB Monitor	AHBMONITOR[17]	Debug information	0	8	B25
AHB Monitor	AHBMONITOR[18]	Debug information	0	8	G22
AHB Monitor	AHBMONITOR[19]	Debug information	0	8	A25
AHB Monitor	AHBMONITOR[20]	Debug information	0	8	F22
AHB Monitor	AHBMONITOR[21]	Debug information	0	8	C24
AHB Monitor	AHBMONITOR[22]	Debug information	0	8	E22
AHB Monitor	AHBMONITOR[23]	Debug information	0	8	B24
AHB Monitor	AHBMONITOR[24]	Debug information	0	8	G21
AHB Monitor	AHBMONITOR[25]	Debug information	0	8	A24
AHB Monitor	AHBMONITOR[26]	Debug information	0	8	F21
AHB Monitor	AHBMONITOR[27]	Debug information	0	8	D23
AHB Monitor	AHBMONITOR[28]	Debug information	0	8	C23
AHB Monitor	AHBMONITOR[29]	Debug information	0	8	B23
AHB Monitor	AHBMONITOR[30]	Debug information	0	8	G20
AHB Monitor	AHBMONITOR[31]	Debug information	0	8	A23
AHB Monitor	AHBMONITOR[32]	Debug information	0	8	E21
AHB Monitor	AHBMONITOR[33]	Debug information	0	8	B22
CLCDC	CLAC	AC bias drive/data enable	0	4	AN23
CLCDC	CLCDCLKEXT	External Clock input for CLCD	Ι	-	AN22
CLCDC	CLCP	Panel clock	0	4	AP23
CLCDC	CLD[0]	Data bus	0	4	AH20
CLCDC	CLD[1]	Data bus	0	4	AM23

Tuble A TTuu orginale (continueu)	Table A-1	Pad signals	(continued)
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Function	Signal	Description	Туре	Drive	BGA
CLCDC	CLD[2]	Data bus	0	4	AL23
CLCDC	CLD[3]	Data bus	0	4	AP24
CLCDC	CLD[4]	Data bus	0	4	AK21
CLCDC	CLD[5]	Data bus	0	4	AN24
CLCDC	CLD[6]	Data bus	0	4	AK22
CLCDC	CLD[7]	Data bus	0	4	AL24
CLCDC	CLD[8]	Data bus	0	4	AJ21
CLCDC	CLD[9]	Data bus	0	4	AP25
CLCDC	CLD[10]	Data bus	0	4	AH21
CLCDC	CLD[11]	Data bus	0	4	AN25
CLCDC	CLD[12]	Data bus	0	4	AJ22
CLCDC	CLD[13]	Data bus	0	4	AM25
CLCDC	CLD[14]	Data bus	0	4	AK23
CLCDC	CLD[15]	Data bus	0	4	AP26
CLCDC	CLD[16]	Data bus	0	4	AH22
CLCDC	CLD[17]	Data bus	0	4	AN26
CLCDC	CLD[18]	Data bus	0	4	AM26
CLCDC	CLD[19]	Data bus	0	4	AL26
CLCDC	CLD[20]	Data bus	0	4	AJ23
CLCDC	CLD[21]	Data bus	0	4	AP27
CLCDC	CLD[22]	Data bus	0	4	AH23
CLCDC	CLD[23]	Data bus	0	4	AN27
CLCDC	CLFP	Frame synch pulse	0	4	AJ20
CLCDC	CLLE	Line end	0	4	AK24
CLCDC	CLLP	Line synch pulse	0	4	AK20

Function	Signal	Description	Туре	Drive	BGA
CLCDC	CLPOWER	Panel power enable	0	4	AM22
Clock	HCLKM1	Asynchronous AHB Clock In	Ι	-	T32
Clock	HCLKM2	Asynchronous AHB Clock In	Ι	-	C28
Clock	HCLKS	Asynchronous AHB Clock In	Ι	-	A7
Clock	nPLLRESET	PLL reset	Ι	-	H7
Clock	PLLCLKEXT	Clock input from a PLL	Ι	-	F8
Clock	PLLPWRDN	PLL power down	Ι	-	D3
Clock	REFCLK32K	32KHz Reference Clock	Ι	-	C5
Clock	TIMCLKEXT	Timer Clock	Ι	-	F20
Clock	XTALCLKEXT	Clock input from a crystal oscillator	Ι	-	B5
CPU	DBGACK	Debug acknowledge	0	4	E17
CPU	EDBGRQ	External Debug request	Ι	-	C19
DMAC	DMACBREQ[0]	Burst Transfer Request	Ι	-	L2
DMAC	DMACBREQ[1]	Burst Transfer Request	Ι	-	R5
DMAC	DMACBREQ[2]	Burst Transfer Request	Ι	-	L1
DMAC	DMACBREQ[3]	Burst Transfer Request	Ι	-	T6
DMAC	DMACBREQ[4]	Burst Transfer Request	Ι	-	M4
DMAC	DMACBREQ[5]	Burst Transfer Request	Ι	-	T7
DMAC	DMACCLR[0]	Request Acknowledge Clear	0	4	J2
DMAC	DMACCLR[1]	Request Acknowledge Clear	0	4	J1
DMAC	DMACCLR[2]	Request Acknowledge Clear	0	4	К3
DMAC	DMACCLR[3]	Request Acknowledge Clear	0	4	P7
DMAC	DMACCLR[4]	Request Acknowledge Clear	0	4	K2
DMAC	DMACCLR[5]	Request Acknowledge Clear	0	4	P5

Table A-1	Pad	signals	(continued)
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Function	Signal	Description	Туре	Drive	BGA
DMAC	DMACLBREQ[0]	Last Burst Transfer Request	Ι	-	N1
DMAC	DMACLBREQ[1]	Last Burst Transfer Request	Ι	-	U5
DMAC	DMACLBREQ[2]	Last Burst Transfer Request	Ι	-	P4
DMAC	DMACLBREQ[3]	Last Burst Transfer Request	Ι	-	U7
DMAC	DMACLBREQ[4]	Last Burst Transfer Request	Ι	-	Р3
DMAC	DMACLBREQ[5]	Last Burst Transfer Request	Ι	-	V5
DMAC	DMACLSREQ[0]	Last Single Transfer Request	Ι	-	P2
DMAC	DMACLSREQ[1]	Last Single Transfer Request	Ι	-	V6
DMAC	DMACLSREQ[2]	Last Single Transfer Request	Ι	-	P1
DMAC	DMACLSREQ[3]	Last Single Transfer Request	Ι	-	V7
DMAC	DMACLSREQ[4]	Last Single Transfer Request	Ι	-	R4
DMAC	DMACLSREQ[5]	Last Single Transfer Request	Ι	-	R3
DMAC	DMACSREQ[0]	Single Transfer Request	Ι	-	M3
DMAC	DMACSREQ[1]	Single Transfer Request	Ι	-	M2
DMAC	DMACSREQ[2]	Single Transfer Request	Ι	-	M1
DMAC	DMACSREQ[3]	Single Transfer Request	Ι	-	T5
DMAC	DMACSREQ[4]	Single Transfer Request	Ι	-	N3
DMAC	DMACSREQ[5]	Single Transfer Request	Ι	-	U6
DMAC	DMACTC[0]	Terminal Count	0	4	K1
DMAC	DMACTC[1]	Terminal Count	0	4	P6
DMAC	DMACTC[2]	Terminal Count	0	4	L4
DMAC	DMACTC[3]	Terminal Count	0	4	R7
DMAC	DMACTC[4]	Terminal Count	0	4	L3
DMAC	DMACTC[5]	Terminal Count	0	4	R6
ETM	ETMEXTIN	Debug cross trigger support	Ι	-	E14

Function	Signal	Description	Туре	Drive	BGA
ETM	ETMEXTOUT[0]	Debug cross trigger support	0	12	A14
ETM	ETMEXTOUT[1]	Debug cross trigger support	0	12	B14
ETM	ETMEXTOUT[2]	Debug cross trigger support	0	12	D14
ETM	ETMEXTOUT[3]	Debug cross trigger support	0	12	A13
ETM	PIPESTAT[0]	Pipeline Status	0	12	C18
ETM	PIPESTAT[1]	Pipeline Status	0	12	F17
ETM	PIPESTAT[2]	Pipeline Status	0	12	B18
ETM	TRACECLK	Trace Clock	0	12	A19
ETM	TRACEPKT[0]	Trace Packet	0	12	G17
ETM	TRACEPKT[1]	Trace Packet	0	12	A17
ETM	TRACEPKT[2]	Trace Packet	0	12	B17
ETM	TRACEPKT[3]	Trace Packet	0	12	D17
ETM	TRACEPKT[4]	Trace Packet	0	12	F16ETM
ETM	TRACEPKT[6]	Trace Packet	0	12	A16
ETM	TRACEPKT[7]	Trace Packet	0	12	B16
ETM	TRACEPKT[8]	Trace Packet	0	12	E16
ETM	TRACEPKT[9]	Trace Packet	0	12	C16
ETM	TRACEPKT[10]	Trace Packet	0	12	A15
ETM	TRACEPKT[11]	Trace Packet	0	12	B15
ETM	TRACEPKT[12]	Trace Packet	0	12	G16
ETM	TRACEPKT[13]	Trace Packet	0	12	C15
ETM	TRACEPKT[14]	Trace Packet	0	12	E15
ETM	TRACEPKT[15]	Trace Packet	0	12	D15
ETM	TRACESYNC	Trace Sync	0	12	D18
GPIO 0	GP0[0]	General Purpose I/O	В	8	AF6

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Function	Signal	Description	Туре	Drive	BGA
GPIO 0	GP0[1]	General Purpose I/O	В	8	AJ5
GPIO 0	GP0[2]	General Purpose I/O	В	8	AF7
GPIO 0	GP0[3]	General Purpose I/O	В	8	AH6
GPIO 0	GP0[4]	General Purpose I/O	В	8	AK1
GPIO 0	GP0[5]	General Purpose I/O	В	8	AK2
GPIO 0	GP0[6]	General Purpose I/O	В	8	AG5
GPIO 0	GP0[7]	General Purpose I/O	В	8	AK3
GPIO 1	GP1[0]	General Purpose I/O	В	4	AG6
GPIO 1	GP1[1]	General Purpose I/O	В	4	AK4
GPIO 1	GP1[2]	General Purpose I/O	В	4	AG7
GPIO 1	GP1[3]	General Purpose I/O	В	4	AJ6
GPIO 1	GP1[4]	General Purpose I/O	В	4	AH7
GPIO 1	GP1[5]	General Purpose I/O	В	4	AH8
GPIO 1	GP1[6]	General Purpose I/O	В	4	AL3
GPIO 1	GP1[7]	General Purpose I/O	В	4	AJ7
GPIO 2	GP2[0]	General Purpose I/O	В	4	AM4
GPIO 2	GP2[1]	General Purpose I/O	В	4	AJ8
GPIO 2	GP2[2]	General Purpose I/O	В	4	AL5
GPIO 2	GP2[3]	General Purpose I/O	В	4	AK8
GPIO 2	GP2[4]	General Purpose I/O	В	4	AM5
GPIO 2	GP2[5]	General Purpose I/O	В	4	AH9
GPIO 2	GP2[6]	General Purpose I/O	В	4	AN5
GPIO 2	GP2[7]	General Purpose I/O	В	4	AP5
GPIO 3	GP3[0]	General Purpose I/O	В	4	AK6
GPIO 3	GP3[1]	General Purpose I/O	В	4	AJ9

Function	Signal	Description	Туре	Drive	BGA
GPIO 3	GP3[2]	General Purpose I/O	В	4	AL6
GPIO 3	GP3[3]	General Purpose I/O	В	4	AK9
GPIO 3	GP3[4]	General Purpose I/O	В	4	AM6
GPIO 3	GP3[5]	General Purpose I/O	В	4	AH10
GPIO 3	GP3[6]	General Purpose I/O	В	4	AN6
GPIO 3	GP3[7]	General Purpose I/O	В	4	AJ10
JTAG	nBSTAPEN	Boundary Scan TAP Select	IPU	-	C21
JTAG	nTRST	Test Reset	IPU	-	D21
JTAG	RTCK	Sync of Multi-ICE TCK	0	8	A21
JTAG	ТСК	Test Clock	Ι	-	A22
JTAG	TDI	Boundary Scan Input	IPU	-	G19
JTAG	TDO	Boundary Scan Output	Т	8	B21
JTAG	TMS	Test Mode Select	IPU	-	E20
Miscellaneous	BIGENDOUT	Byte Endian Mode or TESTACK	0	4	G7
Miscellaneous	CONFIGINIT	Chip configuration	Ι	-	E8
Miscellaneous	nCONFIGCLR	Chip configuration reset	Ι	-	E6
Miscellaneous	nPORESET	Power On Reset	Ι	-	D5
Miscellaneous	nRESET	AMBA AHB Reset	Ι	-	E7
Miscellaneous	SCANENABLE	Scan Enable	Ι	-	AJ4
Miscellaneous	TESTSELECT	Manufacturing Test Select	Ι	-	H6
MPMC	MPMCADDR[0]	Address bus	0	12	Y3
MPMC	MPMCADDR[1]	Address bus	0	12	Y4
MPMC	MPMCADDR[2]	Address bus	0	12	AA5
MPMC	MPMCADDR[3]	Address bus	0	12	AA2
MPMC	MPMCADDR[4]	Address bus	0	12	AA3

Function	Signal	Description	Туре	Drive	BGA
MPMC	MPMCADDR[5]	Address bus	0	12	AA4
MPMC	MPMCADDR[6]	Address bus	0	12	AA6
MPMC	MPMCADDR[7]	Address bus	0	12	AB1
MPMC	MPMCADDR[8]	Address bus	0	12	AA7
MPMC	MPMCADDR[9]	Address bus	0	12	AB2
MPMC	MPMCADDR[10]	Address bus	0	12	AB3
MPMC	MPMCADDR[11]	Address bus	0	12	AC1
МРМС	MPMCADDR[12]	Address bus	0	12	AB5
MPMC	MPMCADDR[13]	Address bus	0	12	AC2
MPMC	MPMCADDR[14]	Address bus	0	12	AC3
МРМС	MPMCCKE[0]	Clock enable	0	8	U3
MPMC	MPMCCKE[1]	Clock enable	0	8	W5
MPMC	MPMCCKE[2]	Clock enable	0	8	U2
MPMC	MPMCCKE[3]	Clock enable	0	8	W6
MPMC	MPMCCLK[0]	Clock out	0	16	R2
MPMC	MPMCCLK[1]	Clock out	0	16	R1
MPMC	MPMCCLK[2]	Clock out	0	16	Т3
MPMC	MPMCCLK[3]	Clock out	0	16	T2
MPMC	MPMCCLK[4]	Clock out	0	16	T1
МРМС	MPMCDATA[0]	Data bus	В	8	AC4
MPMC	MPMCDATA[1]	Data bus	В	8	AB6
MPMC	MPMCDATA[2]	Data bus	В	8	AD1
MPMC	MPMCDATA[3]	Data bus	В	8	AB7
MPMC	MPMCDATA[4]	Data bus	В	8	AD2
MPMC	MPMCDATA[5]	Data bus	В	8	AD3

Function	Signal	Description	Туре	Drive	BGA
MPMC	MPMCDATA[6]	Data bus	В	8	AD4
MPMC	MPMCDATA[7]	Data bus	В	8	AC5
MPMC	MPMCDATA[8]	Data bus	В	8	AE2
MPMC	MPMCDATA[9]	Data bus	В	8	AC6
MPMC	MPMCDATA[10]	Data bus	В	8	AE3
МРМС	MPMCDATA[11]	Data bus	В	8	AF1
МРМС	MPMCDATA[12]	Data bus	В	8	AF2
MPMC	MPMCDATA[13]	Data bus	В	8	AC7
МРМС	MPMCDATA[14]	Data bus	В	8	AF3
MPMC	MPMCDATA[15]	Data bus	В	8	AD6
MPMC	MPMCDATA[16]	Data bus	В	8	AF4
МРМС	MPMCDATA[17]	Data bus	В	8	AG1
MPMC	MPMCDATA[18]	Data bus	В	8	AG2
МРМС	MPMCDATA[19]	Data bus	В	8	AD5
MPMC	MPMCDATA[20]	Data bus	В	8	AG3
MPMC	MPMCDATA[21]	Data bus	В	8	AD7
MPMC	MPMCDATA[22]	Data bus	В	8	AG4
МРМС	MPMCDATA[23]	Data bus	В	8	AH1
МРМС	MPMCDATA[24]	Data bus	В	8	AH2
МРМС	MPMCDATA[25]	Data bus	В	8	AE5
MPMC	MPMCDATA[26]	Data bus	В	8	AH4
MPMC	MPMCDATA[27]	Data bus	В	8	AE6
MPMC	MPMCDATA[28]	Data bus	В	8	AH5
MPMC	MPMCDATA[29]	Data bus	В	8	AJ1
MPMC	MPMCDATA[30]	Data bus	В	8	AJ2

Function	Signal	Description	Туре	Drive	BGA
MPMC	MPMCDATA[31]	Data bus	В	8	AE7
МРМС	MPMCDQM[0]	Data mask & byte lane select	0	8	V2
MPMC	MPMCDQM[1]	Data mask & byte lane select	0	8	W7
MPMC	MPMCDQM[2]	Data mask & byte lane select	0	8	V4
MPMC	MPMCDQM[3]	Data mask & byte lane select	0	8	Y5
MPMC	MPMCFBCLK	Clock feedback	Ι	-	U4
MPMC	MPMCRPVHHOUT	Select Vh level for nRP	0	4	AF5
MPMC	nMPMCCAS	Column address strobe	0	12	W2
MPMC	nMPMCDYCS[0]	Synch memory chip enable	0	8	Y6
MPMC	nMPMCDYCS[1]	Synch memory chip enable	0	8	Y1
MPMC	nMPMCDYCS[2]	Synch memory chip enable	0	8	Y7
MPMC	nMPMCDYCS[3]	Synch memory chip enable	0	8	Y2
MPMC	nMPMCRAS	Row address strobe	0	12	W1
MPMC	nMPMCRPOUT	SyncFlash reset power down	0	4	AJ3
MPMC	nMPMCWE	Write enable	0	12	W3
Power	TAVDD	PLL digital power	PIO	-	C4
Power	TAVSS	PLL digital ground	PIO	-	F7
Power	TVDD1P	PLL analog power	PIO	-	G8
Power	TVSS1P	PLL analog ground	PIO	-	F6
Power	VDDC[0]	Core Power	PC	-	F2
Power	VDDC[1]	Core Power	PC	-	<b>J</b> 4
Power	VDDC[2]	Core Power	PC	-	N2
Power	VDDC[3]	Core Power	PC	-	V3
Power	VDDC[4]	Core Power	PC	-	AA1
Power	VDDC[5]	Core Power	PC	-	AE1

Function	Signal	Description	Туре	Drive	BGA
Power	VDDC[6]	Core Power	PC	-	AH3
Power	VDDC[7]	Core Power	PC	-	AP6
Power	VDDC[8]	Core Power	PC	-	AP9
Power	VDDC[9]	Core Power	PC	-	AN12
Power	VDDC[10]	Core Power	PC	-	AP20
Power	VDDC[11]	Core Power	PC	-	AP21
Power	VDDC[12]	Core Power	PC	-	AM24
Power	VDDC[13]	Core Power	PC	-	AM27
Power	VDDC[14]	Core Power	PC	-	AJ34
Power	VDDC[15]	Core Power	PC	-	AE32
Power	VDDC[16]	Core Power	PC	-	AA34
Power	VDDC[17]	Core Power	PC	-	V32
Power	VDDC[18]	Core Power	PC	-	R31
Power	VDDC[19]	Core Power	PC	-	K33
Power	VDDC[20]	Core Power	PC	-	G30
Power	VDDC[21]	Core Power	PC	-	A28
Power	VDDC[22]	Core Power	PC	-	D24
Power	VDDC[23]	Core Power	PC	-	C22
Power	VDDC[24]	Core Power	PC	-	B19
Power	VDDC[25]	Core Power	PC	-	C14
Power	VDDC[26]	Core Power	PC	-	A11
Power	VDDC[27]	Core Power	PC	-	C8
Power	VDDIO[0]	I/O Power	PIO	-	B1
Power	VDDIO[1]	I/O Power	PIO	-	D1
Power	VDDIO[2]	I/O Power	PIO	-	V1

Function	Signal	Description	Туре	Drive	BGA
Power	VDDIO[3]	I/O Power	PIO	-	AL1
Power	VDDIO[4]	I/O Power	PIO	-	AN1
Power	VDDIO[5]	I/O Power	PIO	-	A2
Power	VDDIO[6]	I/O Power	PIO	-	C2
Power	VDDIO[7]	I/O Power	PIO	-	AM2
Power	VDDIO[8]	I/O Power	PIO	-	AP2
Power	VDDIO[9]	I/O Power	PIO	-	B3
Power	VDDIO[10]	I/O Power	PIO	-	AN3
Power	VDDIO[11]	I/O Power	PIO	-	A4
Power	VDDIO[12]	I/O Power	PIO	-	D4
Power	VDDIO[13]	I/O Power	PIO	-	K4
Power	VDDIO[14]	I/O Power	PIO	-	N4
Power	VDDIO[15]	I/O Power	PIO	-	T4
Power	VDDIO[16]	I/O Power	PIO	-	W4
Power	VDDIO[17]	I/O Power	PIO	-	AB4
Power	VDDIO[18]	I/O Power	PIO	-	AE4
Power	VDDIO[19]	I/O Power	PIO	-	AL4
Power	VDDIO[20]	I/O Power	PIO	-	F5
Power	VDDIO[21]	I/O Power	PIO	-	AK5
Power	VDDIO[22]	I/O Power	PIO	-	D10
Power	VDDIO[23]	I/O Power	PIO	-	AL10
Power	VDDIO[24]	I/O Power	PIO	-	D13
Power	VDDIO[25]	I/O Power	PIO	-	AL13
Power	VDDIO[26]	I/O Power	PIO	-	D16
Power	VDDIO[27]	I/O Power	PIO	-	AL13

Function	Signal	Description	Туре	Drive	BGA
Power	VDDIO[28]	I/O Power	PIO	-	D19
Power	VDDIO[29]	I/O Power	PIO	-	AL19
Power	VDDIO[30]	I/O Power	PIO	-	D22
Power	VDDIO[31]	I/O Power	PIO	-	AL22
Power	VDDIO[32]	I/O Power	PIO	-	D25
Power	VDDIO[33]	I/O Power	PIO	-	AL25
Power	VDDIO[34]	I/O Power	PIO	-	E30
Power	VDDIO[35]	I/O Power	PIO	-	AK30
Power	VDDIO[36]	I/O Power	PIO	-	A31
Power	VDDIO[37]	I/O Power	PIO	-	D31
Power	VDDIO[38]	I/O Power	PIO	-	K31
Power	VDDIO[39]	I/O Power	PIO	-	N31
Power	VDDIO[40]	I/O Power	PIO	-	T31
Power	VDDIO[41]	I/O Power	PIO	-	W31
Power	VDDIO[42]	I/O Power	PIO	-	AB31
Power	VDDIO[43]	I/O Power	PIO	-	AE31
Power	VDDIO[44]	I/O Power	PIO	-	AL31
Power	VDDIO[45]	I/O Power	PIO	-	AP31
Power	VDDIO[46]	I/O Power	PIO	-	B32
Power	VDDIO[47]	I/O Power	PIO	-	AN32
Power	VDDIO[48]	I/O Power	PIO	-	A33
Power	VDDIO[49]	I/O Power	PIO	-	C33
Power	VDDIO[50]	I/O Power	PIO	-	AM33
Power	VDDIO[51]	I/O Power	PIO	-	AP33
Power	VDDIO[52]	I/O Power	PIO	-	B34

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Function	Signal	Description	Туре	Drive	BGA
Power	VDDIO[53]	I/O Power	PIO	-	D34
Power	VDDIO[54]	I/O Power	PIO	-	U34
Power	VDDIO[55]	I/O Power	PIO	-	AL34
Power	VDDIO[56]	I/O Power	PIO	-	AN34
Smart Card	nSCICARDRST	Card reset	0	4	R30
Smart Card	nSCICLKEN	Tristate buffer control	0	4	P32
Smart Card	nSCIDATAEN	Tristate buffer control	0	4	T29
Smart Card	nSCIDATAOUTEN	Serial data buffer control	0	4	P33
Smart Card	nSCIVCCEN	Card supply voltage control	0	4	P31
Smart Card	SCICLKIN	Clock input from card interface	Ι	-	R33
Smart Card	SCICLKOUT	Clock output to card interface	Т	4	P34
Smart Card	SCIDATAIN	Serial data input	Ι	-	U30
Smart Card	SCIDATAOUTOD	Open drain data output	Т	4	T30
Smart Card	SCIDETECT	Card detect	Ι	-	R32
Smart Card	SCIFCB	Function code for type II sync card	0	4	N34
Smart Card	SCIREFCLKEXT	External Clock input for SCI	Ι	-	R34
SSMC	nSMBLS[0]	Byte lane select	0	8	AM21
SSMC	nSMBLS[1]	Byte lane select	0	8	AJ19
SSMC	nSMBLS[2]	Byte lane select	0	8	AL21
SSMC	nSMBLS[3]	Byte lane select	0	8	AH19
SSMC	nSMBURSTWAIT	Burst wait mode input	Ι	-	AL7
SSMC	nSMOEN	Output enable	0	12	AP22
SSMC	nSMWEN	Write enable	0	12	AP19
SSMC	nSTATICCS[0]	Chip select	0	8	AM19
SSMC	nSTATICCS[1]	Chip select	0	8	AH18

Function	Signal	Description	Туре	Drive	BGA
SSMC	nSTATICCS[2]	Chip select	0	8	AN20
SSMC	nSTATICCS[3]	Chip select	0	8	AM20
SSMC	nSTATICCS[4]	Chip select	0	8	AL20
SSMC	nSTATICCS[5]	Chip select	0	8	AJ18
SSMC	nSTATICCS[6]	Chip select	0	8	AN21
SSMC	nSTATICCS[7]	Chip select	0	8	AK19
SSMC	SMADDR[0]	Address bus	0	12	AH15
SSMC	SMADDR[1]	Address bus	0	12	AM14
SSMC	SMADDR[2]	Address bus	0	12	AJ15
SSMC	SMADDR[3]	Address bus	0	12	AN14
SSMC	SMADDR[4]	Address bus	0	12	AP14
SSMC	SMADDR[5]	Address bus	0	12	AL15
SSMC	SMADDR[6]	Address bus	0	12	AH16
SSMC	SMADDR[7]	Address bus	0	12	AM15
SSMC	SMADDR[8]	Address bus	0	12	AK15
SSMC	SMADDR[9]	Address bus	0	12	AN15
SSMC	SMADDR[10]	Address bus	0	12	AP15
SSMC	SMADDR[11]	Address bus	0	12	AM16
SSMC	SMADDR[12]	Address bus	0	12	AJ16
SSMC	SMADDR[13]	Address bus	0	12	AN16
SSMC	SMADDR[14]	Address bus	0	12	AK17
SSMC	SMADDR[15]	Address bus	0	12	AP16
SSMC	SMADDR[16]	Address bus	0	12	AL17
SSMC	SMADDR[17]	Address bus	0	12	AM17
SSMC	SMADDR[18]	Address bus	0	12	AH17

Table A-T Pau Signals (continueu	Table A-1	Pad signals	(continued)
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Function	Signal	Description	Туре	Drive	BGA
SSMC	SMADDR[19]	Address bus	0	12	AN17
SSMC	SMADDR[20]	Address bus	0	12	AK16
SSMC	SMADDR[21]	Address bus	0	12	AP18
SSMC	SMADDR[22]	Address bus	0	12	AN18
SSMC	SMADDR[23]	Address bus	0	12	AL18
SSMC	SMADDR[24]	Address bus	0	12	AJ17
SSMC	SMADDR[25]	Address bus	0	12	AM18
SSMC	SMADDRVALID	Address valid	0	8	AK18
SSMC	SMBAA	Burst address advance	0	8	AN19
SSMC	SMCANCELWAIT	Wait mode cancel	Ι	-	AH11
SSMC	SMCLK[0]	Clock out	0	16	AM7
SSMC	SMCLK[1]	Clock out	0	16	AN7
SSMC	SMCLK[2]	Clock out	0	16	AP7
SSMC	SMDATA[0]	Data bus	В	8	AK10
SSMC	SMDATA[1]	Data bus	В	8	AM8
SSMC	SMDATA[2]	Data bus	В	8	AJ11
SSMC	SMDATA[3]	Data bus	В	8	AN8
SSMC	SMDATA[4]	Data bus	В	8	AK11
SSMC	SMDATA[5]	Data bus	В	8	AP8
SSMC	SMDATA[6]	Data bus	В	8	AH12
SSMC	SMDATA[7]	Data bus	В	8	AL9
SSMC	SMDATA[8]	Data bus	В	8	AM9
SSMC	SMDATA[9]	Data bus	В	8	AN9
SSMC	SMDATA[10]	Data bus	В	8	AJ12
SSMC	SMDATA[11]	Data bus	В	8	AM10

Function	Signal	Description	Туре	Drive	BGA
SSMC	SMDATA[12]	Data bus	В	8	AK12
SSMC	SMDATA[13]	Data bus	В	8	AN10
SSMC	SMDATA[14]	Data bus	В	8	AH13
SSMC	SMDATA[15]	Data bus	В	8	AP10
SSMC	SMDATA[16]	Data bus	В	8	AL11
SSMC	SMDATA[17]	Data bus	В	8	AM11
SSMC	SMDATA[18]	Data bus	В	8	AK13
SSMC	SMDATA[19]	Data bus	В	8	AN11
SSMC	SMDATA[20]	Data bus	В	8	AJ13
SSMC	SMDATA[21]	Data bus	В	8	AP11
SSMC	SMDATA[22]	Data bus	В	8	AL12
SSMC	SMDATA[23]	Data bus	В	8	AM12
SSMC	SMDATA[24]	Data bus	В	8	AH14
SSMC	SMDATA[25]	Data bus	В	8	AP12
SSMC	SMDATA[26]	Data bus	В	8	AJ14
SSMC	SMDATA[27]	Data bus	В	8	AM13
SSMC	SMDATA[28]	Data bus	В	8	AK14
SSMC	SMDATA[29]	Data bus	В	8	AN13
SSMC	SMDATA[30]	Data bus	В	8	AP13
SSMC	SMDATA[31]	Data bus	В	8	AL14
SSMC	SMFBCLK	Clock feedback	Ι	-	AL8
SSMC	SMWAIT	Wait mode input	Ι	-	AK7
SSP	nSSPCTLOE	Output enable SSPCLKOUT	0	4	A20
SSP	nSSPOE	Output enable SSPTXD	0	4	E18
SSP	SSPCLKEXT	External Clock input for SSP	Ι	-	F19

Table A-T Pau Signals (continueu	Table A-1	Pad signals	(continued)
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Function	Signal	Description	Туре	Drive	BGA
SSP	SSPCLKIN	Clock input	Ι	-	C20
SSP	SSPCLKOUT	Clock output	0	4	G18
SSP	SSPFSSIN	Frame input	Ι	-	D20
SSP	SSPFSSOUT	Frame or slave select	0	4	F18
SSP	SSPRXD	Receive data input	Ι	-	E19
SSP	SSPTXD	Transmit data output	0	4	B20
UART 0	nSIROUT0	SIR transmitted serial data	0	4	AJ28
UART 0	nUART0CTS	Clear to send	Ι	-	AH25
UART 0	nUART0DCD	Data Carrier detect	Ι	-	AK28
UART 0	nUART0DSR	Data Set Ready	Ι	-	AJ26
UART 0	nUART0DTR	Data terminal ready	0	4	AK26
UART 0	nUART0Out1	Out 1 modem status	0	4	AK27
UART 0	nUART0Out2	Out 2 modem status	0	4	AL30
UART 0	nUARTORI	Ring Indicator	Ι	-	AP30
UART 0	nUARTORTS	Request to send	0	4	AK29
UART 0	SIRIN0	SIR received serial data	Ι	-	AN30
UART 0	UARTORXD	Received serial data	Ι	-	AH26
UART 0	UART0TXD	Transmitted serial data	0	4	AM30
UART 0	UARTCLKEXT	External Clock input for UART	Ι	-	AL29
UART 1	nUART1CTS	Clear to send	Ι	-	AM31
UART 1	nUART1RTS	Request to send	0	4	AG28
UART 1	UART1RXD	Received serial data	Ι	-	AJ27
UART 1	UART1TXD	Transmitted serial data	0	4	AH27
UART 2	nUART2CTS	Clear to send	Ι	-	AH29
UART 2	nUART2RTS	Request to send	0	4	AH30

Function	Signal	Description	Туре	Drive	BGA
UART 2	UART2RXD	Received serial data	Ι	-	AJ29
UART 2	UART2TXD	Transmitted serial data	0	4	AH28
VIC	PWRFAIL	Interrupt source	Ι	-	AL27
VIC	VICINTSOURCE[21]	Interrupt source	Ι	-	AJ24
VIC	VICINTSOURCE[22]	Interrupt source	Ι	-	AP28
VIC	VICINTSOURCE[23]	Interrupt source	Ι	-	AN28
VIC	VICINTSOURCE[24]	Interrupt source	Ι	-	AM28
VIC	VICINTSOURCE[25]	Interrupt source	Ι	-	AH24
VIC	VICINTSOURCE[26]	Interrupt source	Ι	-	AL28
VIC	VICINTSOURCE[27]	Interrupt source	Ι	-	AJ25
VIC	VICINTSOURCE[28]	Interrupt source	Ι	-	AP29
VIC	VICINTSOURCE[29]	Interrupt source	I	-	AK25
VIC	VICINTSOURCE[30]	Interrupt source	Ι	-	AN29
VIC	VICINTSOURCE[31]	Interrupt source	Ι	-	AM29

Signals on Pads

# Appendix B Mechanical and Electrical Specifications

This appendix contains the specifications. It contains the following sections:

- Mechanical details on page B-2
- *Electrical specification* on page B-3.

# B.1 Mechanical details

Figure B-1 shows the pad numbering. Power and ground pins are highlighted. The ball spacing is 1mm.



Figure B-1 BGA numbering, ball side view

## **B.2** Electrical specification

This section provides details of the voltage and current characteristics for the core module.

## B.2.1 Bus interface characteristics

Table B-1 shows the core module electrical characteristics for the system bus interface.

Symbol	Description	Min	Max
V <sub>IH</sub>	High-level input voltage	2.0V	3.6V
V <sub>IL</sub>	Low-level input voltage	0V	0.8V
V <sub>OH</sub>	High-level output voltage	2.4V	-
V <sub>OL</sub>	Low-level output voltage	-	0.4V
C <sub>IN</sub>	Input capacitance	-	20pF

#### Table B-1 Interface signal electrical characteristics

Table B-1 shows the recommended operating ranges.

			-	• •
Parameter	Symbol	Min	Тур	Max
Core voltage	VDDCx	1.62V	1.8V	1.98V
I/O voltage	VDDIOx	3.0V	3.3V	3.6V
Junction temperature	TJ	0°C	25°C	125°C
PLL digital power	TAVDD	1.62V	1.8V	1.98V
Note				
PLL power must be a filtered version of core power. PLL digital ground is connected to I/O ground.				
PLL analog power	TVDD1P	1.62V	1.8V	1.98V
Note				
PLL power must be a filtered version of core power. PLL digital ground is connected to I/O ground.				

### **Table B-2 Operating ranges**

### B.2.2 Power estimation

Table B-3 shows the maximum power requirements.

Description	Power
Total Logic, RAM and Clock Tree Power	1 W
Total I/O Power	3.5W
Total	4.5 W

### Table B-3 Power estimate

### B.2.3 Power sequencing

There is an internal parasitic diode path from core voltage to I/O voltage. If the lower core voltage is powered up earlier than the higher I/O voltage, current flow through the parasitic diode can cause latchup.

To prevent latchup, ensure that the higher I/O voltage is powered on before the core voltage.

#### —— Caution ———

If you cannot ensure that the I/O voltage is always higher than the core voltage, use a low-voltage drop Schottcky diode between the two supplies (anode to **VDDC** and cathode to **VDDIO**).

# Appendix C Timing Specification

This appendix provides the AC timing parameters for the ARM926EJ-S Development Chip components. It contains the following sections:

- About the timing parameters on page C-2
- AHB bus timing on page C-3
- *Memory timing* on page C-4
- *Peripheral timing* on page C-5.

# C.1 About the timing parameters

Figure C-1 shows the parameters that define the setup and hold times. For more detail on timing and example waveforms, see the TRM for the peripheral.



### Figure C-1 AC timing example

The following timing parameters are used:

t <sub>cyc</sub>	The maximum cycle time for the clock signal.
t <sub>ov</sub>	The maximum delay from the relevant clock edge until the ARM926EJ-S Development Chip outputs are valid.
t <sub>oh</sub>	The minimum time after the relevant clock edge that the ARM926EJ-S Development Chip outputs remain valid.
t <sub>is</sub>	The minimum time that the ARM926EJ-S Development Chip inputs must be valid before the edge of relevant clock.
t <sub>ih</sub>	The minimum time that the ARM926EJ-S Development Chip inputs must remain valid after the edge of relevant clock.
—— Note	

For the specifications in this appendix, the rising clock edge is the reference edge unless specified otherwise.
### C.2 AHB bus timing

Table C-1 lists the timing for the AHB buses. (The bus clock frequency is typically 35MHz for a  $t_{cyc}$  of 28.5ns).

Table C-1	ARM926EJ-S	Development	Chip	bus timing	ı
			-		

Bus signals	Clock	tov	toh	tis	tih
HRESETn input	XTALCLKEXT	-	-	10ns	2ns
AHB M1 outputs in synchronous mode (HADDR, HSELx, HWRITE, HTRANS[1:0], HSIZE[2:0], HBURST[2:0], and write data)	XTALCLKEXT	16ns	1ns	-	-
AHB M1 inputs in synchronous mode ( <b>HREADY</b> , <b>HRESP</b> , <b>HLOCK</b> , and read data)	XTALCLKEXT	-	-	17ns	Ons
AHB M1 outputs in async mode (HADDR, HSELx, HWRITE, HTRANS[1:0], HSIZE[2:0], HBURST[2:0], and write data)	HCLKM1	18ns	4ns	-	-
AHB M1 inputs in async mode ( <b>HREADY</b> , <b>HRESP</b> , <b>HLOCK</b> , and read data)	HCLKM1	-	-	17ns	4.5ns
AHB M2 outputs in synchronous mode (HADDR, HSELx, HWRITE, HTRANS[1:0], HSIZE[2:0], HBURST[2:0], and write data)	XTALCLKEXT	16ns	1ns	-	-
AHB M2 inputs in synchronous mode ( <b>HREADY</b> , <b>HRESP</b> , <b>HLOCK</b> , and read data)	XTALCLKEXT	-	-	17ns	Ons
AHB M2 outputs in async mode (HADDR, HSELx, HWRITE, HSIZE[2:0], HBURST[2:0], and write data)	HCLKM2	18ns	4ns	-	-
AHB M2 inputs in async mode ( <b>HREADY</b> , <b>HRESP</b> , <b>HLOCK</b> , and read data)	HCLKM2	-	-	17ns	4.5ns
AHB S outputs in synchronous mode ( <b>HREADY</b> , <b>HRESP</b> , <b>HLOCK</b> , and read data)	XTALCLKEXT	16ns	1ns	-	-
AHB S inputs in synchronous mode (HADDR, HSELx, HWRITE, HTRANS[1:0], HSIZE[2:0], HBURST[2:0], and write data)	XTALCLKEXT	-	-	17ns	Ons
AHB S outputs in async mode (HREADY, HRESP, HLOCK, and read data)	HCLKS	18ns	4ns	-	-
AHB S inputs in async mode (HADDR, HSELx, HWRITE, HTRANS[1:0], HSIZE[2:0], HBURST[2:0], and write data)	HCLKS	-	-	17ns	4.5ns

### C.3 Memory timing

Table C-2 shows the memory timing. For more detail on timing and example waveforms, see the *ARM PrimeCell Static Memory Controller (PL093) Technical Reference Manual* and the *ARM PrimeCell Multiport Memory Controller (GX175) Technical Reference Manual*.)

Memory signals	Clock	tov	toh	tis	tih
SSMC outputs (SMDATA[31:0] for write, nSMDATAEN[3:0], SMADDR[25:0], SMCS[7:0], nSMOEN, nSMWEN, nSMBLS[3:0], and CANCELSMWAIT) SMCLK is typically 70MHz for a tcyc of 14.3ns.	SMCLK	10ns	1ns	-	-
SSMC inputs in asynchronous mode (SMDATA[31:0] for read, SMWAIT, and CANCELSMWAIT)	SMCLK	-	-	5ns	1ns
SSMC inputs in synchronous mode (SMDATA[31:0] for read, SMWAIT, and CANCELSMWAIT) Note The SMFBCLK delay from SMCLK must be less than 1.5ns.	SMFBCLK	-	-	5ns	1ns
MPMC outputs ( <b>MPMCADDROUT</b> [27:0], <b>MPMCCKEOUT</b> [3:0], <b>MPMCDQMOUT</b> [3:0], <b>nMPMCOEOUT</b> , <b>nMPMCRASOUT</b> , <b>nMPMCRPOUT</b> , <b>nMPMCWEOUT</b> , <b>MPMCDATA</b> [31:0] for write ) <b>MPMCCLK</b> is typically 70MHz for a tcyc of 14.3ns.	MPMCCLK	4ns	0.5ns	-	-
MPMC inputs (MPMCFBCLKIN[3:0], MPMCTESTREQA, for read) ——Note The MPMCFBCLK delay from MPMCCLK must be less than 1.5ns.	MPMCFBCLK	-	-	1ns	0.5ns

### Table C-2 ARM926EJ-S Development Chip memory timing

### C.4 Peripheral timing

Table C-3 shows the peripheral and controller timing. For more detail on timing and example waveforms, see the relevant Technical Reference Manual for the module.

Peripheral signals	Clock	tov	toh	tis	tih
CLCDC outputs (CLD[23:0], CLPOWER, CLLP, CLCP, CLFP, CLAC, and CLLE)	CLCDCLK	12.5ns	-2.5ns	-	-
The maximum frequency of <b>CLCDCLK</b> is 100MHz for a tcyc of 10ns.					
DMAC outputs (DMACCLR[5:0] and DMACTC[5:0])	HCLK	3ns	Ons	-	-
DMAC inputs (DMACLBREQ[5:0], DMACLSREQ[5:0], DMACBREQ[5:0] and DMACSREQ[5:0] )	HCLK	-	-	4ns	Ons
SCI outputs ( <b>nSCICLKOUTEN</b> , <b>SCICLKOUT</b> , <b>nSCIDATAOUTEN</b> , <b>nSCICLKEN</b> , and <b>nSCIDATAEN</b> )	SCIREFCLK	14ns	-1ns	-	-
SCI inputs (SCICLKIN, SCIDATAIN, and SCIDETECT) The maximum frequency of SCIREFCLK is 100MHz for a tcyc of 10ns.	SCIREFCLK	-	-	12ns	-14ns
SSP outputs ( <b>SSPFRMOUT</b> , <b>SSPCLKOUT</b> , <b>SSPTXD</b> , <b>nSSPCTLOE</b> , and <b>nSSPOE</b> )	SSPCLK	4ns	-2ns	-	-
SSP inputs ( <b>SSPRXD</b> , <b>SSPFRMIN</b> , and <b>SSPCLKIN</b> ) The maximum frequency of <b>SSPCLK</b> is 100MHz for a tcyc of 10ns.	SSPCLK	-	-	12ns	-14ns
VIC inputs (VICINTSOURCE[31:21] and PWRFAIL)	HCLK	-	-	4ns	0ns

### Table C-3 Peripherals and controller timing

Timing Specification

# Index

The items in this index are listed in alphabetical order, with symbols and numerics appearing at the end. The references given are to page numbers.

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